

# STGAP4S

Datasheet

# Automotive advanced isolated gate driver for IGBTs and SiC MOSFETs



STGAP4S



## Features

- AEC-Q100 qualified
- High voltage rail up to 1200 V
- Two output pins for direct driving of external MOSFET buffer
- Driver current capability:
  - OUT1: 0.6/2.5 A sink/source
    - OUT2: 2.4/0.6 A sink/source
- Negative gate drive ability
- dV/dt transient immunity ±100 V/ns in full temperature range
- Integrated controller for isolated flyback power supply
- Active Miller clamp driver for external N-channel MOSFET
- Programmable Desaturation detection
- Programmable Overcurrent detection
- Soft turn-off
- V<sub>CE</sub> active clamp
- Two diagnostic status outputs
- Programmable UVLO and OVLO on each supply
- Programmable input deglitch filter
- Asynchronous stop command
- Isolated 8-bit A/D converter
- Integrated temperature sensor
- Programmable deadtime, with violation error
- SPI interface for parameters programming and extended diagnostic
- Temperature warning and shutdown protection
- Self-diagnostic routines for protection features

## **Applications**

- Inverters for EV/HEV
- 600/1200 V industrial inverters
- EV charging stations
- UPS equipment
- AC/AC converters
- DC/DC converters
- Solar inverters

## Description

The STGAP4S is a galvanically isolated single gate driver for IGBTs and SiC MOSFETs with advanced protection, configuration and diagnostic features. The architecture of the STGAP4S isolates the channel gate driving from the control and the low voltage interface circuitry through true galvanic isolation.

The unique output architecture is designed to allow the use of an external MOSFET push-pull stage giving flexibility in terms of current capability dimensioning and easing the use of several power switches in parallel. The 2 pre-driver outputs are characterized by current capability and output voltage swing optimized for that topology and allow the use of a negative gate driving supply.

The integrated controller for isolated flyback power supply allows to generate positive and negative gate driver supply voltages with few external components, enabling PCB space saving.

Protection functions such as the Miller clamp driver, desaturation and overcurrent detection, UVLO and OVLO are included to easily design high reliability systems.

A temperature sensor is integrated in the driver.

Open drain diagnostic outputs are present and detailed device conditions can be monitored through the SPI. Each function's parameter can be programmed via the SPI, making the device very flexible and allowing it to fit in a wide range of applications.



# 1 Block diagram

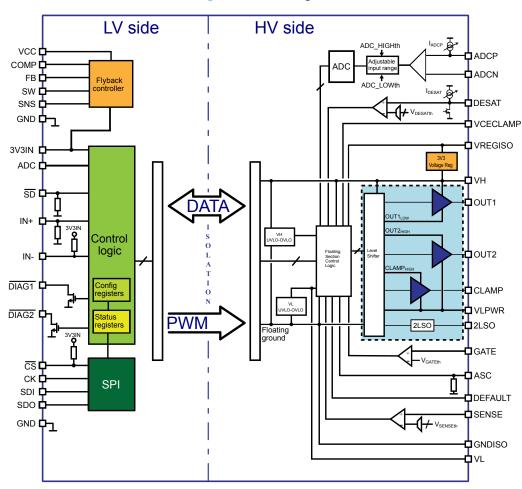


Figure 1. Block Diagram

# Pin description and connection diagram

| vcc 🗖       | 1  | 36 | DESAT   |
|-------------|----|----|---------|
| sw 🗖        | 2  | 35 |         |
| SNS 🗖       | 3  | 34 |         |
| GND 🗖       | 4  | 33 |         |
| СОМР 🗖      | 5  | 32 | □ ASC   |
| FB 🗖        | 6  | 31 |         |
| SDO 🗖       | 7  | 30 |         |
| SDI 🗖       | 8  | 29 | CLAMP   |
| <u>cs</u> □ | 9  | 28 | 2LSO    |
| ск 🗖        | 10 | 27 | ⊐ ∨н    |
| SD 🗖        | 11 | 26 | GATE    |
| IN+ 🗖       | 12 | 25 | ADCP    |
| IN- 🗖       | 13 | 24 | ADCN    |
| ADC 🗖       | 14 | 23 | SENSE   |
| DIAG1       | 15 | 22 | DEFAULT |
| DIAG2       | 16 | 21 | VREGISO |
| 3∨3IN 🗖     | 17 | 20 | GNDISO  |
| GND 🗖       | 18 | 19 |         |

# Figure 2. Pin connection (top view)

| Table 1. Pin description |
|--------------------------|
|--------------------------|

| Pin #  | Pin Name | Туре              | Function   |
|--------|----------|-------------------|--|
| 1      | VCC      | Power supply      | Flyback controller, power supply for external MOSFET driving |
| 2      | SW       | Analog output     | Flyback controller, switching pin for MOSFET gate driving    |
| 3      | SNS      | Analog input      | Flyback controller, external shunt resistor sensing          |
| 4, 18  | GND      | Ground            | Low voltage side ground                                      |
| 5      | COMP     | Analog input      | Flyback controller, compensation                             |
| 6      | FB       | Analog input      | Flyback controller, feedback                                 |
| 7      | SDO      | Logic output      | SPI serial data output                                       |
| 8      | SDI      | Logic input       | SPI serial data input  |
| 9      | CS       | Logic input       | SPI chip select (active low)                                 |
| 10     | СК       | Logic input       | SPI clock  |
| 11     | SD       | Logic input       | Shutdown input (active low)                                  |
| 12     | IN+      | Logic input       | Gate command input   |
| 13     | IN-      | Logic input       | Gate command input   |
| 14     | ADC      | Logic output      | Pulse width modulated output for ADC conversion result       |
| 15     | DIAG1    | Open drain output | Open drain diagnostic output 1 (active low)                  |
| 16     | DIAG2    | Open drain output | Open drain diagnostic output 2 (active low)                  |
| 17     | 3V3IN    | Power supply      | Low voltage side power supply                                |
| 19, 33 | VL       | Power supply      | High voltage side negative supply or ground                  |



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### STGAP4S Pin description and connection diagram

| GNDISO<br>VREGISO | Ground   |   |
|-------------------|--|---|
| VREGISO           |  | High voltage side ground  |
| TILEOIOO          | Power supply   | High voltage side internal regulator output pin for decoupling capacitor  |
| DEFAULT           | Logic input  | Configuration pin for the operation flow chart  |
| SENSE             | Analog input   | Sense input for overcurrent protection  |
| ADCN              | Analog input   | Analog measurement reference, must be connected to GNDISO   |
| ADCP              | Analog input   | Analog measurement input  |
| GATE              | Analog input   | Gate voltage feedback   |
| VH                | Power supply   | High voltage side positive power supply   |
| 2LSO              | Analog output  | Soft turn-off output  |
| CLAMP             | Analog output  | Miller clamp controller output  |
| OUT2              | Analog output  | Pre-driver output 2, for external push-pull N-channel MOSFET  |
| OUT1              | Analog output  | Pre-driver output 1, for external push-pull P-channel MOSFET  |
| ASC               | Digital input  | Asynchronous stop command   |
| VLPWR             | Power supply   | High voltage side negative power supply or ground for external push-pull driving, must be shorted to VL   |
| VCECLAMP          | Analog input   | VCE active clamping protection input  |
| DESAT             | Analog input   | Desaturation protection input   |
|                   | SENSE<br>ADCN<br>ADCP<br>GATE<br>/H<br>2LSO<br>CLAMP<br>DUT2<br>DUT1<br>ASC<br>/LPWR<br>/CECLAMP | Analog inputADCNAnalog inputADCPAnalog inputADCPAnalog inputGATEAnalog inputJUT2Analog outputDUT1Analog outputASCDigital inputVLPWRPower supplyVCECLAMPAnalog input |

# 3 Electrical data

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# 3.1 Absolute maximum ratings

| Symbol                         | Parameter   | Test condition                       | Min.                    | Max.                        | Unit |
|--------------------------------|---|--------------------------------------|-------------------------|-----------------------------|------|
| VCC                            | Low voltage side<br>power supply voltage<br>vs. GND           | _                                    | -0.30                   | 28                          | v    |
| FB                             | Feedback pin voltage  | I <sub>FB</sub> within AMR<br>limits | Self limited            | Self limited                | V    |
| I <sub>FB</sub>                | Feedback pin source/<br>sink current                          | -                                    | -2                      | 2                           | mA   |
| COMP                           | OTA output voltage  | -                                    | -0.30                   | 3.60                        | V    |
| SNS                            | Current sensing pin voltage                                   | -                                    | -0.30                   | 1                           | V    |
| SW                             | Gate driver output of flyback controller                      | -                                    | -0.30                   | (VCC + 0.3, 12) min.        | V    |
| 3V3IN                          | Low voltage side<br>power supply voltage<br>vs. GND           | -                                    | -0.30                   | 3.60                        | V    |
| VREGISO                        | High voltage side<br>internal regulator<br>voltage vs. GNDISO | -                                    | -0.30                   | 3.60                        | V    |
| VLOGIC_INPUT                   | Input logic pins voltage vs. GND                              | -                                    | -0.30                   | 6                           | V    |
| VLOGIC_OUTPUT                  | Output logic pins voltage vs. GND                             | -                                    | -0.30                   | 3.60                        | V    |
| V <sub>HL</sub>                | Differential supply voltage (VH vs. VL)                       | -                                    | -0.30                   | 36                          | V    |
| VH                             | Positive power supply<br>voltage (VH vs.<br>GNDISO)           | -                                    | -0.30                   | 36                          | V    |
| VL                             | Negative supply<br>voltage (VL vs.<br>GNDISO)                 | -                                    | -15                     | 0.30                        | V    |
| VLPWR                          | Negative power supply<br>voltage (VLPWR vs.<br>GNDISO)        | -                                    | -15                     | 0.30                        | V    |
| V <sub>PS</sub> <sup>(1)</sup> | Differential voltage<br>between VLPWR and<br>VL pin           | -                                    | -0.30                   | +0.30                       | V    |
| V <sub>OUT1</sub>              | Voltage on OUT1 pre-<br>driver output (OUT1<br>vs. VH)        | -                                    | (-20, VLPWR - 0.3) max. | +0.30                       | V    |
| I <sub>OUT1sink</sub>          | OUT1 pre-driver<br>output sink current                        | -                                    | -                       | Self limited <sup>(2)</sup> | mA   |
| I <sub>OUT1source</sub>        | OUT1 pre-driver<br>output source current                      | OUT1 = LOW                           | -                       | 10                          | mA   |
| V <sub>OUT2</sub>              | Voltage on OUT2 pre-<br>driver output (OUT2<br>vs. VLPWR)     | -                                    | -0.30                   | (+ 20, VH + 0.3) min        | V    |

## Table 2. Absolute maximum ratings

| Symbol                   | Parameter  | Test condition         | Min.     | Max.                        | Unit |
|--------------------------|--|------------------------|----------|-----------------------------|------|
| I <sub>OUT2sink</sub>    | OUT2 pre-driver<br>output sink current                     | OUT2 = HIGH            | -        | 10                          | mA   |
| I <sub>OUT2source</sub>  | OUT2 pre-driver<br>output source current                   | -                      | -        | Self limited <sup>(2)</sup> | mA   |
| V <sub>GATE</sub>        | Voltage on GATE pin vs. GNDISO                             | -                      | VL-0.30  | VH + 0.30                   | V    |
| V <sub>CLAMP</sub>       | Voltage on CLAMP<br>pre-driver output<br>(CLAMP vs. VLPWR) | -                      | -0.30    | (+ 20, VH + 0.3) min.       | V    |
| ICLAMPsink               | CLAMP pre-driver<br>output sink current                    | CLAMP = HIGH           | -        | 10                          | mA   |
| I <sub>CLAMPsource</sub> | CLAMP pre-driver<br>output source current                  | -                      | -        | Self limited <sup>(2)</sup> | mA   |
| V <sub>DESAT</sub>       | Voltage on DESAT pin vs. GNDISO                            | -                      | -0.30    | VH + 0.30                   | V    |
| V <sub>ADCP</sub>        | Voltage on ADCP pin vs. GNDISO                             | -                      | -0.30    | 3.6                         | V    |
| V <sub>ADCN</sub>        | Voltage on ADCN pin vs. GNDISO                             | -                      | -0.30    | +0.30                       | V    |
| V <sub>SENSE</sub>       | Voltage on SENSE pin vs. GNDISO                            | -                      | -2       | (VH +0.30, 20) min.         | V    |
| V <sub>CECLAMP</sub>     | Voltage on<br>VCECLAMP pin vs.<br>GNDISO                   | -                      | VL -0.30 | VH +0.30                    | V    |
| V2LTO_SOFTOFF            | Voltage on 2LSO pin vs. GNDISO                             | -                      | VL -0.30 | VH +0.30                    | V    |
| V <sub>ASC</sub>         | Voltage on ASC pin vs. GNDISO                              | -                      | -0.30    | VH +0.30                    | V    |
| Vdefault                 | Voltage on DEFAULT pin vs. GNDISO                          | -                      | -0.30    | VH +0.30                    | V    |
| V <sub>DIAGx</sub>       | Open drain output voltage                                  | -                      | -0.30    | 6                           | V    |
| Tj                       | Junction temperature                                       | -                      | -40      | 150                         | °C   |
| T <sub>STG</sub>         | Storage temperature  |                        | -50      | 150                         | °C   |
| T <sub>A</sub>           | Ambient temperature  | -                      | -40      | 125                         | °C   |
| P <sub>Din</sub>         | Power dissipation input chip                               | T <sub>A</sub> = 80 °C | -        | 600                         | mW   |
| P <sub>Dout</sub>        | Power dissipation output chip                              | T <sub>A</sub> = 80 °C | -        | 800                         | mW   |
| ESD                      | Human body model   | -                      |          | 2                           | kV   |

1.  $V_{PS} = VLPWR - VL$ 

2. Actual limit depends on power dissipation constraints

## 3.2 Thermal data

## Table 3. Thermal data

| Symbol              | Parameter                              | Value | Unit |
|---------------------|--|-------|------|
| R <sub>th(JA)</sub> | Thermal resistance junction to ambient | 51    | °C/W |

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# 3.3 Recommended operating conditions

| Table 4. Recommended operating conditions |
|---|
|---|

| Symbol                         | Parameter   | Test condition | Min.             | Max.                    | Unit |
|--------------------------------|---|----------------|------------------|-------------------------|------|
| VH                             | High voltage side positive power supply voltage (VH vs. GNDISO) | -              | 5 <sup>(1)</sup> | 32                      | V    |
| VL                             | High voltage side negative supply voltage (VL vs. GNDISO)       | -              | -10              | 0 <sup>(2)</sup>        | V    |
| VREGISO                        | High voltage side logic supply voltage (VREGISO vs. GNDISO)     | -              | 3                | .3 ± 5%                 | V    |
| V <sub>HL</sub>                | Differential supply voltage (VH vs. VL)                         | -              | 5                | 32                      | V    |
| V <sub>PS</sub> <sup>(3)</sup> | Differential voltage between VLPWR and VL pin                   | -              | -100             | 100                     | mV   |
| VCC                            | Low voltage side power supply voltage vs. GND                   | -              | 7.2              | 24                      | V    |
| 3V3IN                          | Low voltage side power supply voltage vs. GND                   | -              | 3                | .3 ± 5%                 | V    |
| V <sub>LOGIC_INPUT</sub>       | Logic pins voltage vs. GND                                      | -              | 0                | 5.5                     | V    |
| V <sub>DIAGx</sub>             | Open drain output voltage                                       | -              | 0                | 5.5                     | V    |
| V <sub>ADCP</sub>              | ADCP voltage vs. GNDISO   | -              | 0                | 3.0                     | V    |
| V <sub>ADCN</sub>              | ADCN voltage vs. GNDISO   | -              | 0                | 100                     | mV   |
| GATE                           | GATE pin voltage vs. GNDISO                                     | -              | VL               | VH                      | V    |
| ASC                            | ASC pin voltage vs. GNDISO                                      | -              | 0                | (VH, 15) <sub>min</sub> | V    |
| DEFAULT                        | DEFAULT pin voltage vs. GNDISO                                  | -              | 0                | (VH, 15) <sub>min</sub> | V    |
| V <sub>DESATth</sub>           | Desaturation protection threshold                               | DESAT enabled  | -                | VH – 2 V                | V    |
| f <sub>SW</sub>                | Maximum switching frequency                                     | -              | -                | 80 (4)(5)               | kHz  |

1. When UVLO is enabled this value is  $VH_{on}$ , max

2. When UVLO is enabled this value is VL<sub>on</sub>, min

3.  $V_{PS} = VLPWR - VL$ 

4. Actual limit depends on power dissipation constraints

5. A lower switching frequency is suggested if continuous readings of HV side registers and ADC sampling are implemented



# 4 Electrical characteristics

# 4.1 AC operation

## Table 5. AC operation electrical characteristics

| Symbol                | Parameter   | Test condition  | Min.     | Тур. | Max. | Unit |
|-----------------------|---|---|----------|------|------|------|
|                       |   | INfilter = '01'   | 50       | 70   | 90   | ns   |
| t <sub>deglitch</sub> | Input deglitch time                                     | INfilter = '10'   | 100      | 160  | 220  | ns   |
|                       |   | INfilter = '11'   | 420      | 500  | 580  | ns   |
| t <sub>INmin</sub>    | Minimum propagated input pulse                          | INfilter = '00'   | -        | -    | 20   | ns   |
| t <sub>Don</sub>      | Input to output propagation delay ON                    | INfilter = '00', DTset = '000'<br>to OUT2, No load<br>See Figure 11 | 45       | 60   | 100  | ns   |
| t <sub>Doff</sub>     | Input to output propagation delay OFF                   | INfilter = '00', DTset = '000'<br>to OUT1, No load<br>Figure 11     | 45       | 60   | 100  | ns   |
| t <sub>r1</sub>       | OUT1 rise time  | C <sub>L</sub> = 1 nF, 10% ÷ 90%                                    | -        | -    | 15   | ns   |
| t <sub>f1</sub>       | OUT1 fall time  | C <sub>L</sub> = 1 nF, 90% ÷ 10%                                    | -        | -    | 45   | ns   |
| t <sub>r2,CLAMP</sub> | OUT2, CLAMP rise time                                   | C <sub>L</sub> = 1 nF, 10% ÷ 90%                                    | -        | -    | 45   | ns   |
| t <sub>f2,CLAMP</sub> | OUT2, CLAMP fall time                                   | C <sub>L</sub> = 1 nF, 90% ÷ 10%                                    | -        | -    | 15   | ns   |
| PWD                   | Pulse width distortion $ t_{Don} - t_{Doff} $           | t <sub>IN</sub> > 100 ns<br>INfilter = '00'                         | -        | 0    | 30   | ns   |
|                       | "OUT1 to OUT2" and "OUT2 to OUT1" deadtime              | OUT_DTth = '0'  | 46       | 55   | 64   | ns   |
| OUT <sub>DT</sub>     |   | OUT_DTth = '1'  | 77       | 88   | 97   | ns   |
|                       |   | DTset = '000'   | Disabled |      |      |      |
|                       |   | DTset = '001'   | 205      | 250  | 310  |      |
|                       |   | DTset = '010'   | 410      | 500  | 610  |      |
| DT                    | Deadtime  | DTset = '011'   | 615      | 750  | 905  | ns   |
|                       |   | DTset = '100'   | 820      | 1000 | 1200 |      |
|                       |   | DTset = '101'   | 1025     | 1250 | 1495 |      |
|                       |   | DTset = '110'   | 1230     | 1500 | 1790 |      |
|                       |   | DTset = '111'   | 1640     | 2000 | 2380 |      |
| t <sub>release</sub>  | Minimum flag release time                               | <del>SD</del> = '0', SD_FLAG = '1'                                  | -        | -    | 100  | μs   |
| CMTI <sup>(1)</sup>   | Common-mode transient immunity,   dV <sub>ISO</sub> /dt | V <sub>CM</sub> = 1200 V<br>see Figure 49                           | 100      | -    | -    | V/ns |

1. Characterization data, not tested in production.

# 4.2 DC operation

## Table 6. DC operation electrical characteristics

| Symbol                           | Parameter                            | Test condition                     | Min.         | Тур.         | Max.         | Unit |
|----------------------------------|--------------------------------------|------------------------------------|--------------|--------------|--------------|------|
| Logic inputs/output              |                                      |                                    |              |              |              |      |
| V <sub>ol</sub>                  | SDO, ADC logic "0" output voltage    | I = 4 mA                           | -            | -            | 0.15         | V    |
| V <sub>oh</sub>                  | SDO, ADC logic "1" output voltage    | I = 4 mA                           | 3V3IN - 0.15 | -            | -            | V    |
| IN+h                             | IN+ logic "1"<br>input bias current  | Vin = 3.3 V                        | 41           | 66           | 88           | μA   |
| IN+I                             | IN+ logic "0"<br>input bias current  | Vin = GND                          | -            | -            | 0.10         | μA   |
| IN-h                             | IN- logic "1" input bias current     | Vin = 3.3 V                        | -            | -            | 0.10         | μA   |
| IN-I                             | IN- logic "0"<br>input bias current  | Vin = GND                          | 12           | 18           | 26           | μA   |
| SD+h                             | SD logic "1" input bias current      | Vin = 3.3 V                        | 41           | 66           | 88           | μA   |
| SD+I                             | SD logic "0" input bias current      | Vin = GND                          | -            | -            | 0.10         | μA   |
| CSh                              | CS logic "1" input bias current      | Vin = GND                          | 35           | 60           | 95           | μA   |
| CSI                              | CS logic "0" input bias current      | Vin = 3.3 V                        | -            | -            | 0.10         | μA   |
| Rin_pd                           | IN+ and SD input pull-down resistors | Vin = 3.3 V                        | 37           | 50           | 81           | kΩ   |
| R <sub>in_IN-</sub>              | IN- input<br>pull-up resistor        | -                                  | 126          | 180          | 275          | kΩ   |
| R <sub>in_CS</sub>               | CS input pull-up resistor            | Vin = GND                          | 34           | 55           | 95           | kΩ   |
| VIL                              | Low logic level voltage              | -                                  | 0.29 · 3V3IN | 0.33 · 3V3IN | 0.37 · 3V3IN | V    |
| V <sub>IH</sub>                  | High logic level voltage             | -                                  | 0.62 · 3V3IN | 0.66 · 3V3IN | 0.72 · 3V3IN | V    |
| V <sub>hyst</sub>                | Logic input<br>threshold hysteresis  | -                                  | 1.05         | 1.15         | 1.25         | V    |
| Driver buffer section            | and CLAMP function                   |                                    |              |              |              |      |
| OUT1source                       | Source peak current                  | t <sub>pulse</sub> < 5 μs DC = 1 % | 1650         | 2500         | 3400         | mA   |
| OUT1sink                         | Sink peak current                    | t <sub>pulse</sub> < 5 μs DC = 1 % | 400          | 600          | 800          | mA   |
| OUT2source,<br>CLAMPsource       | Source peak current                  | t <sub>pulse</sub> < 5 μs DC = 1 % | 350          | 600          | 900          | mA   |
| OUT2sink,<br>CLAMPsink           | Sink peak current                    | t <sub>pulse</sub> < 5 μs DC = 1 % | 1700         | 2400         | 3100         | mA   |
| SOFTOFFsink                      | Sink peak current                    | t <sub>pulse</sub> < 5 μs DC = 1 % | 440          | 800          | 1400         | mA   |
|                                  | Source MOSFET<br>R <sub>DS_on</sub>  | I <sub>D</sub> = 100 mA            | 0.8          | 1.5          | 2.8          | Ω    |
| RDSonOUT2sink,<br>RDSonCLAMPsink | Sink MOSFET<br>R <sub>DS_on</sub>    | I <sub>D</sub> = 100 mA            | 0.5          | 0.8          | 1.8          | Ω    |
| RDSonSOFTOFFsink                 | Sink MOSFET<br>R <sub>DS_on</sub>    | I <sub>D</sub> = 20 mA             | 2.5          | 4.5          | 10           | Ω    |
| OUT1 <sub>LOW</sub>              | OUT1 low output<br>voltage           | No load, VH – VL = 15 V            | VH-13        | VH-11.7      | VH-10.5      | v    |

Max.

VL+1.1

VL+13

VH-0.4

2.3

-2.3

80

3.04

2.98

65

11.2

19.2

15.

Тур.

VL+0.7

VL+11.7

VH-0.7

2

-2

50

2.9

2.85

55

7

12

9.5

Unit

V

V

V

V

ns

v

V

mV

mA

| Symbol                   | Parameter  | Test condition   | Min.    |
|--------------------------|--|--|---------|
| OUT1 <sub>LOW</sub>      | OUT1 low output voltage                                  | No load, VH – VL = 5 V   | VL+0.4  |
| OUT2 <sub>HIGH</sub> ,   | OUT2, CLAMP high   | No load, VH – VL = 15 V  | VL+10.5 |
| CLAMP <sub>HIGH</sub>    | output voltage   | No load, VH – VL = 5 V   | VH-1.1  |
| V <sub>GATEth_OFF</sub>  | CLAMP function voltage threshold                         | GATE vs. VL  | 1.7     |
| V <sub>GATEth_ON</sub>   | GATE voltage ON threshold                                | GATE vs. VH  | -1.7    |
| t <sub>CLAMP</sub>       | V <sub>GATEth_OFF</sub> to<br>CLAMP propagation<br>delay | OUT1 = HIGH<br>OUT2 = HIGH   | 30      |
| Supply voltage           |  | 1  |         |
| UVLO3V3IN <sub>ON</sub>  | 3V3IN UVLO turn-on threshold                             | -  | 2.7     |
| UVLO3V3IN <sub>OFF</sub> | 3V3IN UVLO turn-off threshold                            | -  | 2.67    |
| UVLO3V3IN <sub>hys</sub> | 3V3IN UVLO<br>hysteresis                                 | -  | 45      |
|                          |  | INx = GND  | -       |
|                          | 3V3IN quiescent  | IN- = GND<br>IN+ = SD = 3V3IN                                      | -       |
| I <sub>Q3V3</sub>        | supply current   | IN- = GND<br>SD = 3V3IN<br>IN+: f = f <sub>SW,MAX</sub><br>D = 50% | -       |
| VCC <sub>on</sub>        | VCC UVLO<br>turn-on threshold                            | -  | 6.6     |
| VCC <sub>off</sub>       | VCC UVLO<br>turn-off threshold                           | -  | 6.4     |
| VCC <sub>hys</sub>       | VCC UVLO<br>hysteresis                                   | -  | 0.185   |
| IQCC                     | VCC quiescent<br>supply current                          | SW no load<br>F <sub>swDCDC</sub> = 400 kHz                        | -       |
|                          |  | VHONth = '000'   |         |
|                          |  | VHONth = '001'   | 10.35   |
|                          |  | VHONth = '010'   | 11.30   |
|                          | VH UVLO  | VHONth = '011'   | 12.25   |
| VH <sub>on</sub>         | turn-on threshold  | VHONth = '100'   | 13.15   |
|                          |  | VHONth = '101'   | 14.10   |
|                          |  | VHONth = '110'   | 15.00   |
|                          |  | $\lambda$ (LIONIth = (111)   | 45.05   |

| VL <sub>off</sub>  | VL UVLO                        | VLONth = '00'                               |          | Disabled |       |    |
|--------------------|--------------------------------|---|----------|----------|-------|----|
| VH <sub>hyst</sub> | VH UVLO hysteresis             | -   | 0.7      | 1        | 1.3   | V  |
|                    |                                | VHONth = '111'                              | 15.00    | 16       | 17.00 |    |
|                    |                                | VHONth = '110'                              | 14.10    | 15       | 15.95 |    |
|                    |                                | VHONth = '101'                              | 13.15    | 14       | 14.70 |    |
| Pott               | turn-off threshold             | VHONth = '100'                              | 12.25    | 13       | 13.65 | V  |
| /H <sub>off</sub>  | VH UVLO                        | VHONth = '011'                              | 11.30    | 12       | 12.60 | v  |
|                    |                                | VHONth = '010'                              | 10.35    | 11       | 11.55 |    |
|                    |                                | VHONth = '001'                              | 9.40     | 10       | 10.60 |    |
|                    |                                | VHONth = '000'                              | Disabled |          |       |    |
|                    |                                | VHONth = '111'                              | 15.95    | 17       | 18.05 |    |
|                    |                                | VHONth = '110'                              | 15.00    | 16       | 17.00 |    |
|                    |                                | VHONth = '101'                              | 14.10    | 15       | 15.95 |    |
| 'H <sub>on</sub>   | turn-on threshold              | VHONth = '100'                              | 13.15    | 14       | 14.70 | V  |
|                    | VH UVLO                        | VHONth = '011'                              | 12.25    | 13       | 13.65 |    |
|                    |                                | VHONth = '010'                              | 11.30    | 12       | 12.60 |    |
|                    |                                | VHONth = '001'                              | 10.35    | 11       | 11.55 |    |
|                    |                                | VHONth = '000'                              |          | Disabled |       |    |
| QCC                | VCC quiescent supply current   | SW no load<br>F <sub>swDCDC</sub> = 400 kHz | -        | 2        | 4     | mA |
| /CC <sub>hys</sub> | VCC UVLO<br>hysteresis         | -   | 0.185    | 0.235    | 0.285 | v  |
| ′CC <sub>off</sub> | VCC UVLO<br>turn-off threshold | -   | 6.4      | 6.8      | 7.2   | v  |
| /CC <sub>on</sub>  | VCC UVLO<br>turn-on threshold  | -   | 6.6      | 7        | 7.4   | V  |

| Symbol               | Parameter                          | Test condition  | Min.  | Тур.     | Max.  | Unit                       |  |
|----------------------|------------------------------------|---|-------|----------|-------|----------------------------|--|
|                      |                                    | VLONth = '01'   | -2.10 | -2       | -1.80 |                            |  |
| VL <sub>off</sub>    | turn-off threshold                 | VLONth = '10'   | -4.25 | -4       | -3.80 | v                          |  |
|                      |                                    | VLONth = '11'   | -6.35 | -6       | -5.70 |                            |  |
|                      |                                    | VLONth = '00'   |       | Disabled |       |                            |  |
|                      | VL UVLO                            | VLONth = '01'   | -3.15 | -3       | -2.80 | _                          |  |
| VL <sub>on</sub>     | turn-on threshold                  | VLONth = '10'   | -5.25 | -5       | -4.70 | V                          |  |
|                      |                                    | VLONth = '11'   | -7.35 | -7       | -6.55 |                            |  |
| VL <sub>hys</sub>    | VL UVLO hysteresis                 | -   | 0.7   | 1        | 1.3   | V                          |  |
| OVVH <sub>on</sub>   |                                    | OVLOVHth = '00'   | 16.90 | 18       | 19.10 |                            |  |
|                      | VH OVLO                            | OVLOV Hth= '01'   | 18.80 | 20       | 21.20 | -                          |  |
| OVVH <sub>on</sub>   | turn-on threshold                  | OVLOVHth = '10'   | 20.70 | 22       | 23.35 | - V                        |  |
|                      |                                    | OVLOVHth = '11'   | 31.1  | 33       | 34.9  |                            |  |
|                      |                                    | OVLOVHth = '00'   | 17.85 | 19       | 20.15 |                            |  |
| 0.0.4.1              | VH OVLO                            | OVLOVHth = '01'   | 19.75 | 21       | 22.25 |                            |  |
| OVVH <sub>off</sub>  | turn-off threshold                 | OVLOVHth = '10'   | 21.60 | 23       | 24.40 | - V                        |  |
|                      |                                    | OVLOVHth = '11'   | 32.1  | 34       | 35.9  |                            |  |
| OVVH <sub>hys</sub>  | VH OVLO hysteresis                 | -   | 0.7   | 1        | 1.3   | V                          |  |
| OVVL <sub>off</sub>  | VL OVLO<br>turn-off threshold      | -   | -12.8 | -12      | -11.2 | V                          |  |
| OVVL <sub>on</sub>   | VL OVLO<br>turn-on threshold       | -   | -11.8 | -11      | -10.2 | V                          |  |
| OVVL <sub>hyst</sub> | VL OVLO hysteresis                 | -   | 0.7   | 1        | 1.3   | V                          |  |
|                      |                                    | SD = 3V3IN<br>IN+ = IN- = GND                                 | -     | 10       | 13    |                            |  |
| I <sub>QH</sub>      | VH quiescent supply<br>current     | SD = 3V3IN<br>IN- = GND<br>IN+: f = f <sub>SW,MAX</sub> D=50% | -     | 12       | 18    | mA                         |  |
|                      |                                    | SD = 3V3IN<br>IN+ = IN- = GND                                 | -     | 2.5      | 3.5   |                            |  |
| I <sub>QL</sub>      | VL quiescent supply<br>current     | SD= 3V3ININ- = GNDIN+: f = f <sub>SW,MAX</sub> D=50%          | -     | 3.2      | 5     | mA                         |  |
| Isolated Flyback C   | ontroller section – Osci           | llator  |       | 1        | 1     |                            |  |
|                      |                                    | CONTROLLER_FREQ = '00'  | 370   | 400      | 430   |                            |  |
| F <sub>swDCDC</sub>  | Main oscillator                    | CONTROLLER_FREQ = '01'  | 180   | 200      | 220   | kHz                        |  |
| ' SWDCDC             | frequency                          | CONTROLLER_FREQ = '10'  | 270   | 300      | 330   | KI IZ                      |  |
|                      |                                    | CONTROLLER_FREQ = '11'  | 540   | 600      | 660   |                            |  |
| ∆F <sub>swDCDC</sub> | Frequency jittering peak amplitude | -   | 1.4   | 1.75     | 2     | % of<br>F <sub>swDCE</sub> |  |
| F <sub>jit</sub>     | Jittering frequency                | -   | 400   | 500      | 600   | Hz                         |  |
| Isolated Flyback C   | ontroller section – Dem            | agnetization Detector   |       |          |       |                            |  |
| I <sub>FB</sub>      | Static Input Bias<br>Current       | V <sub>FB</sub> = 2.5 V                                       | -     | 0.5      | 1     | μA                         |  |
| V <sub>FBH</sub>     | Upper Clamp<br>Voltage             | I <sub>FB</sub> = 1 mA  | 3     | 3.3      | 3.6   | V                          |  |

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| Symbol                  | Parameter                                | Test condition                               | Min.           | Тур.  | Max.  | Unit |
|-------------------------|--|--|----------------|-------|-------|------|
| / <sub>FBL</sub>        | Lower Clamp<br>Voltage                   | I <sub>FB</sub> = - 1 mA                     | -90            | -60   | -30   | mV   |
| IV <sub>FB</sub> /dt    | Minimum detectable slope                 | Voltage falling                              | 0.05           | 0.08  | 0.15  | V/µs |
| / <sub>FBA</sub>        | Arming Voltage                           | Positive-going edge,<br>% of sampled voltage | 69             | 75    | 81    | %    |
| / <sub>FBT</sub>        | Triggering Voltage                       | Negative-going edge,<br>% of sampled voltage | 61             | 67    | 73    | %    |
| BLANK                   | Demag detection blanking time            | After $V_{\mbox{SW}}$ going low              | 140            | 203   | 240   | ns   |
| solated Flyback Co      | ontroller section – Tran                 | sconductance Error Amplifie                  | er of PSR loop |       |       |      |
| REF Voltage Reference   |  | T <sub>J</sub> = 25 °C                       | 2.45           | 2.5   | 2.55  |      |
| REF                     | Voltage Reference                        | T <sub>J</sub> = -40 ÷ +125 °C               | 2.425          | -     | 2.575 | V    |
| Jm                      | Transconductance                         | V <sub>FB</sub> = 2.5 V                      | 1.6            | 2.3   | 3.1   | mS   |
|                         | Source Current                           | V <sub>COMP</sub> = 2.8 V                    | 0.65           | 1     | 1.3   | mA   |
| COMP                    | Sink Current                             | V <sub>COMP</sub> = 0.9 V                    | 1.3            | 2     | 2.5   | mA   |
| / <sub>COMPsat.hi</sub> | Upper saturation voltage                 | I <sub>COMP</sub> = 100 μA (source)          | 3V3IN -100mV   | -     | 3V3IN | v    |
| solated Flyback Co      | ontroller section – burs                 | t mode                                       |                |       |       |      |
| √сомр_вм                | Burst-mode entry level                   | -  | 1.05           | 1.1   | 1.15  | V    |
| COMP_PRK                | Parking level during idle mode           | -  | 1.1            | 1.15  | 1.2   | V    |
| VCOMP_0                 | COMP offset                              | -  | 0.9            | 1.02  | 1.1   | V    |
| GFF                     | Feedforward gain                         | -  | 0.125          | 0.150 | 0.175 | -    |
| WAKE                    | Burst repetition time                    | -  | 400            | 500   | 600   | μs   |
| solated Flyback Co      | ontroller section – Curr                 | ent sensing                                  | 1              |       |       |      |
| sns                     | Bias current                             | $V_{sns} = 0.2 V,$<br>$V_{sw} = V_{sw_H}$    | -              | -     | 1     | μΑ   |
| d(H-L)                  | Delay to Output                          | dV <sub>CS</sub> /dt = 0.5 V/μs              | 20             | 45    | 70    | ns   |
| LEB                     | Leading Edge<br>Blanking time            | -  | 50             | 70    | 110   | ns   |
| /sns_OCP1               | Cycle-by-cycle OCP<br>level              | -  | 110            | 125   | 150   | mV   |
| √ <sub>sns_OCP2</sub>   | 2nd OCP level                            | -  | 170            | 200   | 230   | mV   |
| solated Flyback Co      | ontroller section – Inter                | nal soft-start                               | 1              |       |       |      |
| SS                      | Soft-start time                          | -  | 5              | 8     | 11    | ms   |
| solated Flyback Co      | ontroller section – Outp                 | ut undervoltage protection                   |                |       |       |      |
| V <sub>UVP</sub>        | UVP threshold                            | -  | 1.045          | 1.1   | 1.155 | V    |
| UVP                     | UVP blanking time                        | After soft-start end                         | 17             | 25    | 33    | ms   |
| UVP'                    |  | Continuos switching                          | -              | 4     | -     | 1113 |
| N <sub>UVP</sub>        | Consecutive cycles<br>for UVP triggering | Burt Mode wake up                            | -              | 3     | -     |      |
| solated Flyback Co      | ontroller section – Fault                |  |                | -     |       |      |
| RESTART                 | Restart delay after fault                | -  | 0.53           | 0.8   | 1.06  | s    |
| solated Flyback Co      |  | winding disconnection deter                  | ction          |       |       |      |
| FBON                    | Min. source current                      | SW = HIGH                                    | 20             | 40    | 55    | μA   |
|                         | ontroller section – Gate                 |  |                |       |       | P" 1 |

Unit V

V

А

ns ns kΩ

V

V

ns

μA

mA

ns

ns

| Symbol                 | Parameter                        | Test condition  | Min.  | Тур.  | Ма  |
|------------------------|----------------------------------|---|-------|-------|-----|
| V <sub>SW_L</sub>      | Output Low Voltage               | I <sub>sink</sub> = 100 mA  | 0.145 | 0.3   | 0.5 |
|                        |                                  | I <sub>source</sub> = 5 mA  | 8     | 9.5   | 1'  |
| V <sub>SW_H</sub>      | Output High voltage              | VCC > 7.6 V<br>I <sub>source</sub> = 5 mA   | 6     | 7.5   | 9   |
|                        |                                  | VCC = VCC <sub>off</sub> + 100 mV<br>I <sub>source</sub> = 5 mA                               | 6.2   | 6.7   | 7.  |
| I <sub>src_pk</sub>    | Peak source current              | -   | 0.220 | 0.550 | 0.8 |
| I <sub>sk_pk</sub>     | Peak sink current                | -   | 0.517 | 1.1   | 1.6 |
| t <sub>f</sub>         | Fall time                        | C <sub>L</sub> = 1 nF, 80% ÷ 20%  | 7     | 13    | 2   |
| t <sub>r</sub>         | Rise time                        | C <sub>L</sub> = 1 nF, 20% ÷ 80%  | 5     | 20    | 4   |
| R <sub>UVLO</sub>      | R UVLO saturation                | -   | 14    | 25    | 34  |
| V <sub>SW_OFF</sub>    | SW LOW without<br>3V3IN          | 3 < VCC < 24 V,<br>3V3IN = GND,<br>I <sub>sk</sub> = 1 mA                                     | 0.21  | 0.37  | 0.7 |
| Desaturation prot      | ection                           |   |       |       |     |
|                        |                                  | DESATth = '000'   | 2.80  | 3     | 3.2 |
|                        | Desaturation<br>threshold        | DESATth = '001'   | 3.60  | 4     | 4.2 |
|                        |                                  | DESATth = '010'   | 4.60  | 5     | 5.3 |
| V <sub>DESATth</sub>   |                                  | DESATth = '011'   | 5.50  | 6     | 6.3 |
|                        |                                  | DESATth = '100'   | 6.50  | 7     | 7.4 |
|                        |                                  | DESATth = '101'   | 7.40  | 8     | 8.4 |
|                        |                                  | DESATth = '110'   | 8.30  | 9     | 9.4 |
|                        |                                  | DESATth = '111'   | 9.30  | 10    | 10. |
| t <sub>DESfilter</sub> | DESAT pin deglitch filter        | DESATth = '100' (1)   | -     | 20    | -   |
|                        |                                  | DESATcur = '00';<br>VDESAT = 0 V  | 230   | 250   | 27  |
| I <sub>DESAT</sub>     | DESAT blanking                   | DESATcur = '01';<br>V <sub>DESAT</sub> = 0 V  | 460   | 500   | 54  |
| DESAT                  | charge current                   | DESATcur = '10';<br>V <sub>DESAT</sub> = 0 V  | 680   | 750   | 81  |
|                        |                                  | DESATcur = '11';<br>V <sub>DESAT</sub> = 0 V  | 910   | 1000  | 10  |
| IDESoff                | DESAT blanking discharge current | V <sub>DESAT</sub> = 8 V<br>IN+= GND;   | 35    | 70    | 9   |
| t <sub>FBLK</sub>      | DESAT fixed blanking time        | -   | 160   | 250   | 34  |
| t <sub>DESAT</sub>     | DESAT intervention time          | DESATth = '000'<br>$0 \rightarrow 5 \text{ V}$ step on V <sub>DESAT</sub><br>Step to OUT1 10% | 80    | 150   | 22  |
| Soft turn-Off funct    | tion                             |   |       |       |     |
|                        |                                  | 2LTO_SOFTtime = '1111'  | 0.22  | 0.25  | 0.  |
|                        |                                  | 2LTO_SOFTtime = '0000'  | 0.43  | 0.50  | 0.5 |
|                        | SOFTOFF MOSFET                   | 2LTO_SOFTtime = '0001'  | 0.64  | 0.75  | 0.8 |

• MOSFET 2LTO\_SOFTtime = '0001' 0.64 0.75 0.89 activation time when the Soft turn-off 2LTO\_SOFTtime = '0010' 0.89 1.00 1.15  $t_{\text{2LTO}\_\text{SOFTtime}}$ μs function is triggered (SAFE\_OF =1; SOFT\_2LTO=0) 2LTO\_SOFTtime = '0011' 1.36 1.50 1.65 2LTO\_SOFTtime = '0100' 1.83 2.00 2.18 2LTO\_SOFTtime = '0101' 2.30 2.50 2.70

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### STGAP4S DC operation



| Symbol                     | Parameter   | Test condition   | Min.      | Тур.      | Max.   | Unit |
|----------------------------|---|--|-----------|-----------|--------|------|
|                            |   | 2LTO_SOFTtime = '0110'   | 2.77      | 3.00      | 3.23   |      |
|                            |   | 2LTO_SOFTtime = '0111'   | 3.25      | 3.50      | 3.75   |      |
|                            | SOFTOFF MOSFET  | 2LTO_SOFTtime = '1000'   | 3.47      | 3.75      | 4.03   |      |
|                            | activation time when  | 2LTO_SOFTtime = '1001'   | 3.71      | 4.00      | 4.29   | μs   |
| <sup>t</sup> 2LTO_SOFTtime | the Soft turn-off<br>function is triggered                      | 2LTO_SOFTtime = '1010'   | 3.94      | 4.25      | 4.56   |      |
|                            | (SAFE_OF =1;<br>SOFT_2LTO=0)                                    | 2LTO_SOFTtime = '1011'   | 4.18      | 4.50      | 4.82   |      |
|                            |   | 2LTO_SOFTtime = '1100'   | 4.42      | 4.75      | 5.08   |      |
|                            |   | 2LTO_SOFTtime = '1101'   | 4.66      | 5.00      | 5.34   |      |
|                            |   | 2LTO_SOFTtime = '1110'   | 4.90      | 5.25      | 5.63   |      |
| SENSE overcurren           | t function  | · · · · ·  |           |           |        |      |
|                            |   | SENSEth = '000'  | 88        | 100       | 112    |      |
|                            |   | SENSEth = '001'  | 110       | 125       | 140    | _    |
|                            |   | SENSEth = '010'  | 135       | 150       | 165    |      |
|                            | SENSE protection  | SENSEth = '011'  | 158       | 175       | 192    |      |
| V <sub>SENSEth</sub>       | threshold   | SENSEth = '100'  | 185       | 200       | 215    | — mV |
|                            |   | SENSEth = '101'  | 235       | 250       | 268    |      |
|                            |   | SENSEth = '110'  | 285       | 300       | 315    |      |
|                            |   | SENSEth = '111'  | 380       | 400       | 420    |      |
| SENSE                      | SENSE protection intervention time                              | SENSEth = '111'<br>$0\rightarrow 1 \text{ V}$ step on V <sub>SENSE</sub> Step<br>to OUT1 10% | 50        | 95        | 120    | ns   |
| VCE active clampir         | ng protection   | · ·  |           |           |        |      |
| V <sub>CECLth</sub>        | VCE clamping threshold  | -  | VL + 1.20 | VL + 1.60 | VL + 2 | V    |
| V <sub>CECLhyst</sub>      | VCE clamping hysteresis   | -  | 0.30      | 0.50      | 0.60   | V    |
| <sup>t</sup> VCECL         | VCE clamping intervetion time                                   | -  | 10        | 22        | 35     | ns   |
| t <sub>COUNT_ACTIVE</sub>  | VCE clamping<br>observation window<br>after turn-off<br>command | -  | 2.77      | 3         | 3.23   | μs   |
| <sup>t</sup> VCECLoff      | VCE clamping time-<br>out                                       | -  | 2         | 2.30      | 2.7    | μs   |
| Diagnostics output         | t   |  |           |           |        |      |
| DIAG1,2                    | Fault event to<br>DIAGx Low delay                               | Fault event to DIAGx 90%   | -         | 4         | -      | μs   |
| DIAG1,2                    | DIAGx low level sink<br>current                                 | V <sub>DIAGx</sub> = 0.4 V   | 8         | 18        | 30     | mA   |
| RDIAG1,2                   | DIAGx pull-down resistor  | -  | 330       | 550       | 800    | kΩ   |
| Analog measureme           | ent function  |  |           |           |        |      |
|                            |   | ADC_CScur = '00'   |           | Disabled  |        |      |
|                            | Current source  | ADC_CScur = '10'   | 260       | 300       | 330    |      |
| ADCP                       | connected to ADCP pin   | ADC_CScur = '01'   | 500       | 600       | 660    | – uA |
|                            |   | ADC_CScur = '11'   | 850       | 1000      | 1100   |      |
| RES                        | ADC resolution  | ADC_LOWth = '000' and<br>ADC_HIGHth = '111'  | -         | 8         | -      | bit  |
| PER_CONV                   | ADC periodic  | -  | 80        | 100       | 120    | μs   |

| Symbol                | Parameter                          | Test condition   | Min.  | Тур.  | Max.  | Unit |  |
|-----------------------|------------------------------------|--|-------|-------|-------|------|--|
| fadc                  | PWM ADC output<br>frequency        | ADC_PWM_EN = '1' and<br>ADC_EN = '1'                               | 8     | 10    | 12    | kHz  |  |
| DC1 <sub>ADC</sub>    | ADC signal maximum duty cycle      | ADC_PWM_EN = '1'<br>STATUS5 = 0x00                                 | -     | 90    | -     | %    |  |
| DC2 <sub>ADC</sub>    | ADC signal medium duty cycle       | ADC_PWM_EN = '1'<br>STATUS5 = 0x80                                 | -     | 50    | -     | %    |  |
| DC3 <sub>ADC</sub>    | ADC signal minimum duty cycle      | ADC_PWM_EN = '1'<br>STATUS5 = 0xFF<br>See Section 7.10for details. | -     | 10    | -     | %    |  |
|                       |                                    | ADC_HIGHth = '000'   | 1.470 | 1.500 | 1.530 |      |  |
|                       |                                    | ADC_HIGHth = '001  | 1.685 | 1.715 | 1.745 |      |  |
|                       |                                    | ADC_HIGHth = '010'   | 1.890 | 1.930 | 1.970 |      |  |
|                       | ADC higher input                   | ADC_HIGHth = '011'   | 2.110 | 2.145 | 2.180 | _    |  |
| ADC_HIGHth            | threshold level                    | ADC_HIGHth = '100'   | 2.310 | 2.360 | 2.400 | - V  |  |
|                       |                                    | ADC_HIGHth = '101'   | 2.520 | 2.570 | 2.610 |      |  |
|                       |                                    | ADC_HIGHth = '110'   | 2.730 | 2.785 | 2.830 | -    |  |
|                       |                                    | ADC_HIGHth = '111'   | 2.940 | 3.000 | 3.040 | -    |  |
|                       |                                    | ADC_LOWth = '000'  | -     | 0     | 0.015 |      |  |
| ADC_LOWth             | ADC lower input<br>threshold level | ADC_LOWth = '001   | 0.200 | 0.215 | 0.230 |      |  |
|                       |                                    | <br>ADC_LOWth = '010'  | 0.405 | 0.430 | 0.455 |      |  |
|                       |                                    | ADC_LOWth = '011'  | 0.615 | 0.645 | 0.670 | _    |  |
|                       |                                    | ADC LOWth = '100'  | 0.830 | 0.855 | 0.890 | - V  |  |
|                       |                                    | ADC_LOWth = '101'  | 1.035 | 1.070 | 1.105 | -    |  |
|                       |                                    | ADC_LOWth = '110'  | 1.250 | 1.285 | 1.320 | -    |  |
|                       |                                    | ADC_LOWth = '111'  | 1.465 | 1.500 | 1.530 | _    |  |
| ADC_OFFSerr           | ADC offset error                   |  | -3    | -     | 3     | LSB  |  |
| ADC_GAINerr           | ADC gain error                     | ADC LOWth = '000' and  | -7    | -     | 3.5   | LSB  |  |
| <br>INL               | ADC INL                            | ADC_HIGHth = '111'   | -3    | -     | 3     | LSB  |  |
| DNL                   | ADC DNL                            |  | -1    | _     | 1     | LSB  |  |
| ADC_IN_LEAK           | ADC Input leakage current          | ADC_LOWth = '000' and<br>ADC_HIGHth= '111'<br>ADCP-ADCN=3.3 V      | -     | -     | 0.50  | uA   |  |
| ASC function          |                                    |  |       |       |       |      |  |
| ASCIL                 | Low logic level voltage            | -  | 0.80  | 1.10  | 1.40  | V    |  |
| ASCIH                 | High logic level voltage           | -  | 1.80  | 2.20  | 2.40  | V    |  |
| ASC <sub>hyst</sub>   | Hysteresis                         | -  | 0.95  | 1.1   | 1.25  | V    |  |
| ASCh                  | ASC logic "1" input bias current   | V <sub>ASC</sub> = 5 V   | 25    | 50    | 75    | μA   |  |
| lasci                 | ASC logic "0" input bias current   | V <sub>ASC</sub> = 0 V   | -     | -     | 0.10  | μA   |  |
| R <sub>ASC</sub>      | ASC pull-down resistor             | V <sub>ASC</sub> = 1.5 V   | 35    | 50    | 70    | kΩ   |  |
| tasc                  | ASC intervention time              | V <sub>ASC</sub> = 5 V<br>SeeFigure 38                             | 30    | 55    | 100   | ns   |  |
| DEFAULT function      |                                    | · · · · · · · · · · · · · · · · · · ·                              |       |       |       |      |  |
| DEFAULT <sub>IL</sub> | Low logic level voltage            | -  | 0.80  | 1.10  | 1.40  | V    |  |

| Symbol                               | Parameter  | Test condition                 | Min. | Тур. | Max. | Unit |
|--------------------------------------|--|--------------------------------|------|------|------|------|
| DEFAULT <sub>IH</sub>                | High logic level voltage                                       | -                              | 1.80 | 2.20 | 2.40 | V    |
| DEFAULT <sub>hyst</sub>              | hysteresis   | -                              | 0.95 | 1.1  | 1.25 | V    |
| tdel_hw3ps_on                        | Delay entering into<br>HW3PS state                             | V <sub>DEFAULT</sub> = VREGISO | 80   | 100  | 120  | μs   |
| Functionality chec                   | ks   |                                |      |      |      |      |
| t <sub>Rchk</sub>                    | SENSE resistor check time                                      | -                              | -    | -    | 15   | μs   |
| ISENSERchk                           | SENSE resistor<br>check current                                | V <sub>SENSE</sub> < 1 V       | 8    | 10   | 12   | μΑ   |
| Overtemperature p                    | protection   |                                |      |      |      |      |
| T <sub>WARN</sub>                    | Warning<br>temperature <sup>(1)</sup>                          | -                              | 125  | -    | -    | °C   |
| T <sub>SDN</sub>                     | Shutdown<br>temperature <sup>(1)</sup>                         | -                              | 155  | -    | -    | °C   |
| T <sub>hys</sub>                     | Temperature hysteresis <sup>(1)</sup>                          | -                              | -    | 20   | -    | °C   |
| SPI <sup>(1)</sup>                   |  |                                |      |      |      |      |
| t <sub>CKmax</sub>                   | Maximuym SPI clock frequency                                   | -                              | 5    | -    | -    | MHz  |
| t <sub>rCK</sub><br>t <sub>fCK</sub> | SPI clock rise and fall time                                   | C <sub>L</sub> = 30 pF         | -    | -    | 25   | ns   |
| t <sub>hCK</sub><br>t <sub>ICK</sub> | SPI clock high and low time                                    | -                              | 75   | -    | -    | ns   |
| t <sub>setCS</sub>                   | CS set-up time   | -                              | 350  | -    | -    | ns   |
| t <sub>holdCS</sub>                  | CS hold time   | -                              | 10   | -    | -    | ns   |
| t <sub>desCS_LRD</sub>               |  | Local register read            | 800  | -    | -    | ns   |
| t <sub>desCS_RRD</sub>               |  | Remote register read           | 30   | -    | -    | μs   |
| t <sub>desCS_STC</sub>               |  | Start configuration            | 1    | -    | -    | μs   |
| t <sub>desCS_SPC</sub>               |  | Stop configuration             | 8    | -    | -    | μs   |
| t <sub>desCS_RST</sub>               | CS deselect time <sup>(2)</sup>                                | ResetStatus, SoftReset         | 8    | -    | -    | μs   |
| t <sub>desCS_LWR</sub>               |  | Local register write           | 700  | -    | -    | ns   |
| t <sub>desCS_RWR</sub>               |  | Remote register write          | 12   | -    | -    | μs   |
| t <sub>desCS_NOP</sub>               |  | NOP command                    | 700  | -    | -    | ns   |
| t <sub>setSDI</sub>                  | SDI set-up time  | -                              | 25   | -    | -    | ns   |
| t <sub>holdSDI</sub>                 | SDI hold time  | -                              | 20   | -    | -    | ns   |
| t <sub>enSDO</sub>                   | SDO enable time  | -                              | -    | -    | 38   | ns   |
| t <sub>disSDO</sub>                  | SDO disable time   | -                              | -    | -    | 47   | ns   |
| t <sub>vSDO</sub>                    | SDO valid time   | -                              | -    | -    | 57   | ns   |
| t <sub>holdSDO</sub>                 | SDO hold time  | -                              | 37   | -    | -    | ns   |
| t <sub>SDLCSL</sub>                  | SD falling to CS falling                                       | -                              | 350  | -    | -    | ns   |
| t <sub>СSHSDH</sub>                  | $\overline{\text{CS}}$ rising to $\overline{\text{SD}}$ rising | -                              | 350  | -    | -    | ns   |
| t <sub>CFG</sub>                     | Configuration timer  | -                              | 2.0  | 2.5  | 3.0  | ms   |

1. Characterization data, not tested in production.

2. See Section 9

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# 5 Isolation

## Table 7. Isolation and safety-related specifications

| Parameter   | Symbol | Value | Unit | Conditions   |
|---|--------|-------|------|--|
| Clearance<br>(Minimum External Air Gap)             | CLR    | 8     | mm   | Measured from input terminals to output terminals, shortest distance through air     |
| Creepage (*)<br>(Minimum External Tracking)         | CPG    | 8     | mm   | Measured from input terminals to output terminals, shortest distance path along body |
| Comparative Tracking Index<br>(Tracking Resistance) | СТІ    | ≥ 400 | V    | DIN IEC 112/VDE 0303 Part 1  |
| Isolation Group                                     |        | II    |      | Material Group (DIN VDE 0110, 1/89, Table 1)   |

## Table 8. Isolation characteristics

| Parameter   | Symbol          | Test conditions                               | Characteristic   | Unit              |
|---|-----------------|---|------------------|-------------------|
| Maximum Working Isolation Voltage                                   | VIORM           |   | 1200             | V <sub>PEAK</sub> |
| Apparent Charge (Partial Discharge)<br>In accordance to VDE 0884-17 |                 | Method a, Type test                           |                  |                   |
|   |                 | $V_{PR} = V_{IORM} \times 1.6$ , $t_m = 10$ s | 1920             | V <sub>PEAK</sub> |
|   | V <sub>PR</sub> | Partial discharge < 5 pC                      |                  |                   |
|   | VPR             | Method b1, 100% Production test               |                  |                   |
|   |                 | $V_{PR} = V_{IORM} \times 1.875, t_m = 1 s$   | 2250             | V <sub>PEAK</sub> |
|   |                 | Partial discharge < 5 pC                      |                  |                   |
| Transient Overvoltage   | VIOTM           | t <sub>ini</sub> = 60 s                       | 6400             | Vpeak             |
| (Highest Allowable Overvoltage)                                     | VIO1M           | Type test                                     | 0400             | V PEAK            |
| Maximum Surge Test Voltage  | VIOSM           | Type test                                     | 6400             | V <sub>PEAK</sub> |
| Isolation Resistance  | R <sub>IO</sub> | V <sub>IO</sub> = 500 V, Type test            | >10 <sup>9</sup> | Ω                 |

## Table 9. Isolation voltage as per UL 1577

| Parameter                   | Symbol                | Test conditions          | Characteristic | Unit                  |
|-----------------------------|-----------------------|--------------------------|----------------|-----------------------|
| Isolation Withstand Voltage | V <sub>ISO</sub>      | 1 min. (type test)       | 3770/5330      | V <sub>rms/PEAK</sub> |
| Isolation Test voltage      | V <sub>ISO,test</sub> | 1 sec. (100% production) | 4525/6400      | V <sub>rms/PEAK</sub> |



## 6 Power supply management

## 6.1 Low voltage side

The power supply of the low voltage side has to be provided to the 3V3IN pin. The supply voltage must be properly filtered with local bypass capacitors. The use of capacitors with different values in parallel provides both local storage for impulsive current supply and high-frequency filtering. The best filtering is obtained by using low-ESR SMT ceramic capacitors and are therefore recommended. A 100 nF ceramic capacitor must be placed as close as possible to the 3V3IN supply pin and a second bypass capacitor with greater value must be placed close to it. A capacitor with a minimum 4.7 uF value is recommended.

After the LV side power-on the LVReset bit in STATUS4 register is set HIGH (see Section 9.2.11).

### 6.2 Integrated flyback controller for isolated power supply

The device integrates in the low voltage section a controller for an isolated flyback DC-DC converter that can be used to generate the VH and VL supply voltages for the gate driving section. The input voltage of the flyback transformer is also fed to the VCC pin and it is used to generate the voltage on the SW pin that drives the external MOSFET.

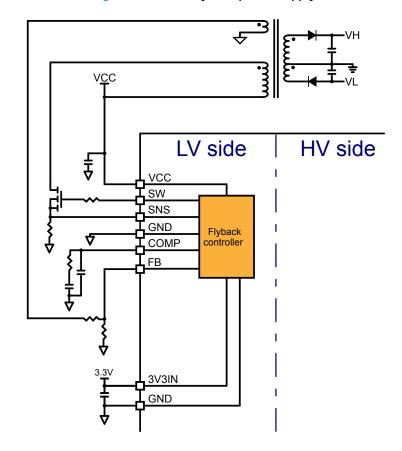


Figure 3. Isolated flyback power supply

The PWM controller included in the STGAP4S is a voltage-mode controller designed for flyback converters operated from a low DC bus voltage in Discontinuous Conduction Mode (DCM) at a fixed frequency. The input voltage feedforward feature provides the converter with the same dynamic characteristics as with peak current mode control.

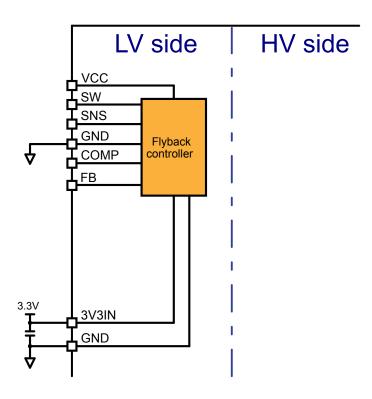
The operating frequency is set by an oscillator whose frequency can be chosen in a set of four possible values by means of two programming bits. Its frequency is jittered to mitigate EMI emissions. At very light load the controller enters a controlled burst-mode operation that helps minimize the consumption from the input line.



The device can provide constant output voltage (CV) regulation using the primary-sensing regulation (CV-PSR) technique. This eliminates the need for the optocoupler and the secondary voltage reference, still maintaining quite accurate regulation. Additionally, reducing the components across the isolation barrier leads to greater safety and reliability.

The controller embeds a full set of protection functions: input undervoltage, output overvoltage (OVP), output undervoltage (UVP), anti-CCM operation, a first-level overcurrent protection (OCP1) with cycle-by-cycle current limitation and a second-level overcurrent protection (OCP2) that is invoked when the transformer saturates or the secondary diode fails short. The internal soft-start and the leading-edge blanking of the current sense input for greater noise immunity complete the equipment of this device.

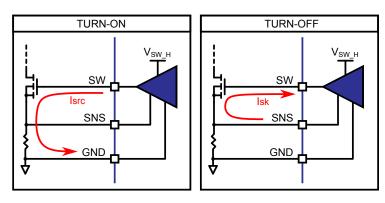
In case the flyback controller is not used, the pins VCC, SW, SNS, FB, COMP must be left unconnected and the pin 4 (GND) must be connected to the low side ground together with the pin 18 (GND), as shown in Figure 4. With this configuration of the pins the flyback controller is disabled without affecting the other functions of the device. The VH and VL supply pins of the HV side must be fed by another power supply. As the VCC voltage is below the UVLO turn-off threshold VCC<sub>off</sub>, the UVLO\_VCC flag in the status register STATUS3 is set HIGH and if this flag is associated to one of the diagnostic outputs, DIAG1 or DIAG2, the corresponding open drain output MOSFET is turned-on.



#### Figure 4. Pin configuration for flyback controller disabling

#### 6.2.1 Flyback output stage

The output stage of the flyback controller is designed with different paths for the turn-on and the turn-off phases. At the turn-on the gate driving current is sourced through the SW pin and the gate loop is closed through the GND pin. At the turn-off the gate driving current is sinked by the SW pin and the gate loop is closed through the SNS pin. Thus the SNS pin is part of the gate turn-off loop besides being the pin for the current sensing implemented with the external shunt resistor.

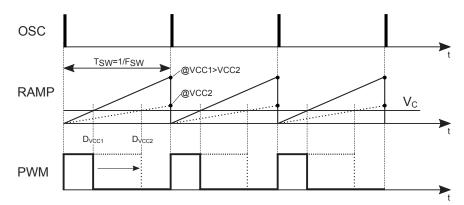


#### Figure 5. Flyback output stage

### 6.2.2 PWM: Voltage-mode control with input voltage feedforward methodology

In voltage-mode control, the PWM is generated by comparing a sawtooth ramp (synchronous to the oscillator) with a fixed control voltage  $V_C$  generated by the feedback loop (refer to Figure 7).

Unlike the traditional voltage-mode control, where the sawtooth ramp has a constant amplitude, in this topology the amplitude of the sawtooth ramp varies in direct proportion to the input voltage. Because of that, if the control voltage  $V_C$  is constant, the duty cycle varies inversely with the input voltage, thus the volt-second product VCC·D is constant without any control change (see Figure 6).



#### Figure 6. Voltage-mode control with input voltage feedforward: operating principle

A flyback converter operated in the Discontinuous Conduction Mode (DCM) results in excellent open-loop line regulation and very low audio susceptibility, like with peak current mode control. Low closed-loop gain is required to achieve the specification of the output voltage regulation and it may be designed mostly to achieve good dynamic performance.

In this context the choice of using voltage mode with input voltage feedforward control methodology is dictated by the low input voltage: peak current mode control, which is most common in flyback controllers for mains-operated applications, would require a dynamic range of the sensed signal large enough to ensure an acceptable signal-to-noise ratio under all loading conditions. This would eat up a not negligible portion of the input voltage (e.g.  $\approx 10\%$  worst case, against < 1% in applications operated from the mains) and would lead to unacceptable losses in the sense resistor.

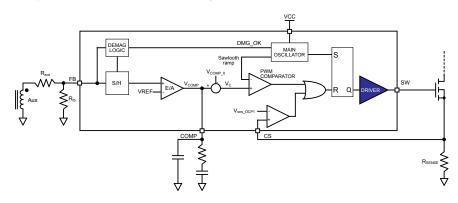
Using voltage-mode control the current sense signal is used for overcurrent protection (OCP) only and the dynamic range can be significantly reduced, being the signal-to-noise ratio significant for the maximum peak current only. This is done with no compromise on the dynamic performance of the converter adding the input voltage feedforward feature.



#### 6.2.3 Constant voltage primary-sensing regulation (CV-PSR) technique

The controller is specifically designed to work with CV-PSR, whereby the output voltage is sensed indirectly by exploiting the magnetic flux that links the windings in the flyback transformer. More specifically, the output voltage is indirectly observed through a resistor divider sensing the voltage developed across the auxiliary winding during the off-time of the power switch. A high-level block diagram of the internal circuit and the external connections is shown in Figure 7.

#### Figure 7. CV-PSR: external configuration and principle internal schematic



Due to transformer's parasitics, the auxiliary voltage provides an accurate image of the output voltage  $V_{out}$  only in the instant when the secondary current zeroes. A demagnetization detection circuit identifies this instant and the signal on the FB pin is sampled-and-held in that instant. This voltage is compared to the error amplifier internal reference  $V_{REF}$  to generate the control voltage Vc provided to the PWM generation block.

The error amplifier is a transconductance type and delivers an output current proportional to the voltage unbalance of the two inputs. The frequency compensation network is connected between its output, available on pin COMP, and GND.

The output voltage can be defined according to the formula:

$$R_{fb} = \frac{V_{REF}}{\frac{N_{aux}}{N_{sec}}} R_{zcd}$$
(1)

where  $N_{sec}$  and  $N_{aux}$  are respectively the transformer secondary and auxiliary turns number. The  $R_{zcd}$  value must be chosen considering that the minimum value of the current sourced by the FB pin during the on-time of the power switch must be larger than the auxiliary winding disconnection detection threshold ( $I_{FBON}$ ) and its maximum value lower than the  $I_{FB}$  AMR:

$$\frac{N_{aux}Vin_{\min}}{N_{pri}R_{zcd}} > I_{FBON} \qquad \frac{N_{aux}Vin_{\max}}{N_{pri}R_{zcd}} < I_{FB}AMR$$
(2)

where N<sub>pri</sub> is the primary turns number.

#### 6.2.4 Main oscillator with frequency jitter

The main oscillator, which sets the operating frequency of the flyback converter, has an operating frequency  $F_{swDCDC}$  with a default typical value of 400 kHz. By programming the appropriate registers its frequency can be changed in a set including three other values: 200, 300 and 600 kHz (typical values).

As shown in Figure 7, the main oscillator generates the pulses that set the PWM latch, determining the turn-on of the power switch, and the sawtooth ramp that, compared to the control voltage  $V_C$  by the PWM comparator, resets the PWM latch and determines the turn-off of the power switch. The amplitude of the ramp is adjusted proportionally to the VCC voltage, which is the input voltage of the flyback converter as well. The time relationship between the two signals is illustrated in Figure 6.

It is advantageous to modulate the switching frequency to mitigate converter's EMI emissions. In fact, the resulting spread-spectrum action distributes the energy of each harmonic of the switching frequency over a number of side-band harmonics. Their overall energy is unchanged, but the individual amplitudes are smaller. The switching frequency is jittered by a percentage  $\Delta F_{DCDC}$  of the controller switching frequency at a jitter rate  $F_{jit}$  with a triangular profile.



#### 6.2.5 Burst-mode operation

When the load is extremely light or zero at all, the converter enters a controlled on/off operation with essentially constant peak current. A load decrease is then translated into a frequency reduction, which can go down even to few hundred Hertz, thus minimizing the frequency related losses and maintaining the regulation ability without incurring any issues related to the minimum manageable duty cycle.

When  $V_{COMP}$  falls below an internally fixed threshold,  $V_{COMP_BM}$ , a comparator makes the controller enter an idle state where the SW output is kept in the off-state and most of the internal circuits are disabled to reduce the consumption and minimize the loading on the VCC line. Only the circuitry that determines the end of the idle state stays alive. During the idle state, a "parking circuit" keeps  $V_{COMP}$  at a fixed value slightly higher than  $V_{COMP_BM}$  plus the hysteresis of the comparator so that the controller is ready to restart.

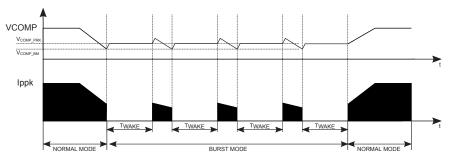
The end of the idle state is internally clocked: indeed, with PSR the information of the output voltage is acquired by the feedback loop only when the converter is switching because the transformer does not transmit DC information. Therefore, once the converter is stopped at the end of a burst, the loop is opened and no output voltage information is available until switching starts again: the power switch must be then turned on periodically (wake-up) to sense any change in the output voltage.

As a result of the energy delivery stop, the output voltage decreases: after  $t_{WAKE}$  the controller restarts the switching activity, the parking circuit is disabled after the end of the first cycle and the sampled voltage on the FB pin is compared with the internal reference. If the voltage on the error amplifier output, as a result of the comparison, remains over  $V_{COMP\_BM}$ , the device continues switching, otherwise it stays off for another  $t_{WAKE}$  period. In this way the converter works in burst-mode with an almost constant peak current defined by  $V_{COMP\_BM}$ . This kind of operation, shown in the timing diagrams of Figure 8, along with the other (continuous switching) previously described, is noise-free since the peak current is low.

The power level P<sub>outBM</sub> at which the converter enters burst-mode operation can be estimated with the following formula:

$$Pout_{BM} = \frac{\eta}{2Lf_{SW}} \left( \frac{V_{COMP}BM - V_{COMP}0}{G_{FF}} \right)^2$$
(3)

Notice, however, that the nonidealities in the control circuit (essentially, propagation delays) cause P<sub>outBM</sub> to depend on VCC, although ideally not expected.



#### Figure 8. Load-dependent operating modes: continuous switching and burst-mode operation.

#### 6.2.6 Soft-start

During converter start-up phase, the soft-start function progressively increases the control voltage  $V_C$  in 8 steps, each one having 1 ms duration (typical value), starting from an initial low value until the control loop takes over. This helps to reduce the stress on all the power components. For this function no external programming component is required as it is activated at every attempt of converter start-up or restart after a fault.

#### 6.2.7 Anti CCM protection

Ensuring that the flyback converter always works in DCM has a twofold objective: on the one hand it makes the CV-PSR topology correctly monitor the output voltage (CV-PSR principle is based on DCM operation) while on the other hand, at start-up or in case of overload, the transformer is demagnetized in every switching cycle and any risk of current staircasing due to deep CCM (Continuous Current Mode) operation is prevented.

The same "Demag Logic" function block that in the CV\_PSR loop identifies the instant when the secondary current zeroes (demagnetization), provides a DMG\_OK signal that is asserted high in each switching cycle only when demagnetization is detected. In case the converter is taken into CCM operation (i.e. the turn-on of the power switch is commanded before the secondary current is zero) the set pulse coming from the oscillator (that generates the turn-on of the power switch and the start of a new switching cycle) is delayed until the DMG\_OK signal is asserted high. In this way, the switching frequency becomes lower than the set frequency  $F_{swDCDC}$  and the converter works in DCM close to the DCM-CCM boundary. As a side-effect, the power capability of the converter is reduced and the output voltage tends to collapse.

In case of short circuit event the Anti CCM protection is not triggered, nevertheless the maximum primary current is limited by the overcurrent protection (OCP) and the controller is stopped by the output undervoltage protection (UVP).

### 6.2.8 Current sensing and overcurrent protection (OCP)

The device is equipped with a current sensing input SNS that is used to prevent the peak primary current exceeding a preset value with a cycle-by-cycle current limitation. The current flowing in the power switch is sensed through a shunt resistor  $R_S$  connected between its source and the ground. The resistor resulting voltage is sensed through the SNS pin and internally it is compared with a reference  $V_{sns_OCP1}$  to determine if the power switch must be turned off. The maximum current level is programmed by means of  $R_S$  value:

$$I_{ppk\_max} = \frac{V_{SNS\_OCP1}}{R_S}$$
(4)

 $R_S$  is such that the  $I_{ppk\_max}$  is larger than the expected peak primary current at the maximum load.

For improved noise immunity the sensing is equipped with a blanking time  $t_{\mbox{\scriptsize LEB}}$  after the SW turn-on.

In case the first level of overcurrent  $V_{sns\_OCP1}$  is not able to keep the peak current under control (e.g. in case of transformer saturation or secondary diode short-circuit), a second greater comparison level is located at  $V_{sns\_OCP2}$ . If this second level is exceeded the controller stops switching and after an idle time  $t_{RESTART}$  it goes through a new soft-start sequence.

#### 6.2.9 Output undervoltage protection (UVP)

The output undervoltage function protects the converter in case of severe overload or short-circuit conditions forcing the system to work intermittently (hiccup mode operation).

The voltage sampled on the FB pin at the end of the transformer's demagnetization is compared with an internal threshold  $V_{UVP}$  and if it is lower than this threshold for four consecutive switching cycles (to provide better noise immunity against false protection triggering) an output undervoltage condition is assumed and switching is stopped. The switching resumes after an idle time  $t_{RESTART}$  and the converter goes through a new soft-start sequence. Under continuous short-circuit conditions, the converter works intermittently with a low duty cycle (hiccup mode). The average output current and power throughput is then significantly attenuated compared to the levels that would occur in case of continuous operation.

At the end of the soft-start sequence a t<sub>UVP</sub> blanking time is provided to avoid erroneous UVP triggering during the output voltage rise time.

Note that the UVP level is proportional to the output voltage regulation setpoint. Their ratio is the same as the ratio of  $V_{REF}/V_{UVP}$ .

### 6.2.10 Auxiliary winding disconnection and output overvoltage protection (OVP)

Sensing the voltage across the auxiliary winding through the FB pin plays a fundamental role in the operation of the PWM controller. For this reason, it is extremely important to check the integrity of the connection of the FB pin to the auxiliary winding.

A winding disconnection is sensed by checking the current  $I_{FB}$  that the FB pin sources during the on-time of the power switch. This current must exceed a minimum value  $I_{FBON}$  to detect that the pin is correctly connected to the winding. If this condition is not met for four consecutive switching cycles, the controller stops switching for an idle time  $t_{RESTART}$  and goes through a new soft-start sequence.

As already stated, this function provides a limit to the maximum value of the resistor  $R_{zcd}$  that connects the FB pin to the aux winding, constraint here reported for the reader's convenience:

$$\frac{N_{aux}}{N_{pri}} \frac{Vin_{\min}}{R_{zcd}} > I_{FBON}$$

(5)

With CV-PSR the only hardware failure that may cause the output voltage to rise out of control is just a disconnection of the FB pin from the auxiliary winding. Therefore, this protection serves also as OVP function.

#### 6.2.11 Flyback fault diagnostic

The fault flag FLYBACK \_FLT reported in the status register STATUS3 is set HIGH whenever the flyback controller detects one of the following fault conditions:

- Second level overcurrent protection (OCP2)
- Output undervoltage protection (UVP)
- Auxiliary winding disconnection and output overvoltage protection (OVP)

When one of these fault conditions is detected, in addition to stopping the switching, the controller also sets HIGH the FLYBACK \_FLT flag immediately and keeps this flag HIGH for all the time  $t_{RESTART}$ . When the  $t_{RESTART}$  expires, the controller sets LOW the flag and goes through a new soft-start sequence. If a fault condition is newly detected, the controller proceeds again as described and thus in case of persistent fault condition the system works intermittently.

## 6.3 High voltage side

All the power supply pins must be properly filtered with local bypass capacitors. The use of capacitors with different values in parallel provides both local storage for impulsive current supply and high-frequency filtering. The best filtering is obtained by using low-ESR SMT ceramic capacitors and are therefore recommended. A 100 nF ceramic capacitor must be placed as close as possible to each supply pin and a second bypass capacitor with greater value should be placed close to it.

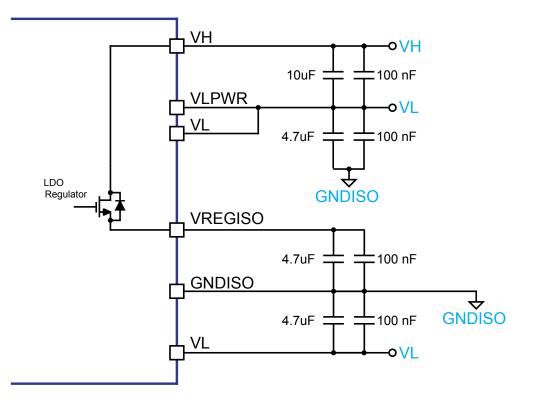
In parallel to the 100 nF one, a capacitor with minimum 10 uF value for the VH supply and 4.7 uF for the negative supply VL (if present) is recommended.

A linear voltage regulator, supplied by the voltage on the VH pin, is integrated in the high voltage side and generates the 3.3 V supply voltage dedicated to the internal logic. Although it is available on the VREGISO pin for filtering purposes it is not intended to supply external components. For the stability of the regulator a capacitor with minimum 4.7 uF value must be connected to the VREGISO pin. Also in this case a 100 nF bypass ceramic capacitor must be placed as close as possible to the VREGISO pin for noise filtering.

After the HV side power-on the HVReset bit in STATUS2 register is set HIGH (see Section 9.2.9).



#### Figure 9. High voltage side 3.3 V internal voltage regulator



## 6.4 Operation flowchart

The device can be in one of the following states:

#### Normal operation

The outputs OUT1 and OUT2 follow the input commands IN-, IN+,  $\overline{\text{SD}}$  as described in Section 7.1and can be switched also using the ASC command as described in Section 7.15

#### SafeState

The outputs OUT1 and OUT2 are kept HIGH (external power switch in OFF state) whatever the state of the input commands IN-, IN+, SD. The outputs can be switched using the command ASC as described in Section 7.15

#### HW3PS (Hardware 3 phase short)

The outputs OUT1 and OUT2 are kept LOW (external power switch in ON state) whatever the state of the input command IN-, IN+, SD and the command ASC.

After the power-on of the HV side the latched flag HVReset='1' forces the driver in SafeState (see Table 62). Other fault flags can be found set to '1' depending on the actual device external conditions, for instance the COMERRR and COMERRL state depends by the power-on timings of the two sides. At the HV side power-on the DEFAULT pin has no influence and the device always goes to SafeState.

When the device is in SafeState it remains in this condition until the flags forcing this state are cleared (see Section 7.14) moving the device to Normal operation.

When the device is Normal operation it goes to SafeState every time an event forcing this state occurs, see Section 9.2.

If the device is NORMAL OPERATION, it goes to HW3PS if the following conditions are verified:

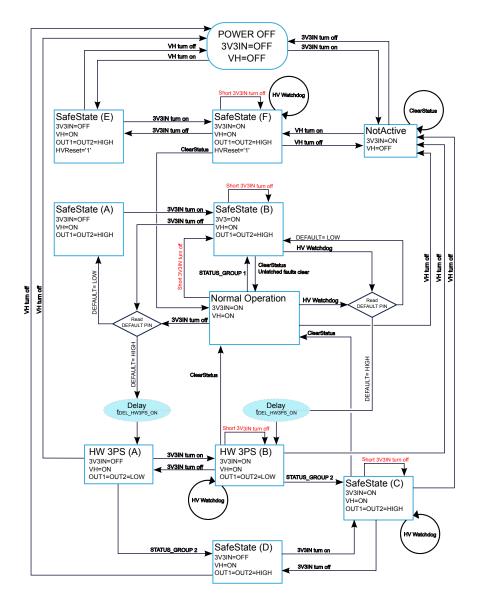
- DEFAULT = HIGH
- COMERRR bit status is set HIGH (HV side is not receiving any response from LV side, see Figure 10 and Table 62).

The device monitors the voltage on the pin DEFAULT and when the COMMERR is detected the device goes to HW3PS if DEFAULT is HIGH, otherwise the device goes to SafeState. Thus, the voltage of the DEFAULT pin must be stable when the event is detected. The outputs OUT1 and OUT2 are set LOW after a delay <sup>t</sup>DEL\_HW3PS\_ON·

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When the device is in "HW3PS" state, including the delay time t<sub>DEL\_HW3PS\_ON</sub>, if any protection mechanism of the group named STATUS\_GROUP2 is activated the device moves immediately to SafeState.

A detailed description of the power-on/power-off sequence and the operation flowchart is reported in Figure 10.



#### Figure 10. Operation flowchart

#### Notes:

- The "3V3IN turn off" is recognized by the HV side through the expiration of the communication watchdog
  that occurs whenever the HV side is not able to communicate with the LV side for any reason. The "3V3IN
  turn off" and the "HV watchdog" are shown as different events in the flowchart only to highlight the behavior
  in case of intermittent operation of the 3V3IN supply.
- The "Short 3V3IN turn off" indicates a 3V3IN turn-off condition lasting less than the HV side watchdog timer
- The STATUS\_GROUP1 includes the following fault conditions: UVLOH, UVLOL, OVLOH, OVLOL, DESAT, TSD, SENSE, REGERRL, REGERRR
- The STATUS\_GROUP2 includes the following fault conditions: UVLOH, OVLOH, DESAT, TSD, SENSE, REGERRR
- If any protection mechanism contained inside STATUS\_GROUP2 is activated during the t<sub>DEL\_HW3PS\_ON</sub> delay counting, it is interrupted and the device moves immediately to SafeState.



- The ASC pin overrides the SafeState (see Section 7.15 for a detailed description and conditions)
- The HW3PS state overrides the ASC command
- The integrated flyback controller is operative if 3V3IN is supplied. If 3V3IN is not supplied, VH must be fed by an external auxiliary supply.



# 7 Functional description

The STGAP4AS is provided with several advanced protection and diagnostic features to ease the design of reliable and rugged systems. Some of them are allocated to the High Voltage side and assume an interaction with the Low Voltage side. In order to perform these features the device is equipped with isolated communication channels between LV and HV sides.

One channel is fully committed to the transmission of the PWM command from the LV side to the HV side and in Normal Operation allows the execution of the commutation of the outputs OUT1 and OUT2 according to the truth table reported in Section 7.1.

Another interface is used to exchange DATA between the two sides, in particular:

- SPI data (HV registers write and read)
- Diagnostic information (GATE and ASC bits, Diag1 and Diag2 transition due to events on HV)
- ADC data

The device is designed to perform these tasks as long as it stably remains within the recommended operating conditions reported in Table 4.

## 7.1 Inputs and outputs

The device is controlled through the following logic inputs:

- SD: active low shutdown
- IN+: driver input
- IN-: driver input
- CS: active low chip select (SPI)
- SDI: serial data input (SPI)
- CK: serial clock (SPI)

And the following logic outputs:

- SDO: serial logic output (SPI)
- DIAG1: active low diagnostic signal 1 (open drain)
- DIAG2: active low diagnostic signal 2 (open drain)

#### Table 10. Inputs truth table, ASC ='0', OFFMODE = '0' (device NOT in "SafeState")

| SD | IN+ | IN- | OUT1 | OUT2 | 2LSO | External<br>buffer <sup>(1)</sup> | External<br>power switch<br>state |
|----|-----|-----|------|------|------|-----------------------------------|-----------------------------------|
| 0  | Х   | Х   | HIGH | HIGH | LOW  | N-ch ON                           | OFF                               |
| 1  | 0   | 0   | HIGH | HIGH | LOW  | N-ch ON                           | OFF                               |
| 1  | 0   | 1   | HIGH | HIGH | LOW  | N-ch ON                           | OFF                               |
| 1  | 1   | 0   | LOW  | LOW  | HiZ  | P-ch ON                           | ON                                |
| 1  | 1   | 1   | HIGH | HIGH | LOW  | N-ch ON                           | OFF                               |

1. P-channel connected to OUT1 and N-channel connected to OUT2.

#### Table 11. Inputs truth table, ASC = '0', OFFMODE = '1' (device NOT in "SafeState")

| SD | IN+ | IN- | OUT1 | OUT2 | 2LSO | External<br>buffer <sup>(1)</sup> | External<br>power switch<br>state |
|----|-----|-----|------|------|------|-----------------------------------|-----------------------------------|
| 0  | Х   | Х   | HIGH | HIGH | HiZ  | N-ch ON                           | OFF                               |
| 1  | 0   | 0   | HIGH | HIGH | HiZ  | N-ch ON                           | OFF                               |
| 1  | 0   | 1   | HIGH | HIGH | HiZ  | N-ch ON                           | OFF                               |
| 1  | 1   | 0   | LOW  | LOW  | HiZ  | P-ch ON                           | ON                                |

Logic I/O interface to 5V logic signals

| SD | IN+ | IN- | OUT1 | OUT2 | 2LSO | External<br>buffer <sup>(1)</sup> | External<br>power switch<br>state |
|----|-----|-----|------|------|------|-----------------------------------|-----------------------------------|
| 1  | 1   | 1   | HIGH | HIGH | HiZ  | N-ch ON                           | OFF                               |

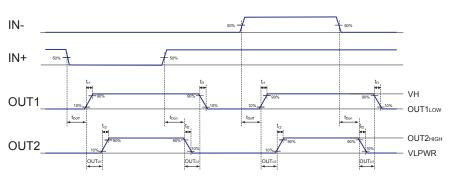
1. P-channel connected to OUT1 and N-channel connected to OUT2.

If ASC is used see Section 7.15 for details about the interaction with the logic inputs.

A programmable deglitch filter can be applied to the device inputs ( $\overline{SD}$ , IN+, IN-). Each input pulse, positive and negative, shorter than the programmed t<sub>deglitch</sub> value is neglected by the internal logic. The deglitch time can be programmed as listed in Table 5.

When the deglitch filter is disabled (INfilter = '00'), a minimum input pulse  $t_{INmin}$  is required to change the device output status. The minimum input pulse timing filters out both positive and negative pulses at the IN+, IN- and  $\overline{SD}$  pins.

A deadtime (OUT<sub>DT</sub>) is applied between OUT1 and OUT2 driver outputs signals to prevent possible crossconduction in the external push-pull stage (see Figure 11).



#### Figure 11. Input to output timing diagram

## 7.2 Logic I/O interface to 5V logic signals

The logic inputs of LV side ( $\overline{SD}$ , IN+, IN-,  $\overline{CS}$ , SDI, CK) are 5V tolerant that means that these pins can accept a recommended voltage up to 5.5V (see Table 4) and allow to interface the STGAP4S with devices that have nominal 5V output logic voltage, such as microcontroller units supplied with 5V. The STGAP4S logic inputs thresholds are referred to the 3V3IN supply voltage (see Section 4.2).

The SPI logic output SDO has a voltage range 0 to 3V3IN but it can be adapted to a 5V logic simply adding a level shifter between the driver and the MCU. Thus if a SPI daisy chain configuration is used only one level shifter is needed to make the STGAP4S SPI loop fully compatible with a 5V logic. A connection example is shown in Figure 12:

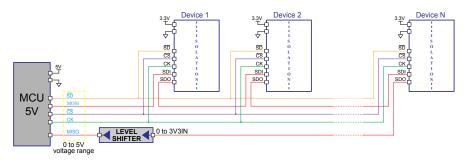
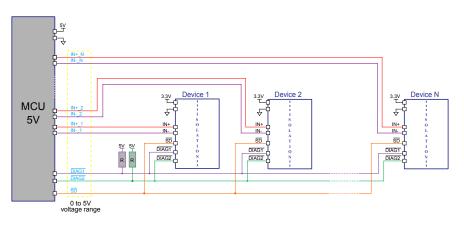


Figure 12. SPI daisy chain connection example with 5V logic

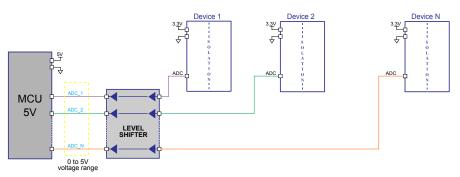


Also the open drain diagnostic outputs DIAG1 and DIAG2 are 5V tolerant, that means that these pins can be easily interfaced to a 5V logic using a pull-up resistor tied to the 5V supply as shown for example in Figure 13:



#### Figure 13. Diagnostic outputs connection example with 5V logic

Also the ADC output has a voltage range 0 to 3V3IN and, as reported for the SDO signal, it can be easily adapted to a 5V logic adding a level shifter between the device pin and the MCU as shown in Figure 14.



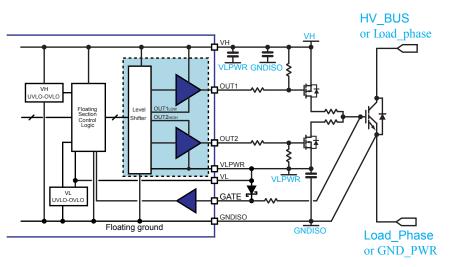
#### Figure 14. ADC outputs connection example with 5V logic

## 7.3 Outputs driving architecture

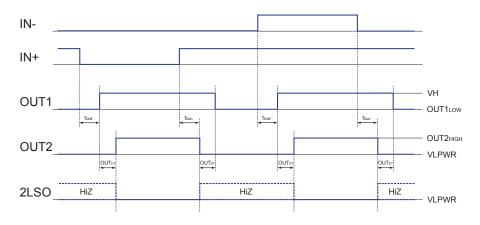
The output driving architecture is designed to allow the use of an external MOSFET push-pull stage giving high flexibility in terms of current capability dimensioning to drive the power IGBT/MOSFET stage. The 2 pre-driver outputs are characterized by current capability and output voltage swing specifically optimized for that topology. The OUT1 output is designed to drive the gate of the p-channel of the external MOSFET push-pull while OUT2 is designed to drive the gate of the complementary n-channel. The driver is provided with a dedicated VLPWR pin to connect the source of the N-channel MOSFET. The VL and the VLPWR pins must be connected together close to the device. The simplified schematic is shown in Figure 15.





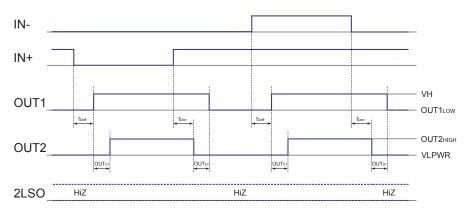


The device offers the possibility to drive the internal SOFTOFF MOSFET, connected to the 2LSO pin, at the same time of OUT2, as shown in Figure 16, allowing the turn-on of the internal SOFTOFF MOSFET at every switching cycle together with the n-channel of the external push-pull. This feature is disabled by default at the HV side power-on, as shown in Figure 17, but can be enabled by configuring OFFMODE=0 in CFG7, see Table 54. This operation mode is inhibited during and after the intervention of the "Soft turn-off" protection function, see Section 7.12 for details.









## 7.4 Gate voltage monitor (GATE PIN)

The device is equipped with a comparator dedicated to the monitoring of the gate voltage of the external power IGBT/MOSFET.

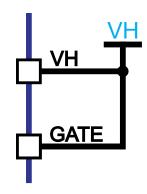
The comparator monitors the voltage of the GATE pin and reports the status in the GATE\_LEVEL\_LV bit contained in the STATUS4 register. Specifically, the comparator has a hysteresis ( $V_{GATEth_ON} - V_{GATEth_OFF}$ ) and the GATE\_LEVEL\_LV bit is set HIGH when the voltage on the GATE pin is rising and exceeds the  $V_{GATEth_ON}$  threshold, while the GATE\_LEVEL\_LV bit is set LOW when the voltage on the GATE pin is falling and goes below the  $V_{GATEth_OFF}$  threshold. To use this function the GATE pin must be connected to the gate of the external power IGBT/MOSFET through a resistor (see Figure 15).

The GATE\_LEVEL\_LV bit status can be reported to the diagnostic pins DIAG1 and DIAG2 by properly configuring the dedicated registers (DIAG1CFGA, DIAG1CFGB, DIAG2CFGA and DIAG2CFGB) (see Section 9.2.14).

The monitoring of the gate of the external power IGBT/MOSFET, connecting the GATE pin to the gate of the external power through a resistor, is mandatory if the Miller clamp function is used (see Section 7.13). If neither the Miller clamp function nor the reporting of the GATE voltage to DIAGx pins are used, to allow the

correct switching operation, the GATE pin must be connected according to one of the following ways:

- through a resistor to the gate of the external power IGBT/MOSFET, as already mentioned (see Figure 15)
- shorted to VH power supply pin (see Figure 18)



#### Figure 18. GATE PIN connection to VH

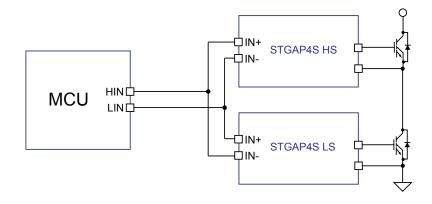
## 7.5 Deadtime and interlocking

When single gate drivers are used in half-bridge configuration, they usually do not allow preventing cross conduction in case of wrong input signals coming from the controller device. Indeed, each driver does not have the possibility to know the status of the input signal of the other companion driver in the same leg. Thanks to the availability of two input pins with opposite polarity the STGAP4S allows implementing a hardware interlocking that prevents cross conduction even in case of wrong input signals generated by the control unit.

This functionality can be achieved by implementing the connection shown in Figure 19.



#### Figure 19. HW cross conduction prevention in half-bridge configuration with two single gate drivers

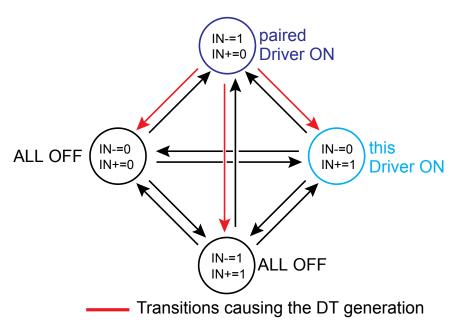


When such configuration is used, it is also possible to enable the STGAP4S programmable deadtime, which guarantees that at least DT time passes between the turn-off of one driver's output and the turn-on of the other driver. The deadtime value DT can be programmed through the SPI interface as shown in Table 5.

If the deadtime feature is enabled, a counter is started when the input status changes from < IN- = '1' and IN+ = '0' > to a different combination, which means that the other driver in the same leg is at the beginning of a turn-off (refer to Figure 20).

Once the counter is started it keeps counting regardless of any input variation until a DT time has passed, and during this time the driver prevents the turn-on of its output even if the controller tries to force the turn-on (inputs set to < IN- = '0' and IN+ = '1' >).

Once the programmed DT counter is expired, the driver immediately turns the output on as soon as a turn-on command is present at the input pins, and no extra delay is added.



#### Figure 20. Transitions causing DT generation

Some examples of the device behavior when the deadtime feature is enabled are shown from Figure 21 to Figure 24.







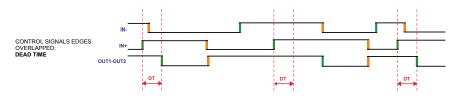
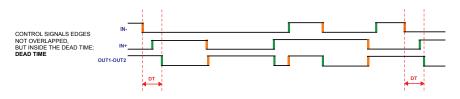
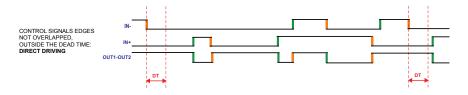


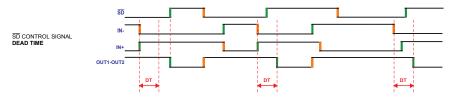
Figure 23. Control edges signal overlapped, example 2



#### Figure 24. Control edges signal not overlapped and outside DT (direct control)







When the deadtime function is enabled the STGAP4S reports a "deadtime violation" fault in case the control unit tries to turn on any of the drivers in one leg during the counting of the programmed DT time. If such event occurs, the DT\_ERR flag is set high and latched.

## 7.6 Power supply UVLO and OVLO

A programmable undervoltage protection is available on both VH and VL supply pins.

The turn-on thresholds  $VH_{on}$  and  $VL_{on}$  can be programmed through the SPI writing the CFG3 register and a fixed hysteresis sets the turn-off threshold, respectively  $VH_{hyst}$  for the VH supply and  $VL_{hyst}$  for the VL supply.

Both the UVLO protections can be independently disabled by setting the proper value of VHONth and VLONth in the CFG3 register.

When the VH voltage goes below the VH<sub>off</sub> threshold the device goes in "SafeState" and the UVLOH flag in the STATUS1 register is set high. If the UVLOIatch bit in the CFG3 register is set low (default configuration) the UVLOH status flag is set low when the VH voltage returns above the VH<sub>on</sub> threshold and the device returns to normal operation. Otherwise, if the UVLOIatch bit in the CFG3 register is set high, the UVLOH flag is latched and the device remains in "SafeState" until VH voltage is higher than the VH<sub>on</sub> and the UVLOH status flag is reset by the control unit.

When the VL voltage goes over the VL<sub>off</sub> threshold the device goes in "SafeState" and the UVLOL flag in STATUS1 register is set high. If the UVLOlatch bit in the CFG3 register is set low (default configuration) the UVLOL status flag is set low when VL voltage returns below the VL<sub>on</sub> threshold and the device returns to normal operation. Otherwise, if the UVLOlatch bit in the CFG3 register is set high, the UVLOL flag is latched and the device remains in "SafeState" until the VL voltage is lower than the VL<sub>on</sub> threshold and the flag is reset by the control unit.

An overvoltage protection is available on both VH and VL supply pins.

For the VH supply the turn-off threshold  $OVVH_{off}$  can be programmed through the SPI writing the CFG3 register and the fixed hysteresis  $OVVH_{hvst}$  sets the respective turn-on threshold.

When the VH voltage goes over the  $OVVH_{off}$  threshold, the device goes in "SafeState" and the OVLOH flag in the STATUS1 register is set high. The OVLOH flag is latched and the device remains in "SafeState" until VH voltage returns below the  $OVVH_{on}$  threshold and the flag is reset by the control unit.

For the VL supply voltage the turn-off threshold OVVL<sub>off</sub> is fixed and the hysteresis OVVL<sub>hyst</sub> sets the respective turn-on threshold.

When the VL voltage goes below the OVVL<sub>off</sub> threshold the device goes in "SafeState" and the OVLOL flag in the STATUS1 register is set high. The OVLOL flag is latched and the device remains in "SafeState" until VL voltage returns above the OVVL<sub>off</sub> threshold and the flag is reset by the control unit.

The undervoltage protection is available also on the VCC supply and on the 3V3IN supply.

For the VCC voltage the UVLO turn-on threshold  $VCC_{on}$  is fixed and the hysteresis  $VCC_{hys}$  sets the respective  $VCC_{off}$  turn-off threshold.

When the VCC voltage goes below the VCC<sub>off</sub> threshold the UVLO\_VCC flag in the STATUS3 register is set high. The UVLO\_VCC status flag is set low when the VCC voltage returns above the VCC<sub>on</sub> threshold. When the UVLO VCC protection is triggered the internal flyback controller stops switching. The controller restarts the normal operation when the UVLO VCC condition is no longer present, without the need of any external intervention. For the 3V3IN voltage the UVLO turn-on threshold UVLO3V3IN<sub>ON</sub> is fixed and the hysteresis UVLO3V3IN<sub>hys</sub> sets the respective UVLO3V3IN<sub>OFF</sub> turn-off threshold. The protection is enabled by default at the device power-on but it can be disabled setting high the bit UVLO3V3IN\_EN in the configuration register CFG1. The disabling of the UVLO3V3IN has no effect on the flyback controller section that is always stopped in case of UVLO condition on 3V3IN.

See Section 7.14 for indication on how the fault flags can be released.

## 7.7 Thermal warning and shutdown protection

The device provides a thermal warning and a thermal shutdown protection.

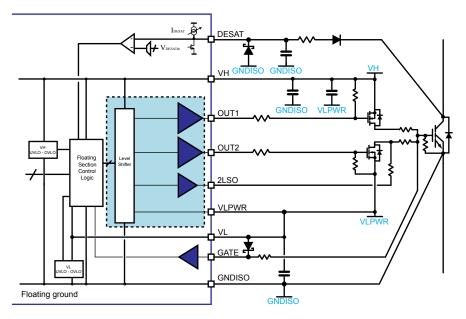
When the junction temperature reaches the  $T_{WARN}$  temperature threshold the TWN flag in the STATUS2 register is set high. The TWN flag is set low as soon as the junction temperature is lower than ' $T_{WARN}$ - $T_{hys}$ '.

When the junction temperature reaches the  $T_{SDN}$  temperature threshold, the device goes in "SafeState" and the TSD flag in the STATUS1 register is set high. The device operation is restored and the TSD flag is set low as soon as the junction temperature is lower than ' $T_{SDN}$  -  $T_{hvs}$ '.

The junction temperature can also be measured using the ADC and setting its input to "Internal IC temperature measurement" (ADC\_INPUT=1). Further details are reported in Section 7.16.7.

### 7.8 Desaturation protection

This feature allows to implement an overload protection for the external power IGBT/MOSFET. The DESAT pin monitors the  $V_{CE}/V_{DS}$  voltage of the IGBT/MOSFET when it is in on-state and if the protection threshold is reached the IGBT/MOSFET is turned off.



#### Figure 26. Example of desaturation protection connection

When the IGBT/MOSFET is off (OUT1 = OUT2 = HIGH) the DESAT pin is kept low internally and the external blanking capacitor connected to the DESAT pin is discharged. The internal current generator is fully switched off and the switch between DESAT and GNDISO pins is turned on.

When the IGBT/MOSFET is turned on (OUT1 = OUT2 = LOW) after a fixed blanking time  $t_{FBLK}$  the switch between DESAT and GNDISO pins is turned off and the internal programmable current generator ( $I_{DESAT}$ ) starts charging the external blanking capacitor.

When a desaturation event occurs the  $V_{CE}/V_{DS}$  voltage increases and if the voltage sensed at the DESAT pin reaches the desaturation threshold  $V_{DESATth}$ , the internal DESAT comparator is triggered. After the time  $t_{DESAT}$  the output is turned off (OUT1 = OUT2 = HIGH). The device goes to "SafeState" and the DESAT\_OC flag in STATUS1 register is set high approximately 200 ns later.

The DESAT comparator is not active when the external IGBT/MOSFET is off or after a desaturation detection (see Figure 27 and Figure 28).

A deglitch filter is applied to the DESAT pin; indeed each pulse exceeding the  $V_{DESATth}$  threshold for a time shorter than  $t_{DESfilter}$  does not trigger the protection.

The DESAT protection can be enabled/disabled by properly setting the DESAT\_EN bit in the CFG2 register. The V<sub>DESATth</sub> threshold and the I<sub>DESAT</sub> blanking current are programmable through the SPI interface (refer to Section 9.2).

The external power IGBT/MOSFET turning-off sequence is performed according to SAFE\_OFF and SOFT\_2LTO bit values (see Section 7.12).



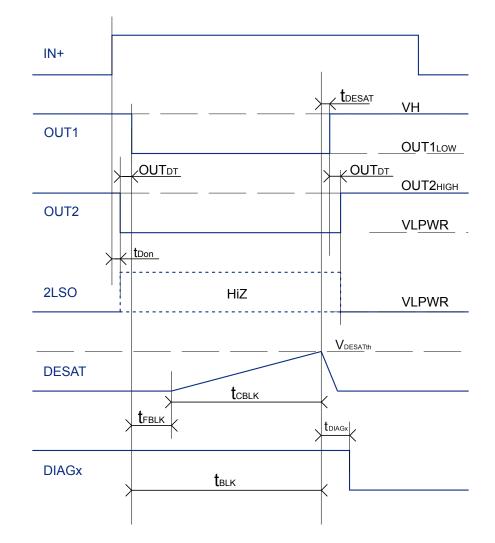


Figure 27. DESAT protection timing diagram (SAFE\_OFF = '0', OFFMODE = '0')



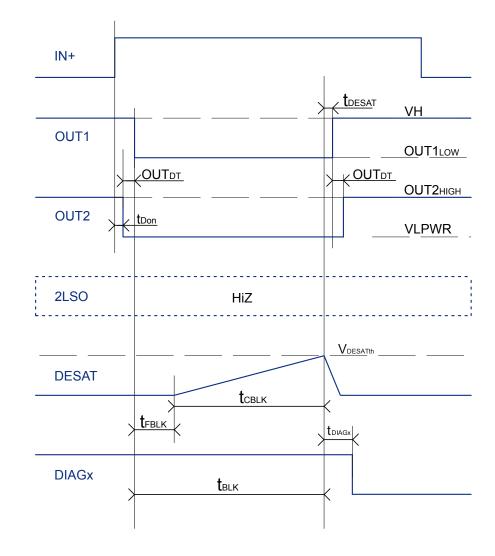


Figure 28. DESAT protection timing diagram (SAFE\_OFF = '0', OFFMODE = '1')

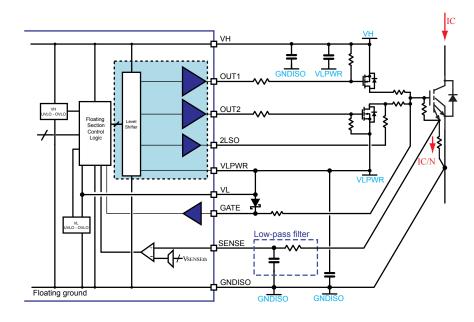
# 7.9 SENSE overcurrent protection

This function is suitable in applications in which it is possible to measure the load current through the use of a shunt resistor, or when IGBTs or MOSFETs with current sense pin are used. The load current (or a fraction of it in case senseFETs are used) is converted to voltage by an external shunt resistor and is fed to the SENSE input pin. If an overcurrent event occurs the voltage at the SENSE pin increases and when the threshold V<sub>SENSEth</sub> is reached, the SENSE comparator output is set. The output is turned off (OUT1 = OUT2 = HIGH) after a time t<sub>SENSE</sub>. The device goes to "SafeState" and the SENSE\_OC flag is set high approximately 200 ns later.

The SENSE protection can be enabled/disabled by properly setting the SENSE\_EN bit in the CFG2 register. The V<sub>SENSEth</sub> threshold is programmable through the SPI interface (refer to Section 9.2).

The external power IGBT/MOSFET turning-off sequence is performed according to SAFE\_OFF and SOFT\_2LTO bit values (see Section 7.12).





#### Figure 29. Example of SENSE overcurrent protection connection

### 7.10 Analog measurement function

The analog measurement function allows to acquire and convert into a digital representation an analog signal coming from the HV side, for instance:

- Forward voltage of diode integrated into power modules, for temperature monitoring
- Voltage drop across NTC inside power modules, for temperature monitoring
- High voltage DC bus or phase voltage sensing
- Internal IC temperature measurement

This function is realized through an acquisition system which includes, on the HV side, a pre-conditioning block followed by an ADC. The main characteristics are:

- ADC 8 bit resolution
- Fast conversion time
- Fixed conversion period t<sub>PER CONV</sub>
- Programmable input range

The analog measurement function is enabled by setting high the ADC\_EN bit in the CFG7 register.

The ADC input range can be programmed through ADC\_LOWth and ADC\_HIGHth parameters in the CFG7 register. This allows to adapt the ADC scale to the dynamic range of the input signal. The selected input range is divided in 256 uniform voltage levels.

The ADC\_INPUT bit in CFG4 defines the ADC input source, specifically:

- ADC\_INPUT = '0': Differential voltage between ADCP and ADCN
- ADC\_INPUT = '1': Internal IC temperature measurement

The ADCN pin must be connected to GNDISO (with a short path close to the device) and it is the ground reference for the external voltage to be measured. The ADCP pin is the input pin for the positive voltage to be measured.

The characteristic of the internal temperature sensor is approximately:

$$V_{TEMP} = -0.00366 * T_{INTERNAL} + 1.5V$$

(6)

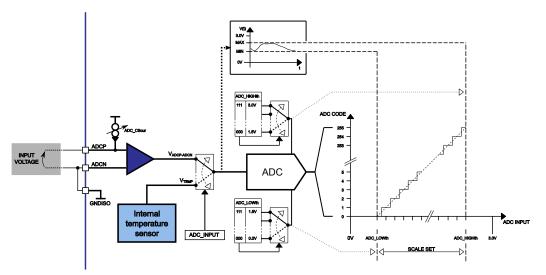
where:

- V<sub>TEMP</sub> is the internal sensor voltage applied to the input of the ADC (when ADC\_INPUT = '1')
- TINTERNAL is the absolute temperature of the internal sensor expressed in °C

The ADC input range must be programmed according to the voltage range to be converted also when the internal temperature sensor is selected.

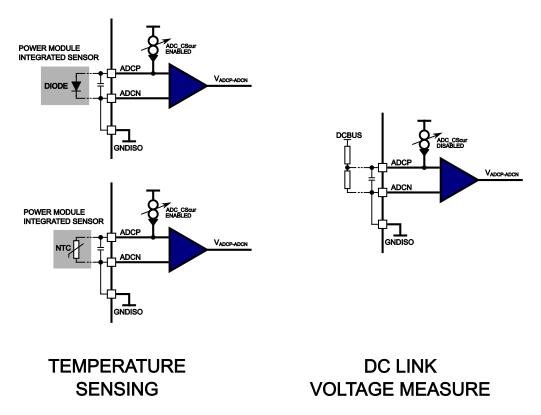
A programmable current source is available on the ADCP pin allowing the feeding of external sensors without adding external components, for instance when a NTC or a diode is used to measure the temperature of a power module. The ADC current source can be programmed trough the ADC\_CScur parameters in CFG4 register. The disable option is available.

The block diagram of the analog measurement architecture is shown in Figure 30 and some connection examples are reported in Figure 31.









The ADC output is available in two different ways:





- 1. The ADC output information is stored in a dedicated status register (STATUS5), whose content can be read through the SPI interface
- A PWM signal on the ADC pin, whose duty cycle is modulated by the ADC output code. This signal duty cycle is proportional to the ADC sampled value and varies between DC3<sub>ADC</sub> and DC1<sub>ADC</sub>. The PWM on ADC output is disabled if ADC PWM EN is set low (default configuration).

### DATA STORED IN STATUS5

If the ADC\_EN bit in CFG7 is set low, that is ADC disabled, the value in the STATUS5 register is 0xFFh.

If the ADC\_EN bit in CFG7 is set high, the value in the STATUS5 register is the data converted by the ADC.

If for any reason the value in STATUS5 is not updated for more than approximately 500 µs the value in STATUS5 is set to 0xFFh until a new updated value is stored.

#### **PWM SIGNAL ON PIN ADC:**

If the bit ADC\_PWM\_EN in CFG1 is set low the signal on pin ADC is kept low.

If the bit ADC\_PWM\_EN in CFG1 is high (PWM on ADC pin enabled) and the ADC\_EN bit in CFG7 is high (ADC enabled) the device generates a PWM signal on the pin ADC with nominal frequency 10 kHz and duty cycle proportional to the data value stored in the STATUS5 register by the following equation:

$$Duty \ cycle = DC3_{ADC} + \left(DC1_{ADC} - DC3_{ADC}\right)^* \frac{(value \ in \ STATUS5)}{(full \ scale \ value: 0xFFh)}$$
(7)

That means that:

- the minimum duty cycle is DC3<sub>ADC</sub> and matched to STATUS5=0x00h
- the maximum duty cycle is DC1<sub>ADC</sub> and matched to STATUS5=0xFFh

The duty cycle is updated every time a new conversion is stored in the STATUS5 register.

If for any reason the value in STATUS5 is not updated for more than approximately 500 us, the signal on pin ADC is kept high (duty cycle=100%) until a new updated value is stored. When a new updated value is stored in STATUS5, the duty cycle of the PWM signal on pin ADC is restored at the related consistent value.

Consistently, if the bit ADC\_PWM\_EN in CFG1 is set high (PWM on ADC pin enabled) but the ADC\_EN bit in CFG7 is set low (ADC disabled) the signal on pin ADC is kept high.

# 7.11 V<sub>CE</sub> active clamping protection

This protection is used to actively clamp the overvoltage spikes on the drain/collector of the external MOSFET/ IGBT during the turn-off.

The feedback of the drain/collector voltage to the VCECLAMP pin can be done via an element with avalanche characteristic such as a TVS. If the drain/collector voltage exceeds the breakdown voltage of the TVS, the VCECLAMP<sub>th</sub> threshold voltage is reached and the device actively slows down the turn-off of the power switch to keep a safe condition.

At the turn-off of the external MOSFET/IGBT (OUT1/OUT2 rising) a timer lasting  $t_{COUNT\_ACTIVE}$  is activated and during this observation time the VCECLAMP function is enabled and the protection can be triggered. If at the end of this timer no VCECLAMP events are detected, the VCECLAMP function is disabled up to the next turn-off event. This feature avoids spurious triggering of VCECLAMP far from the turn-off event.

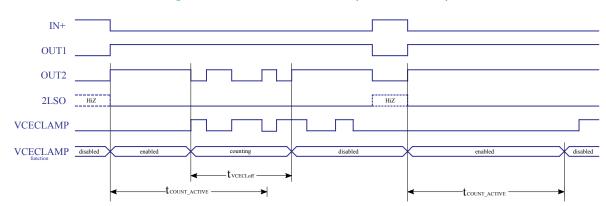
If during the observation time  $t_{COUNT\_ACTIVE}$  the protection is triggered, because the voltage on VCECLAMP pin exceeds the VCECLAMP<sub>th</sub> threshold, a new timer  $t_{VCECLoff}$  is started. As soon as this timer is activated, the timer  $t_{COUNT\_ACTIVE}$  no longer has any effect and the protection is kept enabled for a time  $t_{VCECLoff}$  starting from the first triggered event of VCECLAMP. During the time  $t_{VCECLoff}$  the protection can be triggered multiple times but when this timer expires the VCECLAMP function is disabled up to the next turn-off event.

During the time  $t_{VCECLoff}$  everytime the voltage on the VCECLAMP pin exceeds the VCECLAMP<sub>th</sub> threshold OUT2 is set LOW and the turn-off of the external power MOSFET/IGBT is performed through the internal SOFTOFF N-channel MOSFET connected to the 2LSO pin. When the voltage on VCECLAMP is below the VCECLAMP<sub>th</sub> threshold OUT2 is set HIGH and the SOFTOFF N-channel MOSFET connected to the 2LSO pin is turned off. To use this protection the 2LSO pin must be connected to the external power MOSFET/IGBT gate through a resistor.

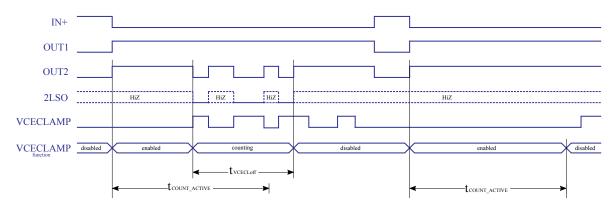
By setting the OFFMODE bit the internal SOFTOFF MOSFET can either be activated in combination with OUT2 or only when the protection is triggered. If OFFMODE=0 the SOFTOFF MOSFET is turned-on when OUT2 is HIGH and thus it is already on when a VCECLAMP event is triggered. If OFFMODE=1 the SOFTOFF MOSFET is turned on only when the VCECLAMP event is triggered.



Figure 32. VCECLAMP activation (OFFMODE = '0')







When the external power MOSFET/IGBT is on the VCECLAMP pin is masked and has no effect on the driver's outputs status .

If the SOFTOFF function is enabled (SAFE\_OFF = 1) for the use in combination with DESAT or SENSE functions (SAFE\_OFF = 1), the VCECLAMP is internally disabled when a desaturation or overcurrent event occurs. Thus, if SAFE\_OFF = 1 and a desaturation or overcurrent event occurs the VCECLAMP is not performed. The function is again enabled at the next turn-off event of the external MOSFET/IGBT.

| Table 12 | 2. VCECLAMP in case of I | DESAT/SENSE event |
|----------|--------------------------|-------------------|
|----------|--------------------------|-------------------|

| SAFE_OFF | VCECLAMP                              |
|----------|---------------------------------------|
| 0        | Enabled                               |
| 1        | Disabled in case of DESAT/SENSE event |

To correctly perform the VCE active clamping protection the GATE pin must be connected according to one of the following ways:

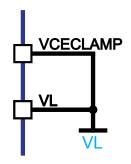
- through a resistor to the gate of the external power IGBT/MOSFET, if the monitoring of the gate or the Miller Clamp functions are used
- shorted to VH power supply pin, if neither the monitoring of the gate nor the Miller Clamp functions are used

See Section 7.4 for details.

If the V<sub>CE</sub> active clamping protection is not used the VCECLAMP pin must be connected to VL as reported in Figure 34.



### Figure 34. VCECLAMP disabling



# 7.12 Soft turn-off

The Soft turn-off (SOFTOFF) function can be used to slow down the turn-off of the external MOSFET/IGBT in case of turn-off due to an overcurrent condition, thus reducing the overvoltage spike on the drain/collector. The type of turn-off performed when a DESAT or SENSE event occurs is set configuring the SAFE\_OFF and SOFT\_2LTO bits. As reported in Table 13, two possible turn-off modes can be selected, the standard described in Section 7.8 and Section 7.9 or the SOFTOFF described below:

#### Table 13. Turn-off functions at DESAT or SENSE triggering

| SAFE_OFF | SOFT_2LTO | Turn-off function |
|----------|-----------|-------------------|
| 0        | 0         | Standard          |
| 1        | 0         | SOFTOFF           |

The Soft turn-off function (SOFTOFF) switches off the external power MOSFET/IGBT using the internal N-channel MOSFET connected to the 2LSO pin. To use this protection the 2LSO pin must be connected to the external power MOSFET/IGBT gate through a resistor. If SAFE\_OFF='1' and SOFT\_2LTO='0', when a DESAT or SENSE overcurrent is triggered, OUT1 is immediately set HIGH and after a time OUT<sub>DT</sub> the SOFTOFF internal MOSFET is turned on, while OUT2 is kept LOW. In this way, selecting the proper resistor value of the Soft turn-off path, the turn-off of the external power MOSFET/IGBT can be slower compared to a standard turn-off sequence performed turning on the n-channel of the push-pull by setting HIGH OUT2. Afterwards, to complete the external power MOSFET/IGBT turn-off, the SOFTOFF internal MOSFET is turned off and OUT2 is set HIGH, activating the n-channel of the external push-pull, at the occurrence of one of the following events:

- the expiration of the time t<sub>2LTO\_SOFTtime</sub>
- the voltage on the GATE pin has reached the V<sub>GATEth\_OFF</sub> voltage threshold (before the expiration of the time t<sub>2LTO\_SOFTtime</sub>)

To correctly perform the Soft turn-off function the GATE pin must be connected according to one of the following ways:

- through a resistor to the gate of the external power IGBT/MOSFET, if the monitoring of the gate or the Miller Clamp functions are used
- shorted to VH power supply pin, if neither the monitoring of the gate nor the Miller Clamp functions are used

See Section 7.4 for details.

The protection timing diagram is shown in Figure 35 and Figure 36 for the DESAT protection but, in principle, for the SENSE protection is analogous.



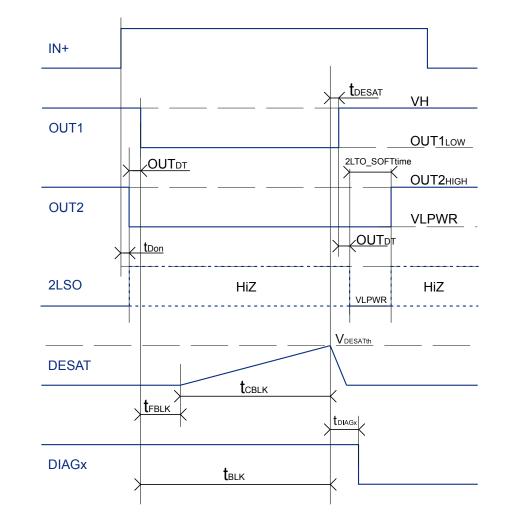
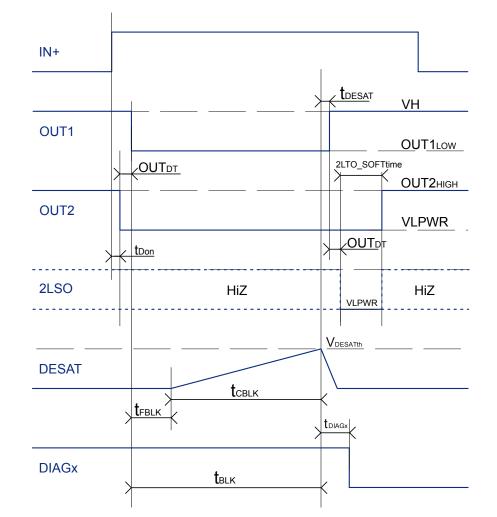


Figure 35. DESAT protection timing diagram (SAFE\_OFF = '1' - SOFT\_2LTO = '0' - OFFMODE = '0')



### Figure 36. DESAT protection timing diagram (SAFE\_OFF = '1' - SOFT\_2LTO = '0' - OFFMODE = '1')

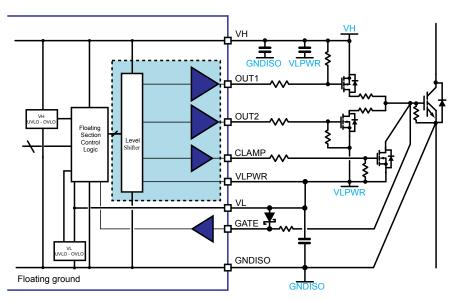
# 7.13 Miller clamp function

The Miller clamp function allows the control of the Miller current during the power stage switching in half-bridge configurations, preventing the cross-conduction that might be caused by gate spikes. When the external power transistor is in the off-state, the driver operates to avoid the induced turn-on phenomenon that may occur when the other switch in the same leg is being turned on, due to the Miller capacitance.

The gate of the external switch is monitored through the GATE pin and during a turn-off commutation the gate of the external CLAMP switch is activated when the voltage on the GATE pin goes below the voltage threshold  $V_{GATEth_OFF}$ . The CLAMP pin can drive an external low-voltage N-channel MOSFET, thus creating a low impedance path between the switch gate and the VLPWR pin.

To correctly perform the Miller clamp function the GATE pin must be connected through a resistor to the gate of the external IGBT/MOSFET power (see Section 7.4).

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### Figure 37. Example of Miller clamp protection connection

## 7.14 Fault management

The device provides advanced diagnostics through open drain outputs (DIAG1 and DIAG2) and internal status registers.

Status registers (STATUS1, STATUS2, STATUS3, STATUS4, STATUS5) provide fault and status information as listed in the related sections.

DIAG1 and DIAG2 pins can be independently programmed through the dedicated registers (DIAG1CFGA, DIAG1CFGB, DIAG2CFGA and DIAG2CFGB) to signal one or more fault conditions. The state of each diagnostic output pin is the result of the NOR of the associated status bits, thus if one of the selected status bits is high the related DIAGx output is set low.

Some of the fault conditions reported by the status registers are latched, that means that the flag remains set high even if the triggering condition is no longer present.

The fault flags contained in the status registers can be cleared by a *ClearStatus* operation that can be executed by two methods:

#### • the SPI command ResetStatus

The  $\overline{SD}$  pin must be set low before this command and must remain low until the end of the command's execution time. This is the recommended method, because it guarantees that the status registers are cleared only by direct intervention of the MCU. All the flags in the status registers are cleared after a t<sub>desCS RST</sub> time following the rising edge of the SPI  $\overline{CS}$  (see Section 9.1.4).

#### • the SDReset driving the SD pin

All the flags are cleared after the rising edge of the  $\overline{SD}$  pin setting low the  $\overline{SD}$  pin for at least a t<sub>release</sub> time. This mode is enabled by default at the device power-on but it can be disabled configuring SD\_FLAG='0' in CFG1, avoiding the possibility to clear the flags without the direct intervention of the MCU. Even with SD\_FLAG='1', the SDReset is not executed if before the rising edge of the SD pin a rising edge of the CK occurs while  $\overline{CS}$  is low. This prevents the unintentional clearing of errors that may have been generated during the SPI communication, for instance a configuration sequence. In this case, to be able to execute a SDReset, a rising edge of the  $\overline{CS}$  must happen before setting low again the  $\overline{SD}$  pin.

The possibility to clear the status registers by SDReset allows to operate the device also without using the SPI interface. In case the SPI is used, it is recommended to disable this functionality by configuring SD\_FLAG='0' to avoid the unintentional clearance of fault conditions.

Selected faults force the device in "SafeState"; the device remains in this state until the related status flags are released. Refer to Table 60, Table 62, Table 64, Table 66 for details.



# 7.15 Asynchronous stop command

The ASC pin allows to turn on the external power switch acting directly on the HV side driver logic, regardless of the status of the primary side. Indeed, the ASC function works also if the primary-side 3V3IN supply voltage is not present or in UVLO condition. The faults on the LV side haven't any effect on the ASC function. The power supply of the HV side, both VH and VREGISO, must be present and have completed the start-up transient. If the primary side is supplied and no faults are present the ASC pin works according to Table 14:

### Table 14. ASC truth table

| ASC | External power switch state |
|-----|-----------------------------|
| 0   | See Table 10 and Table 11   |
| 1   | ON                          |

If the HV side is in HW3PS state the ASC command is overridden, thus OUT1 and OUT2 are LOW (External power switch in ON state) even if ASC=0 (see Section 6.4).

In relation to the HV side protection functions the behavior of the ASC pin is as described in Table 15 :

| Protection       | Protection configuration | ASC functionality   |  |  |  |  |  |
|------------------|--------------------------|---|--|--|--|--|--|
|                  | Enabled                  | ASC active if VH supply is not in UVLO condition  |  |  |  |  |  |
| VHOVEO           | Disabled                 | ASC active if VH supply is within recommended operating values  |  |  |  |  |  |
| VH OVLO          | -                        | ASC is not active   |  |  |  |  |  |
| VL UVLO          | -                        | ASC is active   |  |  |  |  |  |
| VL OVLO          | -                        | ASC is active   |  |  |  |  |  |
| REGERRR          | -                        | ASC is active   |  |  |  |  |  |
| COMERRR          | -                        | ASC is active   |  |  |  |  |  |
| Thermal Warning  | -                        | ASC is active   |  |  |  |  |  |
| Thermal Shutdown | -                        | ASC is not active while in thermal shutdown protection  |  |  |  |  |  |
| DESAT            | Enabled                  | The rising edge of ASC turns on the external power switch regardless of<br>DESAT_OC flag status in the STATUS1 register.If a DESAT event occurs, detected when the DESAT pin exceeds the threshold<br>selected, the external power switch is turned off and the DESAT_OC is set or<br>confirmed high. ASC can turn on again the external power switch with a new<br>ASC rising edge.If a ClearStatus command clears the DESAT_OC flag while ASC is high the<br>external power switch maintains the present status.After a ClearStatus one of the following input combinations must be set to<br>enable the output turn-on:IN+ IN- SD ASC<br>X X 0 0<br>X 1 X 0<br>0 X X 0 |  |  |  |  |  |
| SENSE            | Enabled                  | The rising edge of ASC turns on the external power switch regardless of SENSE_OC flag status in the STATUS1 register.<br>If a SENSE event occurs, detected when the SENSE pin exceeds the selected threshold, the external power switch is turned off and the SENSE_OC is set or confirmed high. ASC can turn on again the external power switch with a new ASC rising edge.<br>If a ClearStatus command clears the SENSE_OC flag while ASC is high the external power switch maintains the present status.   |  |  |  |  |  |

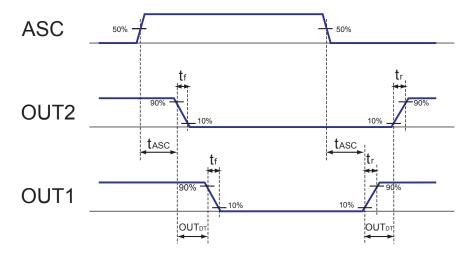
### Table 15. ASC interaction with protection functions



| Protection | Protection configuration | ASC functionality   |     |    |     |  |  |  |
|------------|--------------------------|---|-----|----|-----|--|--|--|
|            |                          | After a ClearStatus one of the following input combinations must be set to enable the output turn-on: |     |    |     |  |  |  |
|            |                          | IN+   | IN- | SD | ASC |  |  |  |
|            |                          | х   | Х   | 0  | 0   |  |  |  |
|            |                          | Х   | 1   | Х  | 0   |  |  |  |
|            |                          | 0   | х   | Х  | 0   |  |  |  |

The ASC function is active also when the device is in Configuration Mode.

The status of this pin is reported in the ASC\_LEVEL\_LV bit present in the STATUS4 register.



### Figure 38. ASC to OUT1 and OUT2 timing diagram

# 7.16 Security check functions

The device allows to verify the integrity of many important features through the following security checks:

- OUT1/OUT2 to gate path
- DESAT
- DEFAULT functionality
- SENSE resistor connection
- SENSE comparator
- CLAMP driver
- ADC

These check modes are enabled through a dedicated configuration register TEST1 (refer to Section 9.2.13) and thus require entering into configuration mode to be performed.

To execute the checks correctly the following points must be considered:

- only one check at a time must be enabled
- it is mandatory to execute a ClearStatus before executing each check
- before operating the driver in normal mode the TEST1 register must be set to 0x00
- · it is recommended to execute a ClearStatus after having disabled each check
- to prevent the SD from clearing the STATUS flags it is recommended to set the SD\_FLAG='0'
- ASC must be kept low during all the tests
- a "gate turn-on" is obtained setting: SD=HIGH, IN-=LOW, IN+=HIGH
- a "gate turn-off" is obtained setting: SD=HIGH, IN-=LOW, IN+=LOW



### 7.16.1 OUT1/OUT2 to gate path

The purpose of this security check is to verify the correct operation of the internal gate comparators and the gate path integrity including the driver's OUT1 and OUT2 outputs, the external push-pull MOSFETs, the gate resistor and the power switch gate.

To perform the check the following steps must be executed:

- Set SD="LOW"
- Send ResetStatus command
- Send StartConfig command
- Set OUT1OUT2CHK='1'
- Set SD\_FLAG='0'
- Set ADC\_EN='1'
- Set properly the ADC parameters (ADC\_HIGHth, ADC\_LOWth)
- Send StopConfig command
- Set SD="HIGH"
- Apply to the input a "gate turn-on" (ON PHASE)
- Wait 20 us
- Read TWN, PROGHV, REGERRR (STATUS2)
- Read GATE\_LEVEL\_LV (STATUS4)
- Read the ADC output code (STATUS5)
- Apply to the input a "gate turn-off" (OFF PHASE)
- Wait 20 us
- Read TWN, PROGHV, REGERRR (STATUS2)
- Read GATE\_LEVEL\_LV (STATUS4)
- Read the ADC output code (STATUS5)

During the test the outputs are driven according to the inputs and during the reading the input state must be kept stable.

The test can be considered passed if the following conditions are verified:

- during the ON PHASE: TWN='1', PROGHV='1' and REGERRR='1'
- during the OFF PHASE: TWN='0', PROGHV='0' and REGERRR='0'

Otherwise the test has failed.

When the check is enabled by setting OUT1OUT2CHK='1' the comparator outputs are reported to the registers in the following way:

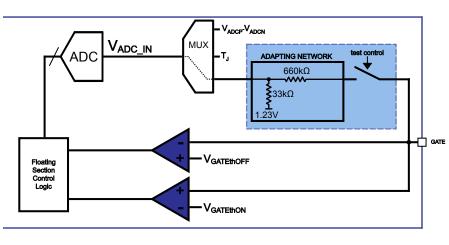
|        | "1" if  | "0" if   |
|--------|---|--|
| TWN    | COMP_ON <sub>OUT</sub> is HIGH                        | COMP_ON <sub>OUT</sub> is LOW                          |
| PROGHV | COMP_OFF <sub>OUT</sub> is LOW                        | COMP_OFF <sub>OUT</sub> is HIGH                        |
| REGERR | GATE level is HIGH                                    | GATE level is LOW                                      |
|        | Expected combination during the ON PHASE with test OK | Expected combination during the OFF PHASE with test OK |

### Table 16. OUT1/OUT2 to gate path check – Bits mapping

Additionally, during each phase the GATE level is reported to GATE\_LEVEL\_LV bit in STATUS4 register and the actual voltage of the GATE pin is available in STATUS5 register as ADC output code.

The voltage of the GATE pin must be stable within approximately 2us from the "gate turn-on"/"gate turn-off" commands.

When the security check is activated a test control switch is closed and the input of the ADC is internally diverted to the GATE pin through a dedicated adapting network as reported in Figure 39:



### Figure 39. OUT1/OUT2 to gate path check

This test allows to measure and check the VH and VL supply voltages, indeed during the ON PHASE the voltage of the gate of the external power IGBT/SiC is the VH voltage while during the OFF PHASE is the VL voltage. The input voltage of the ADC can be calculated with the following equation:

$$V_{ADC_{IN}} = (V_{GATE} - 1.23V)^* \left(\frac{33k\Omega}{660k\Omega + 33k\Omega}\right) + 1.23V$$
(8)

where:

- V<sub>ADC\_IN</sub> is the input voltage of the ADC referred to GNDISO
- V<sub>GATE</sub> is the voltage of the GATE pin referred to GNDISO

To allow the correct execution of this measure, the ADC must be enabled setting ADC\_EN = '1 in CFG7 configuration register and the ADC input range must be properly programmed according to the voltage range to be converted configuring the ADC\_LOWth and the ADC\_HIGHth bits. These operations can be done in the configuration sequence that activates the test.

At the end of the test, to return to the correct operation of the driver, the check function must be disabled configuring OUT1OUT2CHK='0' in the configuration register TEST1 and afterwards a ClearStatus must be executed to clear any latched fault. Also the ADC parameters (ADC\_EN, ADC\_HIGHth, ADC\_LOWth, ADC\_INPUT) must be configured back to the values used in application.

### 7.16.2 DESAT

This check allows to verify the correct operation of the DESAT functionality and to detect a short on the DESAT pin.

To perform the check the following steps must be executed:

- Set SD ="LOW"
- Send ResetStatus command
- Send StartConfig command
- Set DESAT\_EN='1'
- Configure DESAT parameters (DESATcur and DESATth)
- Set DESCHK='1'
- Set SD\_FLAG='0'
- Send StopConfig command
- Set SD="HIGH"
- Apply to the input a "gate turn-on" for at least t<sub>DES chk</sub> (see below definition)
- Read DESAT\_OC flag

The test can be considered passed if DESAT\_OC='1', otherwise the test has failed.

When DESAT check is activated, the turn-on command received by HV side is not transmitted to OUT1 and OUT2 outputs and the external power MOSFET/IGBT remains OFF.



During the test ASC must be kept LOW and the external MOSFET/IGBT's drain/collector must be in high impedance state.

When gate turn-on is applied, after the fixed blanking time,  $I_{DESAT}$  starts charging the external blanking capacitor. In correct operation the voltage of the input pin DESAT rises and after a time  $t_{DES_chk}$  it surpasses  $V_{DESATth}$ .

The test result is determined by the flag DESAT\_OC as follows:

- DESAT\_OC='1' if (V<sub>DESATcomp</sub> > V<sub>DESATth</sub>) which means test PASSED
- DESAT\_OC='0' if (V<sub>DESATcomp</sub> < V<sub>DESATth</sub>) which means test FAILED

Basically, the time  $t_{\text{DES}\ chk}$  can be approximately calculated with the following equation:

$$t_{DES\_chk} \approx t_{Don(MAX)} + t_{FBLK(MAX)} + \frac{V_{DESATth(MAX)} \cdot C_{DESAT}}{I_{DESAT(MIN)}}$$
(9)

To obtain the actual value the specific case in the application must be considered, indeed the equivalent capacitance seen through the resistor and the diode causes a longer time.

At the end of the test, to return to the correct operation of the driver, the check function must be disabled configuring DESCHK='0' in the configuration register TEST1 and afterwards a ClearStatus must be executed to clear any latched fault.

### 7.16.3 DEFAULT functionality

This check allows to verify:

- the watchdog mechanism
- the correct setting of the outputs OUT1/OUT2 in case of HV watchdog expiration
- the correct connection of the DEFAULT pin in application

The test is differentiated for the two possible cases, DEFAULT expected low and DEFAULT expected high.

### **CASE 1 – DEFAULT expected low**

- Set SD="LOW"
- Send ResetStatus command
- Send StartConfig command
- Set DEFAULTCHK='1'
- Set GATECHK='1'
- Set SD FLAG='0'
- Send StopConfig command
- Set SD="HIGH"
- Wait 10 us + t<sub>DEL\_HW3PS\_ON</sub>
- Read GATE\_LEVEL\_LV
- Read COMMERRR, COMMERRL

### The test can be considered passed if:

- GATE\_LEVEL\_LV='0'
- COMMERRR='1'
- COMMERRL='1'

### Otherwise the test has failed.

Internally the device executes the following actions:

- S1 is closed and S2 is opened (see Figure 40)
- Periodical refresh from HV to LV is stopped

### CASE 2 – DEFAULT expected high

- Set SD="LOW"
- Send ResetStatus command
- Send StartConfig command
- Set DEFAULTCHK='1'
- Set GATECHK='0'
- Set SD\_FLAG='0'





- Send StopConfig command
- Set SD="HIGH"
- Wait 10 us + t<sub>DEL\_HW3PS\_ON</sub>
- Read GATE\_LEVEL\_LV
- Read COMMERRR, COMMERRL

The test can be considered passed if:

- GATE\_LEVEL\_LV='1'
- COMMERRR='1'
- COMMERRL='1'

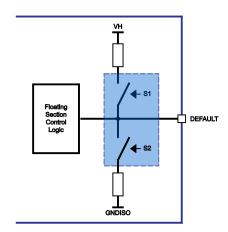
Otherwise the test has failed.

Internally the device executes the following actions:

- S2 is closed and S1 is opened (see Figure 40)
- Periodical refresh from HV to LV is stopped

The device follows the flow described in the "Operation flow chart", thus if the DEAFULT pin is high the output is set as for the HW3PS state.

#### Figure 40. DEFAULT functionality check



At the end of the test, to return to the correct operation of the driver, the check function must be disabled configuring DEFAULTCHK='0' in the configuration register TEST1 and afterwards a ClearStatus must be executed to clear any latched fault.

### 7.16.4 SENSE resistor

This check allows to verify the connection to the external sense resistor on the SENSE pin.

To perform the check the following steps must be executed:

- Set SD="LOW"
- Send ResetStatus command
- Send StartConfig command
- Set SENS\_EN='1'
- Set RSNSCHK='1'
- Set SD FLAG='0'
- Send StopConfig command
- Set SD="HIGH"
- Wait at least t<sub>Rchk</sub>
- Read SENSE\_OC flag

The test is passed if SENSE\_OC='0', otherwise the test has failed.



The test is performed sourcing a small current I<sub>SENSERchk</sub> to the SENSE pin. If, for some reason, the pin is floating the voltage rises until exceeding V<sub>SENSEth</sub> and SENSE\_OC='1' is reported in the STATUS1 register. Otherwise, if the pin is correctly shunted, the voltage on the pin remains below V<sub>SENSEth</sub>. The minimum time to have a reliable value in SENSE\_OC is t<sub>Rchk</sub> (SENSE resistor check time).

If an external filter network is present this must be taken into account. To perform the check correctly the voltage drop on the filter, when the  $I_{SENSERchk}$  current is sourced, must be lower than the  $V_{SENSEth}$ , otherwise the test is not passed although the shunt is correctly connected. Also the minimum time to have a reliable result is impacted by the filter and the correct time value to wait must be checked for each specific case.

At the end of the test, to return to the correct operation of the driver, the check function must be disabled configuring RSNSCHK='0' in the configuration register TEST1 and afterwards a ClearStatus must be executed to clear any latched fault.

### 7.16.5 SENSE comparator

This check allows to verify the functionality of the internal sense comparator.

To perform the check, the following steps must be executed:

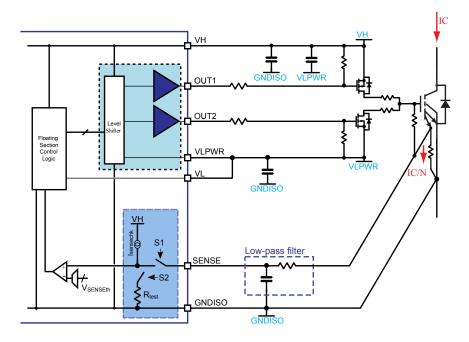
- Set SD="LOW"
- Send ResetStatus command
- Send StartConfig command
- Set SENS\_EN='1'
- Set SNSCHK='1'
- Set SD\_FLAG='0'
- Send StopConfig command
- Set SD="HIGH"
- Wait at least t<sub>Rchk</sub>
- Read SENSE\_OC flag

The test is passed if SENSE\_OC='1', otherwise the test has failed.

Internally, when the check is enabled, S1 is open and S2 is closed (see Figure 41). The test current  $I_{sensechk}$  generates a voltage on test resistor  $R_{test.}$  If the voltage is greater than  $V_{SENSEth}$  an overcurrent is triggered and the device sets SENSE OC='1'. If SENSE OC='0' something is not correctly working.

At the end of the test, to return to the correct operation of the driver, the check function must be disabled configuring SNSCHK='0' in the configuration register TEST1 and afterwards a ClearStatus must be executed to clear any latched fault.

#### Figure 41. SENSE comparator check



### 7.16.6 CLAMP driver

This check allows to verify the functionality of the Miller clamp output stage.

To perform the check, the following steps must be executed:

- Set SD="LOW"
- Send ResetStatus command
- Send StartConfig command
- Set MCPCHK='1'
- Set SD FLAG='0'
- Send StopConfig command
- Set SD="HIGH"
- Apply at the input a "gate turn-on" command (ON PHASE)
- Wait at least 10 us
- Read GATE\_LEVEL\_LV flag
- Apply at the input a "gate turn-off" command (OFF PHASE)
- Wait at least 10 us
- Read GATE\_LEVEL\_LV flag

During the test, the outputs are driven according to the inputs and during the reading the input state must be kept stable.

The test can be considered passed if the following conditions are verified:

- during the ON PHASE: GATE\_LEVEL\_LV='1'
- during the OFF PHASE: GATE\_LEVEL\_LV='0'

Otherwise the test has failed.

Internally the device keeps OUT2=LOW also during the OFF PHASE performing the "gate turn-off" through the external N-channel MOSFET driven by the CLAMP pin.

The voltage of the GATE pin must be stable within approximately 2us from the "gate turn-on"/"gate turn-off" commands. If more time is needed this must be added to the "wait time" after the command.

At the end of the test, to return to the correct operation of the driver, the check function must be disabled configuring MCPCHK='0' in the configuration register TEST1 and afterwards a ClearStatus must be executed to clear any latched fault.



### 7.16.7 ADC functionality check

This check allows to verify the functionality of the internal ADC.

- To perform the check, the following steps must be executed:
- Set SD="LOW"
- Send ResetStatus command
- Send StartConfig command
- Set ADC\_EN='1'
- Set ADC\_INPUT='0'
- Set ADCCHK='1'
- Set SD\_FLAG='0'
- Send StopConfig command
- Wait at least 20 us
- Read TWN (STATUS2)

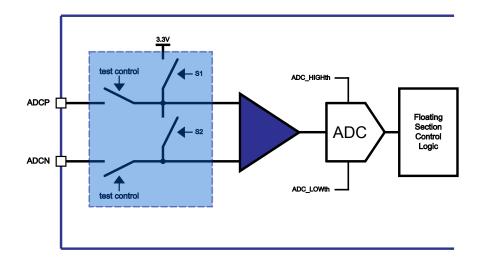
The test is passed if TWN='1', otherwise the test has failed.

Internally the device executes the following steps:

- the switches in series to ADCP and ADCN are opened.
- the ADC output code register is internally forced to "00001111"
- the differential input of the ADC is internally forced to VREGISO (S1 closed, S2 open, see Figure 42)
- if the ADC output code is "11111111" this internal test phase is OK, otherwise FAIL
- the differential input of the ADC is internally forced to 0V (S1 open, S2 closed, see Figure 42)
- if the ADC output code is "00000000" this internal test phase is OK, otherwise FAIL

If both the internal test phases are OK the device sets TWN='1', otherwise the device sets TWN='0'.





At the end of the test, to return to the correct operation of the driver, the check function must be disabled configuring ADCCHK='0' in the configuration register TEST1 and afterwards a ClearStatus must be executed to clear any latched fault. The ADC parameters (ADC\_EN, ADC\_HIGHth, ADCLOWth, ADC\_INPUT) must be configured back to the values used in application.

# 7.17 Registers corruption protection

All the configuration registers are protected against content corruption.

If the value of a local configuration register changes without the execution of a proper command (the configuration sequence or the SoftReset) the REGERRL flag is set HIGH and the device is forced in "SafeState" or remains in "HW3PS" if this is the current state. See details in Section 6.4.



If the value of a remote configuration register changes without the execution of a proper command (the configuration sequence or the SoftReset) the REGERRR flag is set HIGH and the device is forced in "SafeState".

# 8 SPI interface

7/

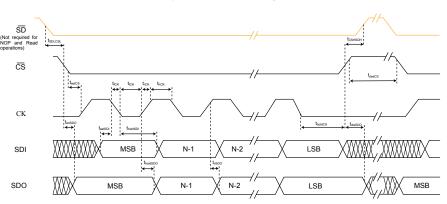
The STGAP4S communicates with an external MCU through a 16-bit SPI. This interface is used to set the device parameters and for advanced diagnostics.

The SPI commands are executed after the rising edge of  $\overline{CS}$  and adequate wait time must be respected before a new command is started by setting  $\overline{CS}$  low again. Refer to the  $\overline{CS}$  deselect time parameters in Section 4.2 for required wait time after each command.

The SPI I/O pins are:

- <u>CS</u>: chip select (active low)
- CK: serial clock
- SDI: serial data input (MOSI)
- SDO: serial data output (MISO).

The interface uses the SPI configuration CPHA = 1 and CPOL = 0 (serial data is sampled on CK falling edge and it is updated on CK rising edge, at the  $\overline{CS}$  falling edge the CK signal must be low) as shown in Figure 43.



#### Figure 43. SPI timings

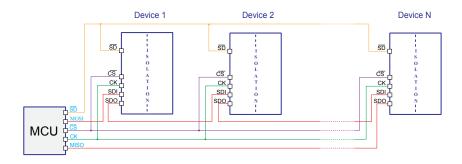
The SPI interface can work with a clock CK up to 5 Mbps and allows the connection of multiple STGAP4S devices in a daisy chain. The SDO output must be connected only to logic inputs of other devices.

In order to guarantee a safe operation and robustness to electrical noise, the number of rising edges within a  $\overline{CS}$  negative pulse must be multiples of 16, otherwise the communication cycle is ignored and an error is reported setting high the SPI\_ERR flag.

In the daisy chain topology any number of the STGAP4S can be connected and only four SPI lines and one for the SD are required in order to access the status and configuration registers of each device. An example of daisy chain configuration is shown in Figure 44.

Each device in the chain can be configured independently allowing, for instance, the differentiation of the configuration for the high-side and low-side drivers.

#### Figure 44. SPI daisy chain connection example





## 8.1 CRC protection

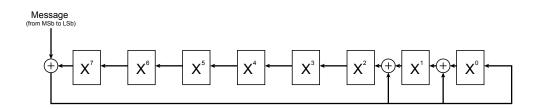
All the commands and data bytes must be followed by a CRC code.

At the power-on or after a SoftReset the SPI CRC is disabled by default (CRC\_SPI='0') and the STGAP4S does not consider the content of the CRC byte. In this case the host must transmit the CRC byte anyway although the STGAP4S does not use it for integrity checks. The STGAP4S generates the correct CRC byte in response to the SPI access also with the CRC disabled.

If the SPI CRC is enabled by setting CRC\_SPI='1', the CRC byte transmitted by the host is used by the device to check the integrity of the data byte and an error in the CRC check causes the related data byte to be ignored and the SPI\_ERR flag is set high.

The polynomial generator of the CRC code is  $X^{8}+X^{2}+X+1$  corresponding to the block diagram in Figure 45.

#### Figure 45. Block diagram of the CRC generator



The host must transmit to the device the inverted CRC code computed using the following procedure:

- Initialize CRC to all 1
- Start the calculation from the most significant bit of the message
- Invert the CRC result

In case of a WriteReg command, the CRC of the data byte (i.e. the new register value) must be calculated initializing the computation system to the CRC of the command byte previously calculated (i.e.: the CRC is calculated on a 16-bit message composed by the command + data byte). In this way a data byte cannot be accepted as a command byte and vice versa.

The device always transmits a response byte followed by a CRC computed using the same polynomial generator  $(X^8 + X^2 + X + 1)$ . The CRC byte transmitted by the device is not inverted.

If no response is required, the word returned by the device has no meaning and it should be discarded.

# 9 Programming manual

# 9.1 SPI commands

The SPI interface is provided with a set of commands that allow the configuration of the device as well as the access to the advanced diagnostic.

The NOP and the ReadReg command, dedicated to the registers content read as described in Section 9.1.3, can be executed without stopping the PWM, as long as the SPI signals are not distorted by noise affecting the integrity of the communication.

The ResetStatus command, dedicated to the clearing of the fault flags as described in Section 9.1.4, is executed only when the SD pin is LOW, thus when the PWM is not running.

The device has a one position FIFO buffer (First In First Out) that, in case the LV side recognizes that the HV side is powered-off, stores the last ReadReg or ResetStatus command received. Afterwards the LV side sends the stored command to the HV side as soon as it recognizes that the HV side is powered-on.

Some commands are dedicated to the configuration of the device and also in this case the execution is performed only when the  $\overline{SD}$  pin is LOW, corresponding to the condition with PWM not running, and furthermore the modification of the configuration registers content is allowed only when the device is Configuration Mode. The suggested flow is reported in Figure 46.

The commands summary is given in Table 17

#### Table 17. SPI commands

| Command<br>mnemonic |   | Command value |   |   |   |   |   |   | Action                               | Notes                         |
|---------------------|---|---------------|---|---|---|---|---|---|--------------------------------------|-------------------------------|
| StartConfig         | 0 | 0             | 1 | 0 | 1 | 0 | 1 | 0 | Device configuration start           | Enter CFG mode<br>SD low only |
| StopConfig          | 0 | 0             | 1 | 1 | 1 | 0 | 1 | 0 | Device configuration/check completed | Leave CFG mode<br>SD low only |
| NOP                 | 0 | 0             | 0 | 0 | 0 | 0 | 0 | 0 | No operation                         |                               |
| WriteReg            | 1 | 0             | 0 | А | А | А | А | А | Write AAAAA register                 | CFG mode only                 |
| ReadReg             | 1 | 0             | 1 | А | А | А | А | А | Read AAAAA register                  |                               |
| ResetStatus         | 1 | 1             | 0 | 1 | 0 | 0 | 0 | 0 | Reset all the status registers       | SD low only                   |
| SoftReset           | 1 | 1             | 1 | 0 | 1 | 0 | 1 | 0 | Soft reset                           | CFG mode only                 |

### 9.1.1 StartConfig and StopConfig commands

### Table 18. StartConfig command synopsis

| Byte      | 1         | 2                  |
|-----------|-----------|--------------------|
| To dovico | COMMAND   | CRC <sup>(1)</sup> |
| To device | 0010 1010 | 1101 1010          |

1. If CRC check is disabled this byte is ignored.

### Table 19. StopConfig command synopsis

| Byte      | 1         | 2                  |
|-----------|-----------|--------------------|
| To device | COMMAND   | CRC <sup>(1)</sup> |
|           | 0011 1010 | 1010 1010          |

1. If CRC check is disabled this byte is ignored.

The device can be configured properly writing the values of the configuration registers (CFGx and DIAGxCFGx), operation that is allowed only entering in configuration mode.

To switch the device to the configuration mode the *StartConfig* command must be sent. The execution needs a  $\overline{CS}$  deselect time  $t_{desCS\_STC}$  and it is valid only if the  $\overline{SD}$  input is low, otherwise the command is not executed and the SPI\_ERR flag is set HIGH. If the command has been correctly received and interpreted, the configuration registers writing is enabled. When the *StartConfig* command is correctly received, the flag PROGLV (STATUS3) and PROGHV (STATUS2) are set high, indicating that the device has entered the configuration mode.

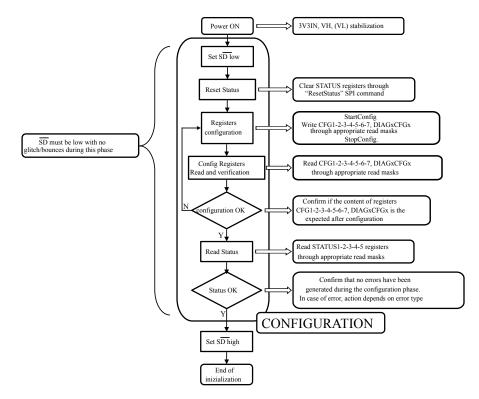
The  $\overline{\text{SD}}$  pin must be kept low during the whole configuration procedure. If the  $\overline{\text{SD}}$  pin is raised during the configuration procedure the device immediately quits the configuration mode causing an error indicated by the SPI\_ERROR bit. In this case all the changes operated on the device configuration are ignored and the previous configuration is maintained.

At the end of the device configuration the *StopConfig* command must be sent to quit the configuration mode and to make all changes effective. The execution needs a  $\overline{CS}$  deselect time  $t_{desCS}$  SPC.

The PROGLV and PROGHV bits are set low only when the device is configuration mode and a StopConfig command is received.

The configuration sequence must be repeated every time the power supply of one of the two sides (3V3IN or VH) is removed and then restored.

When all supply voltages are stable, the configuration process can be executed. The flow chart shown in Figure 46 is recommended for the configuration. At the end of the configuration sequence it is possible to check that the desired configuration has been correctly executed.



### Figure 46. STGAP4S recommended configuration flow

The configuration procedure must be completed within the configuration timer  $t_{CFG}$ . The timer is started after receiving a StartConfig command and it is stopped after receiving a StopConfig command. If the configuration is not completed within the timer, that is, the StopConfig is not received before the timer is expired, the device immediately quits the configuration mode causing an error indicated by the SPI\_ERROR bit. In this case all the changes operated on the device configuration are ignored and the previous configuration is maintained. In this case the PROGLV and PROGHV bits remain set high.



### 9.1.2 WriteReg command

#### Table 20. WriteReg command synopsis

| Byte      | 1                        | 2                  | 3                   | 4                  |
|-----------|--------------------------|--------------------|---------------------|--------------------|
| To device | COMMAND+ADDRESS          | CRC <sup>(1)</sup> | DATA <sup>(2)</sup> | CRC <sup>(3)</sup> |
| TO device | 100A AAAA <sup>(4)</sup> | 2222 2222          | DDDD DDDD           | KKKK KKKK          |

1. CRC byte of the command, if CRC check is disabled this byte is ignored.

2. Data to be written into the target register.

3. CRC byte of the command and data, if CRC check is disabled this byte is ignored.

4. Command byte where AAAAA is the address of the target register.

The device registers can be written through the WriteReg command when the device is set in configuration mode only (refer to Section 9.1.1), otherwise the write command is ignored and the SPI\_ERR flag is set HIGH.

A complete WriteReg is composed by 4 bytes thus it requires two SPI accesses to be executed. In the first access the SPI host must send the Byte 1 and Byte 2 (containing the command, the address of the register to be written and the related CRC) followed by the proper CS deselect time. Then, in the second access, the host must send the Byte 3 and Byte 4 (containing the data to be written into the target register and the CRC) followed by the same CS deselect time.

The  $\overline{CS}$  deselect time required depends on the side where the register is located. The writing of a local register (LV side) needs a  $\overline{CS}$  deselect time t<sub>desCS\_LWR</sub>. The writing of a remote register (HV side) needs a  $\overline{CS}$  deselect time t<sub>desCS\_RWR</sub>. See Section 4.2 for details.

The CRC of the data byte (Byte 4) must be calculated initializing the computation system to the CRC of the command byte previously calculated (Byte 2). In this way, in case of communication error, a data byte cannot be decoded as a command and vice versa (refer to Section 8.1).

### 9.1.3 ReadReg command

| Byte        | 1                         | 2   | <b>3</b> <sup>(1)</sup>       | 4                  |
|-------------|---------------------------|---|-------------------------------|--------------------|
| To dovice   | COMMAND+ADDRESS           | CRC <sup>(2)</sup>                          | NOP                           | CRC <sup>(3)</sup> |
| To device   | 101A AAAA <sup>(4)</sup>  | 2222 2222                                   | 0000 0000                     | 0000 1100          |
| From device | SPI BUFFER <sup>(5)</sup> | CRC <sup>(6)</sup> of the SPI output buffer | REQUESTED DATA <sup>(7)</sup> | CRC <sup>(8)</sup> |
| From device | XXXX XXXX                 | ΥΥΥΥ ΥΥΥΥ                                   | DDDD DDDD                     | KKKK KKKK          |

#### Table 21. ReadReg command synopsis

1. Appropriate time has to pass in order to allow the device to prepare the data.

2. The CRC byte of the command, if the CRC check is disabled this byte is ignored.

3. The CRC byte of the NOP command, if the CRC check is disabled this byte is ignored

4. The command byte where AAAAA is the address of the target register.

5. Content of the SPI output buffer when the ReadReg is sent

6. CRC

7. Data read from the target register.

8. The CRC byte of the data.

All the registers of the device can be read anytime and this requires two SPI accesses.

In the first access the SPI host must send the ReadReg containing the command and the address of the register to be read (Byte 1) and the related CRC code (Byte 2). After waiting the proper  $\overline{CS}$  deselect time the read result is stored in the SPI output buffer and the host can receive it doing a new SPI access that shifts the output buffer content. Any command can be used for this purpose, including a NOP or the ReadReg command for the next register to be read. In Table 21 an example is reported using the NOP (Byte 3) and the related CRC (Byte 4).

The deselect time required depends on the side where the register is located. The reading of a local register (LV side) needs a  $\overline{CS}$  deselect time t<sub>desCS\_LRD</sub>. The reading of a remote register (HV side) needs a  $\overline{CS}$  deselect time t<sub>desCS\_RRD</sub>. See Section 4.2 for details.

The CRC polynomial used by the device during the transmission is the same used by the host, the CRC code is not inverted before transmission (refer to Section 8.1).

Some status and configuration registers contain reserved bits whose content is not predictable. In order to clearly identify the content of relevant information, the value read from each register should be masked with the appropriate masking code (see Table 26).

### 9.1.4 ResetStatus command

#### Table 22. ResetStatus command synopsis

| Byte      | 1         | 2                  |
|-----------|-----------|--------------------|
| To device | COMMAND   | CRC <sup>(1)</sup> |
|           | 1101 0000 | 0011 0010          |

1. if the CRC check is disabled this byte is ignored.

The *ResetStatus* command acts on all status registers clearing all the flags. The execution needs a  $\overline{CS}$  deselect time t<sub>desCS\_RST</sub> and it is valid only if the  $\overline{SD}$  input is low, otherwise the command is not executed and the SPI\_ERR flag is set HIGH.

If during the execution of the command a fault is present the related bit is not cleared.

### 9.1.5 SoftReset command

#### Table 23. SoftReset command synopsis

| Byte      | 1         | 2                  |
|-----------|-----------|--------------------|
| To device | COMMAND   | CRC <sup>(1)</sup> |
|           | 1110 1010 | 1001 0100          |

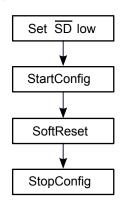
1. If the CRC check is disabled this byte is ignored.

The *SoftReset* command restores all the registers (both the Status and the Configuration) to the default value and clears all the fault flags. The command execution needs a  $\overline{CS}$  deselect time  $t_{desCS}$ \_RST and it is valid only when the device is in configuration mode, otherwise the command is not executed and the SPI\_ERR flag is set HIGH. The reset of the registers is applied only after the execution of the "StopConfig" command.

If during the execution of the command a fault is present the related bit is not cleared.

When the SoftReset command is executed no other commands must be present in the same configuration slot, as in the sequence reported in Figure 47:

#### Figure 47. SoftReset Flow





## 9.1.6 NOP command

### Table 24. NOP command synopsis

| Byte      | 1         | 2                  |
|-----------|-----------|--------------------|
| To device | COMMAND   | CRC <sup>(1)</sup> |
|           | 0000 0000 | 0000 1100          |

1. If the CRC check is disabled this byte is ignored.

The command does not modify the device status and does not generate any answer. The execution needs a  $\overline{\text{CS}}$  deselect time  $t_{\text{desCS}\_\text{NOP}}.$ 



# 9.2 Registers and flags description

All device features can be configured through a set of 8-bit long registers. There are two different types of registers:

- Local registers are located on the low voltage side
- Remote registers are located on the high voltage side

A map of the user registers is shown in Table 25

| Name      | Side <sup>(1)</sup> |               | Structure   |              |               |             |             |             |              |
|-----------|---------------------|---------------|-------------|--------------|---------------|-------------|-------------|-------------|--------------|
| -         | -                   | [7]           | [6]         | [5]          | [4]           | [3]         | [2]         | [1]         | [0]          |
| CFG1      | L                   | UVLO3V3IN_EN  | SD_FLAG     |              | DTset         |             | INfilter    |             | ADC_PWM_EN   |
| CFG2      | R                   | SENSE_EN      | SAFE_OFF    | DESAT_EN     | DESA          | Tcur        | DESATth     |             |              |
| CFG3      | R                   | OVLO          | VHth        | UVLOlatch    | VLO           | Nth         |             | VHONth      |              |
| CFG4      | R                   |               | SENSEth     |              | ADC_C         | Scur        | ADC_INPUT   | SOFT_2LTO   | OUT_DTth     |
| CFG5      | R                   | -             | -           | -            | -             |             | 2LTO_       | SOFTtime    |              |
| CFG6      | L                   | CONTROLL      | ER_FREQ     | CRC_SPI      | -             | -           | -           | -           | -            |
| CFG7      | R                   | ADC_HIGHth AD |             |              | ADC_LOWth     |             | ADC_EN      | OFFMODE     |              |
| STATUS1   | R                   | OVLOH         | OVLOL       | DESAT_OC     | SENSE_OC      | UVLOH       | UVLOL       | TSD         | STATUS1_BUSY |
| STATUS2   | R                   | SAFESTATE     | HVReset     | -            | TWN           | PROGHV      | REGERRR     | COMERRR     | STATUS2_BUSY |
| STATUS3   | L                   | UVLO_3V3IN    | UVLO_VCC    | -            | DT_ERR        | SPI_ERR     | -           | PROGLV      | FLYBACK_FLT  |
| STATUS4   | L                   | -             | PWM_LV      | ASC_LEVEL_LV | GATE_LEVEL_LV | LVReset     | REGERRL     | COMERRL     | SPI_HVbusy   |
| STATUS5   | L                   |               |             |              | AD            | С           |             |             |              |
| TEST1     | R                   | ADC_CHK       | RSNSCHK     | SNSCHK       | МСРСНК        | DESCHK      | DEFAULTCHK  | OUT1OUT2CHK | GATECHK      |
| DIAG1CFGA | R                   | DIAG1CFGA_7   | DIAG1CFGA_6 | DIAG1CFGA_5  | DIAG1CFGA_4   | DIAG1CFGA_3 | DIAG1CFGA_2 | DIAG1CFGA_1 | DIAG1CFGA_0  |
| DIAG1CFGB | L                   | DIAG1CFGB_7   | DIAG1CFGB_6 | DIAG1CFGB_5  | DIAG1CFGB_4   | DIAG1CFGB_3 | DIAG1CFGB_2 | DIAG1CFGB_1 | DIAG1CFGB_0  |
| DIAG2CFGA | R                   | DIAG2CFGA_7   | DIAG2CFGA_6 | DIAG2CFGA_5  | DIAG2CFGA_4   | DIAG2CFGA_3 | DIAG2CFGA_2 | DIAG2CFGA_1 | DIAG2CFGA_0  |
| DIAG2CFGB | L                   | DIAG2CFGB_7   | DIAG2CFGB_6 | DIAG2CFGB_5  | DIAG2CFGB_4   | DIAG2CFGB_3 | DIAG2CFGB_2 | DIAG2CFGB_1 | DIAG2CFGB_0  |

Table 25. Registers map

1. R: remote (high voltage side), L: local (low voltage side).

### Table 26. Registers access

| Name      | Address | Mask code |
|-----------|---------|-----------|
| CFG1      | 0x00    | 0xFF      |
| CFG2      | 0x11    | 0xFF      |
| CFG3      | 0x12    | 0xFF      |
| CFG4      | 0x13    | 0xFF      |
| CFG5      | 0x14    | 0x0F      |
| CFG6      | 0x01    | 0xE0      |
| CFG7      | 0x15    | 0xFF      |
| STATUS1   | 0x1B    | 0xFF      |
| STATUS2   | 0x1C    | 0xDF      |
| STATUS3   | 0x0D    | 0xDB      |
| STATUS4   | 0x0E    | 0x7F      |
| STATUS5   | 0x1D    | 0xFF      |
| TEST1     | 0x1F    | 0xFF      |
| DIAG1CFGA | 0x17    | 0xFF      |
| DIAG1CFGB | 0x18    | 0xFF      |
| DIAG2CFGA | 0x19    | 0xFF      |
| DIAG2CFGB | 0x1A    | 0xFF      |

### 9.2.1 CFG1 register (LV side)

The CFG1 register has the structure and default values in Table 27.

#### Table 27. CFG1 register

|                 | Bit 7        | Bit 6   | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0      |
|-----------------|--------------|---------|-------|-------|-------|-------|-------|------------|
|                 | UVLO3V3IN_EN | SD_FLAG |       | DTset |       | INfi  | lter  | ADC_PWM_EN |
| SoftReset/Reset | 0            | 1       |       | 000   |       | 0     | 0     | 0          |

The UVLO3V3IN\_EN bit enables/disables the UVLO protection of 3V3IN supply voltage. This setting has no effect on the flyback section that is always stopped in case of UVLO condition on 3V3IN.

#### Table 28. 3V3IN supply voltage UVLO

| UVLO3V3IN_EN | 3V3IN UVLO enable |
|--------------|-------------------|
| 1            | Disabled          |
| 0            | Enabled           |

The SD\_FLAG bit sets the  $\overline{SD}$  pin functionality according to Table 29. When the reset of the fault flags through the  $\overline{SD}$  pin is enabled, keeping low the  $\overline{SD}$  pin for at least t<sub>release</sub> causes all the flags of the status registers to be released at next  $\overline{SD}$  rising edge.

### Table 29. Reset by SD pin

| SD_FLAG | SD pin functionality                     |
|---------|--|
| 0       | SD pin do not reset the STATUS registers |
| 1       | SD pin resets the STATUS registers       |



## The DTset bits set the deadtime value of DT function.

| Table | 30. | Deadtime |
|-------|-----|----------|
|-------|-----|----------|

|   | DTset[20] |   |          |  |  |
|---|-----------|---|----------|--|--|
| 0 | 0         | 0 | Disabled |  |  |
| 0 | 0         | 1 | 250      |  |  |
| 0 | 1         | 0 | 500      |  |  |
| 0 | 1         | 1 | 750      |  |  |
| 1 | 0         | 0 | 1000     |  |  |
| 1 | 0         | 1 | 1250     |  |  |
| 1 | 1         | 0 | 1500     |  |  |
| 1 | 1         | 1 | 2000     |  |  |

The INfilter bits set the duration  $t_{\text{deglitch}}$  of input deglitch filter for  $\overline{\text{SD}},$  IN- and IN+ pins.

### Table 31. Input deglitch time

| INfilt | er [10] | Input deglitch time [ns] |
|--------|---------|--------------------------|
| 0      | 0       | Disabled                 |
| 0      | 1       | 70                       |
| 1      | 0       | 160                      |
| 1      | 1       | 500                      |

The ADC\_PWM\_EN bit enables the PWM output signal on the ADC pin.

### Table 32. ADC\_PWM\_EN

| ADC_PWM_EN | ADC PWM output signal enable |  |  |
|------------|------------------------------|--|--|
| 0          | Disabled                     |  |  |
| 1          | Enabled                      |  |  |



## 9.2.2 CFG2 register (HV side)

The CFG2 register has the structure and default values in Table 33.

#### Table 33. CFG2 register

|   |                 | Bit 7    | Bit 6    | Bit 5    | Bit 4    | Bit 3 | Bit 2   | Bit 1 | Bit 0 |
|---|-----------------|----------|----------|----------|----------|-------|---------|-------|-------|
|   |                 | SENSE_EN | SAFE_OFF | DESAT_EN | DESATcur |       | DESATth |       |       |
| S | SoftReset/Reset | 0        | 0        | 1        | 0        | 0     |         | 010   |       |

"SoftReset" is obtained by SPI SoftReset command.

"Reset" is obtained by power-on of the HV side.

The SENSE\_EN bit enables the sense overcurrent protection function (refer to Section 7.9 for details).

### Table 34. SENSE comparator enabling

| SENSE_EN | SENSE protection |
|----------|------------------|
| 0        | disabled         |
| 1        | enabled          |

The SAFE\_OFF bit determines the turn-off mode in case of overcurrent or desaturation event (activation of SENSE or DESAT protection).

#### Table 35. SAFE\_OFF

| SAFE_OFF | Desaturation/overcurrent turning off mechanism                                     |  |  |  |
|----------|--|--|--|--|
| 0        | Turn-off is performed as in normal operation                                       |  |  |  |
| 1        | Turn-off is performed through SOFTOFF feature (the SOFT_2LTO bit must be set to 0) |  |  |  |

The DESAT\_EN bit enables the desaturation protection function:

#### Table 36. DESAT comparator enabling

| DESAT_EN | DESAT protection |  |  |
|----------|------------------|--|--|
| 0        | disabled         |  |  |
| 1        | enabled          |  |  |

The DESATcur parameter sets the  $I_{DESAT}$  current sourced by DESAT pin according to Table 37 and the DESATth parameter sets the  $V_{DESATth}$  threshold of DESAT comparator according to Table 38. Refer to Section 7.8 for details.

### Table 37. DESAT current

| DESATcur [10] |   | DESAT current [µA] |
|---------------|---|--------------------|
| 0             | 0 | 250                |
| 0             | 1 | 500                |
| 1             | 0 | 750                |
| 1 1           |   | 1000               |



### Table 38. DESAT threshold

|   | DESATth [20] | DESAT threshold [V] |    |
|---|--------------|---------------------|----|
| 0 | 0            | 0                   | 3  |
| 0 | 0            | 1                   | 4  |
| 0 | 1            | 0                   | 5  |
| 0 | 1            | 1                   | 6  |
| 1 | 0            | 0                   | 7  |
| 1 | 0            | 1                   | 8  |
| 1 | 1            | 0                   | 9  |
| 1 | 1            | 1                   | 10 |

### 9.2.3 CFG3 register (HV side)

The CFG3 register has the structure and the default values in Table 39.

### Table 39. CFG3 register

|                 | Bit 7    | Bit 6 | Bit 5     | Bit 4  | Bit 3 | Bit 2  | Bit 1 | Bit 0 |
|-----------------|----------|-------|-----------|--------|-------|--------|-------|-------|
|                 | OVLOVHth |       | UVLOlatch | VLONth |       | VHONth |       |       |
| SoftReset/Reset |          | 11    | 0         | 0      | 0     |        | 001   |       |

"SoftReset" is obtained by SPI SoftReset command.

"Reset" is obtained by power-on of the HV side.

The OVLOHth bits set the OVVH<sub>off</sub> and OVVH<sub>on</sub> OVLO thresholds on VH positive power supply according to Table 40.

### Table 40. VH supply voltage OVLO threshold

| OVLOVHt | h [10] | OVVH <sub>off</sub> [V] | OVVH <sub>on</sub> [V] |
|---------|--------|-------------------------|------------------------|
| 0       | 0      | 19                      | 18                     |
| 0       | 1      | 21                      | 20                     |
| 1       | 0      | 23                      | 22                     |
| 1       | 1      | 34                      | 33                     |

The UVLOlatch bit sets if the UVLOH and UVLOL are latched or not (refer to Section 7.6 for details).

### Table 41. VH and VL UVLO protection latch

| UVLOlatch | UVLOH and UVLOL latch |
|-----------|-----------------------|
| 0         | disabled              |
| 1         | enabled               |

The VLONth bits set the  $VL_{off}$  and  $VL_{on}$  UVLO thresholds on VL negative power supply according to Table 42. By default at HV side power-on the function is disabled as VLONth=00.

When the function is enabled by configuring the device with one of the available thresholds, after the StopConfig command (see Section 9.1.1) the UVLOL fault could be temporarily asserted (for approximately 10 us) even if the voltage on the VL pin is not in UVLO condition. In this case if the protection is latched (UVLOlatch=1) at the end of the configuration the fault flag UVLOL in STATUS1 is found HIGH. If a diagnostic pin is configured to report the UVLOL fault (see Section 9.2.14) the pin behaves consequently to the UVLOL asserting.

| Table 42 | VL supply | voltage | UVLO | threshold |
|----------|-----------|---------|------|-----------|
|----------|-----------|---------|------|-----------|

| VLONth [10] |   | VL <sub>off</sub> [V] | VL <sub>on</sub> [V] |
|-------------|---|-----------------------|----------------------|
| 0           | 0 | Disabled              |                      |
| 0           | 1 | -2                    | -3                   |
| 1           | 0 | -4                    | -5                   |
| 1           | 1 | -6                    | -7                   |

The VHONth bits set the  $VH_{off}$  and  $VH_{on}$  UVLO threshold on VH positive power supply according to Table 43. Setting VHONth='00' disables the UVLO protection of the VH supply.

| Table 43 | VH supply | voltage | UVLO | threshold |
|----------|-----------|---------|------|-----------|
|----------|-----------|---------|------|-----------|

| v | 'HONth [20 | ] | VH <sub>off</sub> [V] VH <sub>on</sub> [V] |          |  |  |
|---|------------|---|--|----------|--|--|
| 0 | 0          | 0 | ]  | Disabled |  |  |
| 0 | 0          | 1 | 10   | 11       |  |  |
| 0 | 1          | 0 | 11   | 12       |  |  |
| 0 | 1          | 1 | 12   | 13       |  |  |
| 1 | 0          | 0 | 13   | 14       |  |  |
| 1 | 0          | 1 | 14   | 15       |  |  |
| 1 | 1          | 0 | 15   | 16       |  |  |
| 1 | 1          | 1 | 16   | 17       |  |  |

### 9.2.4 CFG4 register (HV side)

The CFG4 register has the structure and default values in Table 44.

### Table 44. CFG4 register

|                 | Bit 7 | Bit 6   | Bit 5 | Bit 4     | Bit 3 | Bit 2     | Bit 1     | Bit 0    |
|-----------------|-------|---------|-------|-----------|-------|-----------|-----------|----------|
|                 |       | SENSEth |       | ADC_CScur |       | ADC_INPUT | SOFT_2LTO | OUT_DTth |
| SoftReset/Reset | 000   |         | 0     | 0         | 0     | 0         | 0         |          |

"SoftReset" is obtained by SPI SoftReset command

"Reset" is obtained by power-on of the HV side.

The SENSEth bits set the SENSE comparator threshold according to Table 45. Refer to Section 7.9 for details.

### Table 45. SENSE threshold

|   | SENSEth [20] |   | SENSE threshold [mV] |
|---|--------------|---|----------------------|
| 0 | 0            | 0 | 100                  |
| 0 | 0            | 1 | 125                  |
| 0 | 1            | 0 | 150                  |
| 0 | 1            | 1 | 175                  |
| 1 | 0            | 0 | 200                  |
| 1 | 0            | 1 | 250                  |
| 1 | 1            | 0 | 300                  |
| 1 | 1            | 1 | 400                  |



The ADC\_CScur bits define the current source connected to the ADCP pin of internal ADC (refer to Section 7.10 for details).

#### Table 46. ADC current source

| ADC_C | Scur [10] | ADC current source [µA] |
|-------|-----------|-------------------------|
| 0     | 0         | 0                       |
| 0     | 1         | 300                     |
| 1     | 0         | 600                     |
| 1     | 1         | 1000                    |

The ADC\_INPUT bit defines the input source provided to internal ADC, according to the following table:

#### Table 47. ADC\_INPUT

| ADC_INPUT | ADC input signal source                                |
|-----------|--|
| 1         | Internal IC temperature measurement                    |
| 0         | Differential voltage between $V_{ADCP}$ and $V_{ADCN}$ |

The SOFT\_2LTO bit is set to '0' by default at HV side power-on and this value must be kept also when the device is configured. No other setting is allowed for this bit. In case SAFE\_OFF bit in CFG2 is set at '1' the Soft turn-off function is used when SENSE or DESAT are triggered.

The OUT\_DTth bit defines the OUT<sub>DT</sub> parameter, which sets the deadtime duration between OUT1 and OUT2 (see Figure 11 and Figure 16):

### Table 48. OUT\_DTth

| OUT_DTth | Dead time between OUT1 and OUT2 [ns] |  |  |  |  |  |
|----------|--------------------------------------|--|--|--|--|--|
| 0        | 55                                   |  |  |  |  |  |
| 1        | 88                                   |  |  |  |  |  |

### 9.2.5 CFG5 register (HV side)

The CFG5 register has the structure and default values in Table 49.

#### Table 49. CFG5 register

|                 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1    | Bit 0 |
|-----------------|-------|-------|-------|-------|-------|-------|----------|-------|
|                 | -     | -     | -     | -     |       | 2LTO_ | SOFTtime |       |
| SoftReset/Reset | -     | -     | -     | -     |       | C     | )101     |       |

"SoftReset" is obtained by SPI SoftReset command.

"Reset" is obtained by power-on of the HV side.

If SOFTOFF feature is activated (SAFE\_OFF='1'; SOFT\_2LTO='0') 2LTO\_SOFTtime parameter sets the duration of the Soft turn-off after a DESAT/SENSE event (see Figure 35 and Figure 36), according to Table 50.

|   | 2LTO_SOF | Ttime [30] |   | Soft turn-off timeout [µs] |
|---|----------|------------|---|----------------------------|
| 1 | 1        | 1          | 1 | 0.25                       |
| 0 | 0        | 0          | 0 | 0.50                       |
| 0 | 0        | 0          | 1 | 0.75                       |
| 0 | 0        | 1          | 0 | 1.00                       |
| 0 | 0        | 1          | 1 | 1.50                       |
| 0 | 1        | 0          | 0 | 2.00                       |
| 0 | 1        | 0          | 1 | 2.50                       |
| 0 | 1        | 1          | 0 | 3.00                       |
| 0 | 1        | 1          | 1 | 3.50                       |
| 1 | 0        | 0          | 0 | 3.75                       |
| 1 | 0        | 0          | 1 | 4.00                       |
| 1 | 0        | 1          | 0 | 4.25                       |
| 1 | 0        | 1          | 1 | 4.50                       |
| 1 | 1        | 0          | 0 | 4.75                       |
| 1 | 1        | 0          | 1 | 5.00                       |
| 1 | 1        | 1          | 0 | 5.25                       |

### Table 50. t<sub>2LTO\_SOFTtime</sub> value

# 9.2.6 CFG6 register (LV side)

The CFG6 register has the structure and default values in Table 51.

### Table 51. CFG6 register

|                 | Bit 7           | Bit 6 | Bit 5   | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-----------------|-----------------|-------|---------|-------|-------|-------|-------|-------|
|                 | CONTROLLER_FREQ |       | CRC_SPI | -     | -     | -     | -     | -     |
| SoftReset/Reset | 00              |       | 0       |       |       |       |       |       |

### "SoftReset" is obtained by SPI SoftReset command.

"Reset" is obtained by power-on of the LV side.

The CONTROLLER\_FREQ parameter sets the main oscillator frequency of the internal PWM controller for the isolated flyback converter, according to Table 52.

### Table 52. CONTROLLER\_FREQ

| CONTROLLE | Frequency [kHz] |     |
|-----------|-----------------|-----|
| 0         | 0               | 400 |
| 0         | 1               | 200 |
| 1         | 0               | 300 |
| 1         | 1               | 600 |

The CRC\_SPI bit enables the CRC check on the SPI communication protocol.

#### Table 53. CRC enable

| CRC_SPI | SPI communication protocol CRC enable |
|---------|---------------------------------------|
| 0       | Disabled                              |
| 1       | Enabled                               |

#### 9.2.7 CFG7 register (HV side)

The CFG7 register has the structure and default values in Table 54.

#### Table 54. CFG7 register

|                 | Bit 7      | Bit 6 | Bit 5     | Bit 4 | Bit 3 | Bit 2  | Bit 1   | Bit 0 |
|-----------------|------------|-------|-----------|-------|-------|--------|---------|-------|
|                 | ADC_HIGHth |       | ADC_LOWth |       |       | ADC_EN | OFFMODE |       |
| SoftReset/Reset | 000        |       | 000       |       | 0     | 1      |         |       |

"SoftReset" is obtained by SPI SoftReset command.

"Reset" is obtained by power-on of the HV side.

The ADC\_HIGHth bits set the higher voltage level of the input signal dynamic range:

#### Table 55. ADC\_HIGHth

| AD | ADC_HIGHth [20] |   | Higher voltage threshold for ADC input [V] |
|----|-----------------|---|--|
| 0  | 0               | 0 | 1.50                                       |
| 0  | 0               | 1 | 1.715                                      |
| 0  | 1               | 0 | 1.930                                      |
| 0  | 1               | 1 | 2.145                                      |
| 1  | 0               | 0 | 2.360                                      |
| 1  | 0               | 1 | 2.570                                      |
| 1  | 1               | 0 | 2.785                                      |
| 1  | 1               | 1 | 3.00                                       |

The ADC\_LOWth bits set the lower voltage level of the input signal dynamic range:

#### Table 56. ADC\_LOWth

| AD | C_LOWth [20 | ] | Lower voltage threshold for ADC input [V] |
|----|-------------|---|---|
| 0  | 0           | 0 | 0   |
| 0  | 0           | 1 | 0.215                                     |
| 0  | 1           | 0 | 0.430                                     |
| 0  | 1           | 1 | 0.645                                     |
| 1  | 0           | 0 | 0.855                                     |
| 1  | 0           | 1 | 1.070                                     |
| 1  | 1           | 0 | 1.285                                     |
| 1  | 1           | 1 | 1.500                                     |

The ADC\_EN bit enables the analog measurement function, and so the periodic update of ADC register with internal ADC output code.

#### Table 57. Analog measurement function enable

| ADC_EN | Analog measurement function |  |  |  |  |  |
|--------|-----------------------------|--|--|--|--|--|
| 0      | Disabled                    |  |  |  |  |  |
| 1      | Enabled                     |  |  |  |  |  |

The OFFMODE bit sets if the SOFTOFF MOSFET is activated in combination with OUT2 at every switching cycle or if remains off. This setting doesn't affect the behaviour of the pin 2LSO when the "Soft turn-off" is performed upon a DESAT or SENSE event.

#### Table 58. SOFTOFF MOSFET activation

| OFFMODE | SOFTOFF MOSFET activation |
|---------|---------------------------|
| 0       | Same time as OUT2         |
| 1       | Remains OFF               |

#### 9.2.8 STATUS1 register (HV side)

The STATUS1 is a read-only register. All flags are active high (high value indicates a fault/warning condition). The STATUS1 register has the structure in Table 59.

#### Table 59. STATUS1 register

|                 | Bit 7 | Bit 6 | Bit 5    | Bit 4    | Bit 3 | Bit 2 | Bit 1 | Bit 0        |
|-----------------|-------|-------|----------|----------|-------|-------|-------|--------------|
|                 | OVLOH | OVLOL | DESAT_OC | SENSE_OC | UVLOH | UVLOL | TSD   | STATUS1_BUSY |
| ClearStatus     | 0     | 0     | 0        | 0        | 0     | 0     | 0     | Х            |
| SoftReset/Reset | 0     | 0     | 0        | 0        | 0     | 0     | 0     | Х            |

"ClearStatus" is obtained by SPI ResetStatus command or by SDReset.

"SoftReset" is obtained by SPI SoftReset command.

"Reset" is obtained by power-on of the HV side.

When the ClearStatus, SoftReset or Reset are executed the state reported in the table is valid if no fault conditions are present, otherwise the related bit is overwritten according to the fault

When the Reset is executed the actual state can differ from the reported in the table depending on the slope of the supply voltage at the power-on.

A description of STATUS1 register bits is provided in Table 60.

#### Table 60. STATUS1 register description

| Name     | Bit | Fault  | Latched | Force<br>"SafeState" | Note |
|----------|-----|--|---------|----------------------|------|
| OVLOH    | 7   | VH overvoltage flag.<br>It is set high when VH is over<br>OVVH <sub>off</sub> threshold.   | Yes     | Yes                  |      |
| OVLOL    | 6   | $\label{eq:VL} \begin{array}{l} \mbox{VL overvoltage flag.} \\ \mbox{It is set high when VL is over} \\ \mbox{OVVL}_{\rm off} \mbox{threshold.} \end{array}$ | Yes     | Yes <sup>(1)</sup>   |      |
| DESAT_OC | 5   | Desaturation flag.<br>It is set high when DESAT<br>pin voltage reaches DESATth<br>threshold.   | Yes     | Yes                  |      |



| Name         | Bit | Fault  | Latched                        | Force<br>"SafeState" | Note  |
|--------------|-----|--|--------------------------------|----------------------|---|
| SENSE_OC     | 4   | Sense flag. It is set high when SENSE pin voltage reaches $V_{\text{SENSEth}}$ threshold.                        | Yes                            | Yes                  |   |
| UVLOH        | 3   | VH undervoltage flag.<br>It is set high when VH is below<br>VHoff threshold.                                     | Only when<br>UVLOlatch is high | Yes                  | If not latched<br>(UVLOlatch=0) returns<br>low when VH is over<br>VHon threshold  |
| UVLOL        | 2   | VL undervoltage flag.<br>It is set high when VL is over<br>VLoff threshold.                                      | Only when<br>UVLOlatch is high | Yes <sup>(1)</sup>   | If not latched<br>(UVLOlatch=0) returns<br>low when VL is below<br>VLon threshold |
| TSD          | 1   | Thermal shutdown protection<br>flag.<br>It is set high when<br>overtemperature shutdown<br>threshold is reached. | No<br>(fixed hysteresis)       | Yes                  |   |
| STATUS1_BUSY | 0   | This flag is set high if data<br>obtained through SPI access to<br>STATUS1 (bits 7-1) register are<br>not valid. | No                             | No                   | The value of the flag<br>is updated at every SPI<br>Read of STATUS1               |

1. If current device's state is HW3PS and this fault is detected, device remains in HW3PS state.

#### 9.2.9 STATUS2 register (HV side)

The STATUS2 is a read-only register. All flags are active high (high value indicates a fault/warning condition). The STATUS2 register has the structure in Table 61.

#### Table 61. STATUS2 register

|                 | Bit 7     | Bit 6   | Bit 5 | Bit 4 | Bit 3            | Bit 2            | Bit 1                   | Bit 0        |
|-----------------|-----------|---------|-------|-------|------------------|------------------|-------------------------|--------------|
|                 | SAFESTATE | HVReset | -     | TWN   | PROGHV           | REGERRR          | COMERRR                 | STATUS2_BUSY |
| ClearStatus     | 0         | 0       |       | 0     | X <sup>(1)</sup> | 0 <sup>(2)</sup> | 0                       | Х            |
| SoftReset/Reset | 1         | 1       |       | 0     | 1 <sup>(3)</sup> | 0                | <b>0</b> <sup>(4)</sup> | Х            |

1. When a "Clearstatus" is executed PROGHV maintains the previous value.

2. If a REGGERRR fault has occurred the device configuration must be repeated.

3. If a HV side "Reset" occurs while the device is in Configuration Mode the PROGHV bit is set to 0 after the StopConfig command.

4. The value actually found depends also on the power-on timing of the LV side.

"ClearStatus" is obtained by SPI ResetStatus command or by SDReset.

"SoftReset" is obtained by SPI SoftReset command.

"Reset" is obtained by power-on of the HV side.

When the ClearStatus, SoftReset or Reset are executed the state reported in the table is valid if no fault conditions are present otherwise the related bit is overwritten according to the fault.

When the Reset is executed the actual state can differ from that reported in the table depending on the slope of the supply voltage at the power-on.

A description of STATUS2 register bits is provided in Table 62.

#### Table 62. STATUS2 register description

| Name      | Bit | Fault/signal   | Latched | Force<br>"SafeState" | Note |
|-----------|-----|--|---------|----------------------|------|
| SAFESTATE | 7   | The flag is set when HV is in SafeState. It is reset when HV exits from SafeState. | No      | -                    |      |

| Name         | Bit | Fault/signal  | Latched                     | Force<br>"SafeState"  | Note   |
|--------------|-----|---|-----------------------------|---|--|
| HVReset      | 6   | Set high after a SoftReset/Reset of the HV side.  | Yes                         | Yes   |  |
| -            | 5   |   |                             |   |  |
| TWN          | 4   | Thermal warning flag. It is set high when overtemperature warning threshold is reached.   | No<br>(fixed<br>hysteresis) | No  |  |
|              |     | PROGHV Flag is set high after a SoftReset/Reset or when a StartConfig is correctly received.  |                             |   |  |
| PROGHV       | 3   | It is set low when the device is in Configuration<br>mode and the HV side receives a StopConfig<br>command. When this flag is high, it is not set low<br>by the ClearStatus commands. | No                          | No  |  |
| REGERRR      | 2   | It is set high when one or more misalignments<br>have been found in the HV configuration<br>registers.  | Yes                         | Yes   | The device<br>configuration<br>must be<br>repeated.                        |
| COMERRR      | 1   | Communication error on HV side.<br>It is set high when HV side does not receive any<br>response from LV side (e.g. 3V3IN supply is not<br>provided) within HV WATCHDOG time frame.    | Yes                         | SafeState or<br>HW3PS state is<br>forced,<br>depending on<br>DEFAULT pin's<br>state. <sup>(1)</sup> |  |
| STATUS2_BUSY | 0   | This flag is set high if data obtained through SPI access to STATUS2 register (bits 7-1) are not valid.   | No                          | No  | The value of the<br>flag is updated<br>at every SPI<br>Read of<br>STATUS2. |

1. If current device's state is HW3PS and this fault is detected, device remains in HW3PS state.

### 9.2.10 STATUS3 register (LV side)

The STATUS3 is a read-only register. All flags are active high (high value indicates a fault condition). The STATUS3 register has the structure in Table 63.

#### Table 63. STATUS3 register

|                 | Bit 7      | Bit 6    | Bit 5 | Bit 4  | Bit 3   | Bit 2 | Bit 1            | Bit 0         |
|-----------------|------------|----------|-------|--------|---------|-------|------------------|---------------|
|                 | UVLO_3V3IN | UVLO_VCC |       | DT_ERR | SPI_ERR | -     | PROGLV           | FLYBACK_FAULT |
| ClearStatus     | 0          | 0        | -     | 0      | 0       | Х     | X <sup>(1)</sup> | 0             |
| SoftReset/Reset | 0          | 0        | -     | 0      | 0       | Х     | 1                | 0             |

1. When a "Clearstatus" is executed PROGLV maintains the previous value.

"ClearStatus" is obtained by SPI ResetStatus command or by SDReset.

"SoftReset" is obtained by SPI SoftReset command.

"Reset" is obtained by power-on of the LV side.

When the ClearStatus, SoftReset or Reset are executed the state reported in the table is valid if no fault conditions are present, otherwise the related bit is overwritten according to the fault.

When the Reset is executed the actual state can differ from that reported in the table depending on the slope of the supply voltage at the power-on.

A description of STATUS3 register bits is provided in Table 64.



| Table 64. \$ | STATUS3 | register | description |
|--------------|---------|----------|-------------|
|--------------|---------|----------|-------------|

| Name        | Bit | Fault/signal  | Latched | Force<br>"SafeState" | Note  |
|-------------|-----|---|---------|----------------------|---|
| UVLO_3V3IN  | 7   | 3V3IN undervoltage flag.<br>It is set high when 3V3IN supply is in UVLO<br>condition.   | Yes     | Yes                  |   |
| UVLO_VCC    | 6   | VCC undervoltage flag.<br>It is set high when VCC supply is in UVLO<br>condition.<br>Flyback controller is stopped.   | No      | No                   | This fault is<br>not reported when<br>the LV side is<br>in UVLO_3V3IN<br>condition. |
| -           | 5   |   |         |                      |   |
| DT_ERR      | 4   | Deadtime error flag.<br>This bit is set high when a violation of internal<br>DT is detected.  | Yes     | No                   |   |
| SPI_ERR     | 3   | <ul> <li>SPI communication error flag.</li> <li>It is set high when the SPI communication fails cause: <ul> <li>Wrong CRC check</li> <li>Wrong number of CK rising edges</li> <li>Attempt to execute a not-allowed command</li> <li>Attempt to execute a command not listed in Table 17</li> <li>Programming procedure is not correctly performed</li> <li>Attempt to read or write at a not-available address</li> </ul> </li> </ul> | Yes     | No                   |   |
| -           | 2   |   |         |                      |   |
| PROGLV      | 1   | PROGLV Flag is set high after a SoftReset/<br>Reset or when a StartConfig is correctly<br>received.<br>It is set low when the LV side correctly receives<br>a StopConfig command if the configuration<br>procedure ends correctly. When this flag is<br>set high, it is not set low by the ClearStatus<br>commands. It can be set low only by completing<br>a configuration.  | No      | No                   |   |
| FLYBACK_FLT | 0   | Flyback controller fault. It is set high when the flyback controller is in fault condition.   | No      | No                   | See details in Section 6.2.11   |



#### 9.2.11 STATUS4 register (LV side)

The STATUS4 is a read-only register. All flags are active high (high value indicates a fault condition). The STATUS4 register has the structure in Table 65.

| Table | 65. | STATUS4 | register |
|-------|-----|---------|----------|
|-------|-----|---------|----------|

|                 | Bit 7 | Bit 6                   | Bit 5            | Bit 4                   | Bit 3   | Bit 2            | Bit 1            | Bit 0      |
|-----------------|-------|-------------------------|------------------|-------------------------|---------|------------------|------------------|------------|
|                 | -     | PWM_LV                  | ASC_LEVEL_LV     | GATE_LEVEL_LV           | LVReset | REGERRL          | COMERRL          | SPI_HVbusy |
| ClearStatus     |       | <b>x</b> <sup>(1)</sup> | x <sup>(1)</sup> | <b>X</b> <sup>(1)</sup> | 0       | 0 <sup>(2)</sup> | 0                | 0          |
| SoftReset/Reset |       | 0                       | 0                | 0                       | 1       | 0                | 0 <sup>(3)</sup> | 0          |

1. When a "Clearstatus" is executed GATE\_LEVEL\_LV, PWM\_LV, ASC\_LV maintain their current values.

If a REGGERRL fault has occurred the device configuration must be repeated.
 The value actually found depends also on the power-on timing of the HV side.

"ClearStatus" is obtained by SPI ResetStatus command or by SDReset.

"SoftReset" is obtained by SPI SoftReset command.

"Reset" is obtained by power-on of the LV side.

When the ClearStatus, SoftReset or Reset are executed the state reported in the table is valid if no fault conditions are present, otherwise the related bit is overwritten according to the fault.

When the Reset is executed the actual state can differ from that reported in the table depending on the slope of the supply voltage at the power-on.

A description of STATUS4 register bits is provided in Table 66.

| Table 66. | STATUS4 | register | description |
|-----------|---------|----------|-------------|
|-----------|---------|----------|-------------|

| Name          | Bit | Fault/signal   | Latched | Force<br>"SafeState" | Note                                       |
|---------------|-----|--|---------|----------------------|--|
| -             | 7   |  | -       | -                    |  |
| PWM_LV        | 6   | PWM command flag.<br>The flag is set according to the last<br>PWM command correctly received by<br>HV side.<br>Flag is '1' for ON command<br>Flag is '0' for OFF command   | No      | No                   |  |
| ASC_LEVEL_LV  | 5   | ASC pin status.<br>When ASC pin is high the flag reports<br>'1', otherwise it is '0'.  | No      | No                   |  |
| GATE_LEVEL_LV | 4   | <ul> <li>GATE status flag, monitor of the voltage on GATE pin. It is the output of a comparator with an hysteresis equal to V<sub>GATEth_ON</sub> - V<sub>GATEth_OFF</sub>. Specifically:</li> <li>GATE_LEVEL_LV is set high when GATE is rising and overcome V<sub>GATEth_ON</sub> threshold.</li> <li>GATE_LEVEL_LV is set low when GATE is falling and it goes below V<sub>GATEth_OFF</sub> threshold.</li> </ul> | No      | No                   |  |
| LVReset       | 3   | Set high after a SoftReset/Reset of the LV side.   | Yes     | Yes <sup>(1)</sup>   | See details in Section 6.4.                |
| REGERRL       | 2   | It is set high when one or more<br>misalignments have been found in the<br>LV configuration registers.   | Yes     | Yes <sup>(1)</sup>   | The device configuration must be repeated. |



| Name       | Bit | Fault/signal   | Latched | Force<br>"SafeState" | Note  |
|------------|-----|--|---------|----------------------|---|
| COMERRL    | 1   | Communication error on LV side.<br>It is set high when LV side does not<br>receive any response from HV side<br>(e.g. VH supply is not provided) within<br>HV WATCHDOG time frame. | Yes     | No                   | If set, after HV WATCHDOG<br>time, HV side enters in<br>HW3PS or SAFESTATE<br>based on DEFAULT pin. |
| SPI_HVbusy | 0   | The flag is set high if the data received<br>through an SPI access to the HV<br>configuration registers are not valid<br>(CFGx, DIAGxCFGx, TEST1).                                 | Yes     | No                   |   |

1. If current device's state is HW3PS and this fault is detected, device remains in HW3PS state.

### 9.2.12 STATUS5 register (LV side)

The STATUS5 is a read-only register and has the structure reported in Table 67.

#### Table 67. STATUS5 register

|                 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-----------------|-------|-------|-------|-------|-------|-------|-------|-------|
|                 |       |       |       | A     | C     |       |       |       |
| ClearStatus     | Х     | Х     | Х     | Х     | Х     | Х     | Х     | Х     |
| SoftReset/Reset | 1     | 1     | 1     | 1     | 1     | 1     | 1     | 1     |

"ClearStatus" is obtained by SPI ResetStatus command or by SDReset.

"SoftReset" is obtained by SPI SoftReset command.

"Reset" is obtained by power-on of the LV side.

After the "ClearStatus" execution if ADC\_EN=1 the value is the ADC converted data, otherwise it is 0xFF. After the "SoftReset"/"Reset" execution if ADC\_EN=1 the value is overwritten with the ADC converted data. A description of STATUS5 register bits is provided in Table 68.

#### Table 68. STATUS5 register description

| Name | Bit | Information           | Latched | Force "SafeState" | Note |
|------|-----|-----------------------|---------|-------------------|------|
| ADC  | 7-0 | ADC output data bits. | No      | No                |      |



#### 9.2.13 TEST1 register (HV side)

The TEST1 register has the structure reported in Table 69

#### Table 69. TEST1 register

|                 | Bit 7  | Bit 6   | Bit 5  | Bit 4  | Bit 3  | Bit 2      | Bit 1       | Bit 0   |
|-----------------|--------|---------|--------|--------|--------|------------|-------------|---------|
|                 | ADCCHK | RSNSCHK | SNSCHK | MCPCHK | DESCHK | DEFAULTCHK | OUT1OUT2CHK | GATECHK |
| SoftReset/Reset | 0      | 0       | 0      | 0      | 0      | 0          | 0           | 0       |

According to Table 70, setting one check bit of the register enables the related check mode:

#### Table 70. Check mode

| Name        | Bit | Fault/signal                                |
|-------------|-----|---|
| ADC_CHK     | 7   | ADC functionality                           |
| RSNSCHK     | 6   | SENSE resistor                              |
| SNSCHK      | 5   | SENSE comparator                            |
| МСРСНК      | 4   | MILLER clamp driver                         |
| DESCHK      | 3   | DESAT functionality                         |
| DEFAULTCHK  | 2   | DEFAULT pin function                        |
| OUT1OUT2CHK | 1   | OUT1/OUT2 to gate path                      |
| GATECHK     | 0   | DEFAULT pin function – test type definition |

#### 9.2.14 DIAGxCFGA and DIAGxCFGB registers

DIAG1 and DIAG2 fault pins can be independently associated to up to 16 different diagnostics or faults. DIAG1 configuration can be done setting DIAG1CFGA and DIAG1CFGB registers, which have the structure described in Table 71 and Table 72.

If a bit in DIAG1CFGA or DIAG1CFGB register is set high, the corresponding event turns on the DIAG1 opendrain MOSFET.

#### Table 71. DIAG1CFGA register

|                 | Bit 7       | Bit 6       | Bit 5       | Bit 4       | Bit 3       | Bit 2       | Bit 1       | Bit 0       |
|-----------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
|                 | DIAG1CFGA_7 | DIAG1CFGA_6 | DIAG1CFGA_5 | DIAG1CFGA_4 | DIAG1CFGA_3 | DIAG1CFGA_2 | DIAG1CFGA_1 | DIAG1CFGA_0 |
| SoftReset/Reset | 0           | 1           | 0           | 1           | 0           | 0           | 0           | 0           |

#### Table 72. DIAG1CFGB register

|                 | Bit 7       | Bit 6       | Bit 5       | Bit 4       | Bit 3       | Bit 2       | Bit 1       | Bit 0       |
|-----------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
|                 | DIAG1CFGB_7 | DIAG1CFGB_6 | DIAG1CFGB_5 | DIAG1CFGB_4 | DIAG1CFGB_3 | DIAG1CFGB_2 | DIAG1CFGB_1 | DIAG1CFGB_0 |
| SoftReset/Reset | 0           | 1           | 0           | 0           | 1           | 0           | 0           | 0           |

DIAG2 configuration can be done setting DIAG2CFGA and DIAG2CFGB registers, which have the structure described in Table 73 and Table 74.

If a bit in DIAG2CFGA or DIAG2CFGB register is set high, the corresponding events turn on the DIAG2 opendrain MOSFET.

#### Table 73. DIAG2CFGA register

| Bit 7       | Bit 6       | Bit 5       | Bit 4       | Bit 3       | Bit 2       | Bit 1       | Bit 0       |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| DIAG2CFGA_7 | DIAG2CFGA_6 | DIAG2CFGA_5 | DIAG2CFGA_4 | DIAG2CFGA_3 | DIAG2CFGA_2 | DIAG2CFGA_1 | DIAG2CFGA_0 |



|                 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-----------------|-------|-------|-------|-------|-------|-------|-------|-------|
| SoftReset/Reset | 0     | 0     | 1     | 0     | 1     | 1     | 0     | 1     |

#### Table 74. DIAG2CFGB register

|                 | Bit 7       | Bit 6       | Bit 5       | Bit 4       | Bit 3       | Bit 2       | Bit 1       | Bit 0       |
|-----------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
|                 | DIAG2CFGB_7 | DIAG2CFGB_6 | DIAG2CFGB_5 | DIAG2CFGB_4 | DIAG2CFGB_3 | DIAG2CFGB_2 | DIAG2CFGB_1 | DIAG2CFGB_0 |
| SoftReset/Reset | 1           | 0           | 0           | 0           | 0           | 0           | 1           | 1           |

The relation between DIAGxCFGA and DIAGxCFGB registers bits and fault events is described in Table 75 and Table 76.

#### Table 75. DIAG1CFGA and DIAG2CFGA registers

| DIAGxCFGA bit # | Fault/status                               | Status register bit |
|-----------------|--|---------------------|
| 0               | Communication error on HV side             | COMERRR             |
| 1               | Overvoltage on VH or VL                    | OVLOH, OVLOL        |
| 2               | Undervoltage on VH or VL                   | UVLOH, UVLOL        |
| 3               | Register or configuration error on HV side | REGERRR             |
| 4               | HV side reset                              | HVRESET             |
| 5               | Thermal shutdown, thermal warning          | TSD, TWN            |
| 6               | Desaturation Detection                     | DESAT_OC            |
| 7               | SENSE detection                            | SENSE_OC            |

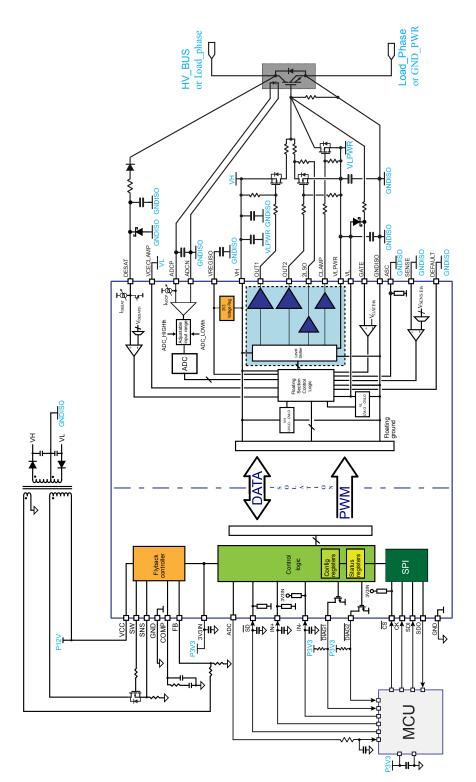
#### Table 76. DIAG1CFGB and DIAG2CFGB registers

| DIAGxCFGB bit # | Fault                                     | Status register bit               |  |  |
|-----------------|---|-----------------------------------|--|--|
| 0               | Register or configuration error on LV     | REGERRL                           |  |  |
| 1               | Communication error on LV side            | COMERRL                           |  |  |
| 2               | Deadtime violation                        | DT_ERR                            |  |  |
| 3               | SPI communication error                   | SPI_ERR                           |  |  |
| 4               | Gate level                                | GATE_LEVEL_LV                     |  |  |
| 5               | ASC level                                 | ASC_LEVEL_LV                      |  |  |
| 6               | LV side reset                             | LVRESET                           |  |  |
| 7               | Flyback fault, UVLO on VCC, UVLO on 3V3IN | FLYBACK_FLT, UVLO_VCC, UVLO_3V3IN |  |  |

# **10** Typical application diagram

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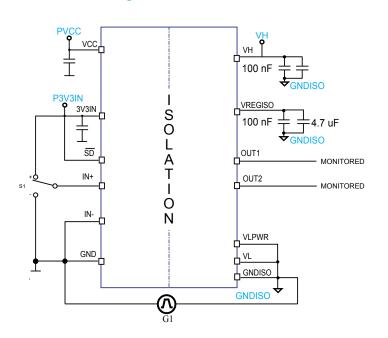






# **11** Testing and characterization information

#### Figure 49. CMTI test circuit





## 12 Package information

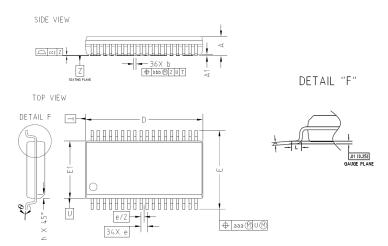
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

## 12.1 SO-36W package information

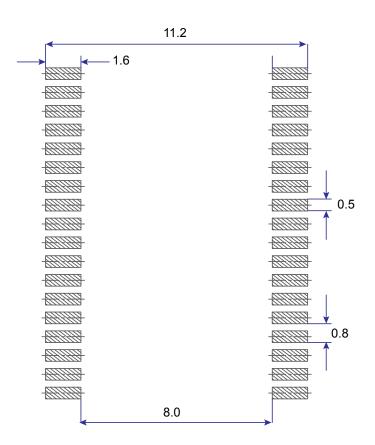
| Oursehal | Dim   | ensions (mm)/Angles(De | gree) | NOTES   |
|----------|-------|------------------------|-------|---------|
| Symbol   | Min.  | Тур.                   | Max.  | - NOTES |
| А        |       |                        | 2.65  |         |
| A1       | 0.1   |                        | 0.3   |         |
| b        | 0.25  |                        | 0.35  |         |
| С        | 0.20  |                        | 0.33  |         |
| D        | 15.20 |                        | 15.60 |         |
| E1       | 7.40  |                        | 7.60  |         |
| E        | 10.05 |                        | 10.65 |         |
| е        |       | 0.8 BSC                | '     |         |
| L        | 0.61  |                        | 0.91  |         |
| h        | 0.25  |                        | 0.75  |         |
| θ        | 0°    |                        | 8°    |         |
| aaa      |       | 0.25                   |       |         |
| bbb      |       | 0.25                   |       |         |
| ccc      |       | 0.1                    |       |         |

#### Table 77. SO-36W package dimensions

#### Figure 50. SO-36W mechanical data

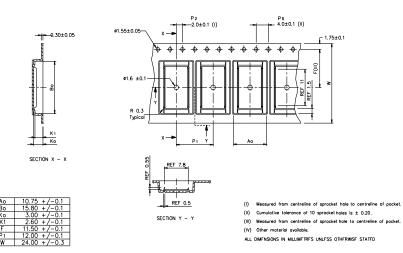


### Figure 51. SO-36W suggested land pattern



## **12.2** Tape and reel





## Figure 53. Reel dimensions

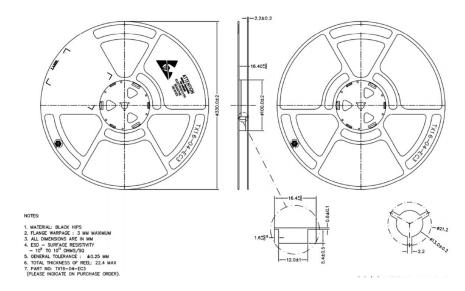
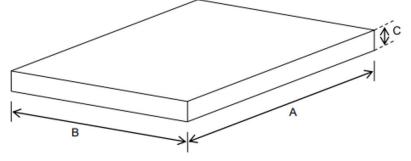


Figure 54. Box dimensions



| Material code | A ± 2mm | B ± 2mm | C ± 2mm | Reel diameter | Reel width | Internal coating  |
|---------------|---------|---------|---------|---------------|------------|-------------------|
| 3CP71972      | 340     | 340     | 340     | 13"           | 8,12,16,24 | No carbon coating |

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# 13 Ordering information

| Table | 78. | Order | codes |
|-------|-----|-------|-------|
|       |     |       |       |

| Order code | Package | Package marking | Packaging     |
|------------|---------|-----------------|---------------|
| STGAP4S    | SO-36W  | STGAP4S         | Tube          |
| STGAP4STR  | SO-36W  | STGAP4S         | Tape and reel |

## **Revision history**

### Table 79. Document revision history

| Date        | Version | Changes  |
|-------------|---------|--|
| 21-Dec-2021 | 1       | Initial release.   |
| 26-Apr-2022 | 2       | Added AEC-Q100 qualification, Typo correction in STATUS4.SPI_HVBusy:<br>Latched = Yes, Added $V_{DIAGx}$ to Table 4, Added Section 6.2.11 Flyback fault<br>diagnostic, Added Section 7.2 Logic I/O interface to 5V logic signals   |
| 26-Ott-2022 | 3       | Added descriptions in Section 7, Section 9. Modified description in<br>Section 7.4, Section 7.13,Section 7.11,Section 7.12,Section 6.2.7,Table 64.<br>Updated N <sub>UVP</sub> parameter in Section 4.2 Typo correction in<br>STAUS3.UVLO_3V3IN: Force SafeState = Yes, Figure 46, Figure 35. Added<br>GATE, VREGISO to Table 4. |
| 09-Mar-2023 | 4       | Updated Figure 9, Figure 39, Figure 48, Figure 49; Updated VDE standard in Table 8; Modified description in Section 7.4; Added description in Section 7.15   |



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